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## MAX77960/MAX77961

## 25V<sub>IN</sub> 3A/6A<sub>OUT</sub> USB-C Buck-Boost Charger with Integrated FETs for 2S/3S Li-Ion Batteries

### General Description

The MAX77960/MAX77961 are high-performance wide-input 3A (MAX77960)/6A (MAX77961) buck-boost chargers with Smart Power Selector™ and operate as a reverse buck converter without an additional inductor, allowing the ICs to power USB on-the-go (OTG) accessories. The devices integrate low-loss power switches and provide high efficiency, low heat, and fast battery charging in a small solution size. The reverse buck has true load disconnect and is protected by an adjustable output current limit. The devices are highly flexible and programmable through I<sup>2</sup>C configuration or autonomously through resistor configuration.

The battery charger includes the Smart Power Selector to accommodate a wide range of battery sizes and system loads. The Smart Power Selector allows the system to start up smoothly when an input source is available even when the battery is deeply discharged (dead battery) or missing. For battery safety/authentication reasons, the ICs can be configured to keep charging disabled, and allow the DC-DC to switch and regulate the SYS voltage. The system processor can later enable charging using I<sup>2</sup>C commands as appropriate. Alternatively, the ICs can be configured to automatically start charging.

### Applications

- USB Type-C Powered Wide-Input Charging Applications
- 2- and 3-Cell Battery-Powered Devices
- Smartphones, Tablets, and 2-in-1 Laptops
- Medical Devices, Health and Fitness Monitors
- Digital Still, Video, and Action Cameras
- Handheld Computers and Terminals
- Handheld Radios
- Power Tools
- Drones
- Battery Backup
- Wireless Speakers

### Benefits and Features

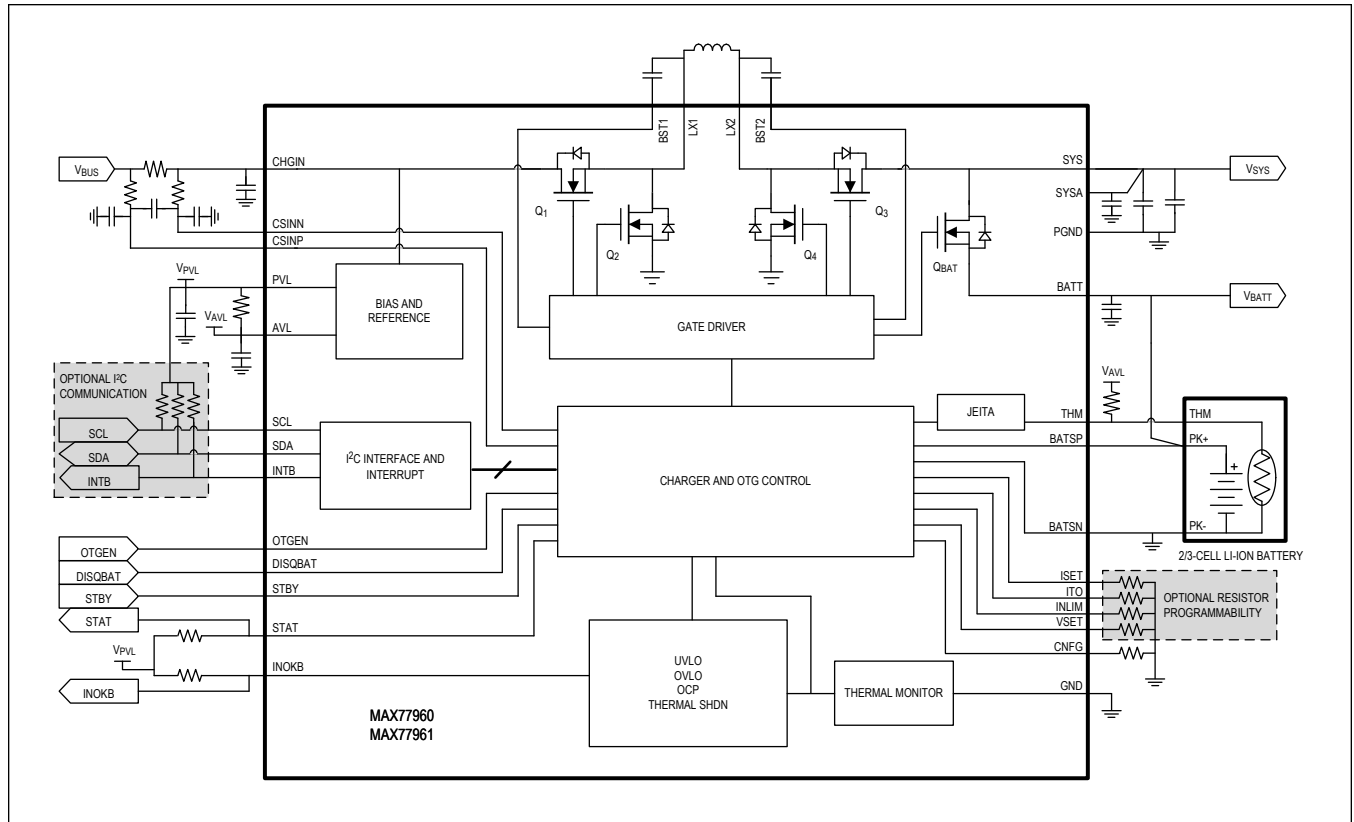
- 3.5V to 25.4V Input Operating Range, 30V<sub>DC</sub> Withstand
- 97% Peak Efficiency for 2S Battery at 9V<sub>IN</sub>/7.4V<sub>OUT</sub>/1.5A<sub>OUT</sub>
- 97% Peak Efficiency for 3S Battery at 15V<sub>IN</sub>/12.6V<sub>OUT</sub>/2A<sub>OUT</sub>
- MAX77960
  - 100mA to 3.15A Programmable Input Current Limit
  - 100mA to 3A Programmable Constant Current Charge
- MAX77961
  - 100mA to 6.3A Programmable Input Current Limit
  - 100mA to 6A Programmable Constant Current Charge
- Remote Differential Voltage Sensing
- 600kHz Switching Frequency
- System Instant On with Smart Power Selector Power Path
- Charge Safety Timer
- Die Temperature Regulation with Thermal Foldback Loop
- Input Power Management with Adaptive Input Current Limit (AICL) and Input Voltage Regulation
- 10mΩ BATT to SYS Switch, Up to 10A Overcurrent Threshold
- Reverse Buck Mode 5.1V/3A to Support USB OTG
- JEITA Compliant with NTC Thermistor Monitor
- I<sup>2</sup>C or Resistor Programmable
- 4mm x 4mm, 30-Lead FC2QFN

**Ordering Information appears at end of data sheet.**

Smart Power Selector is a trademark of Maxim Integrated Products, Inc.



Simplified Block Diagram



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### Absolute Maximum Ratings

|                            |                                   |  |                      |
|----------------------------|-----------------------------------|--|----------------------|
| CHGIN to GND.....          | -0.3V to +30.0V                   | PVL, AVL, ISET, VSET, INLIM, ITO, CNFG, THM to GND .   | -0.3V to +2.2V       |
| CSINP, CSINN to CHGIN..... | -0.3V to +0.3V                    | AVL to PVL .....   | -0.3V to +0.3V       |
| LX1 to PGND.....           | -0.3V to +30.0V                   | DISQBAT, OTGEN, STBY, STAT, INOKB, INTB, SDA, SCL to GND .....   | -0.3V to +6.0V       |
| LX2 to PGND.....           | -0.3V to +16.0V                   | CHGIN Continuous Current .....   | 6.5A <sub>RMS</sub>  |
| BST1 to PVL.....           | -0.3V to +30.0V                   | LX_, PGND Continuous Current.....  | 6.5A <sub>RMS</sub>  |
| BST2 to PVL.....           | -0.3V to +16.0V                   | SYS, BATT Continuous Current .....   | 10.0A <sub>RMS</sub> |
| BST_ to LX.....            | -0.3V to +2.2V                    | Continuous Power Dissipation (Multilayer Board) (T <sub>A</sub> = +70°C, derate 40.37mW/°C above +70°C.) ..... | 3229.71mW            |
| SYS, SYSA to GND.....      | -0.3V to +16.0V                   | Operating Temperature Range .....  | -40°C to +85°C       |
| BATT to GND .....          | -0.3V to +16.0V                   | Storage Temperature Range .....  | -65°C to +150°C      |
| SYS to BATT .....          | -0.3V to +16.0V                   |  |                      |
| BATSP to GND.....          | -0.3V to V <sub>BATT</sub> + 0.3V |  |                      |
| BATSN, PGND to GND .....   | -0.3V to +0.3V                    |  |                      |

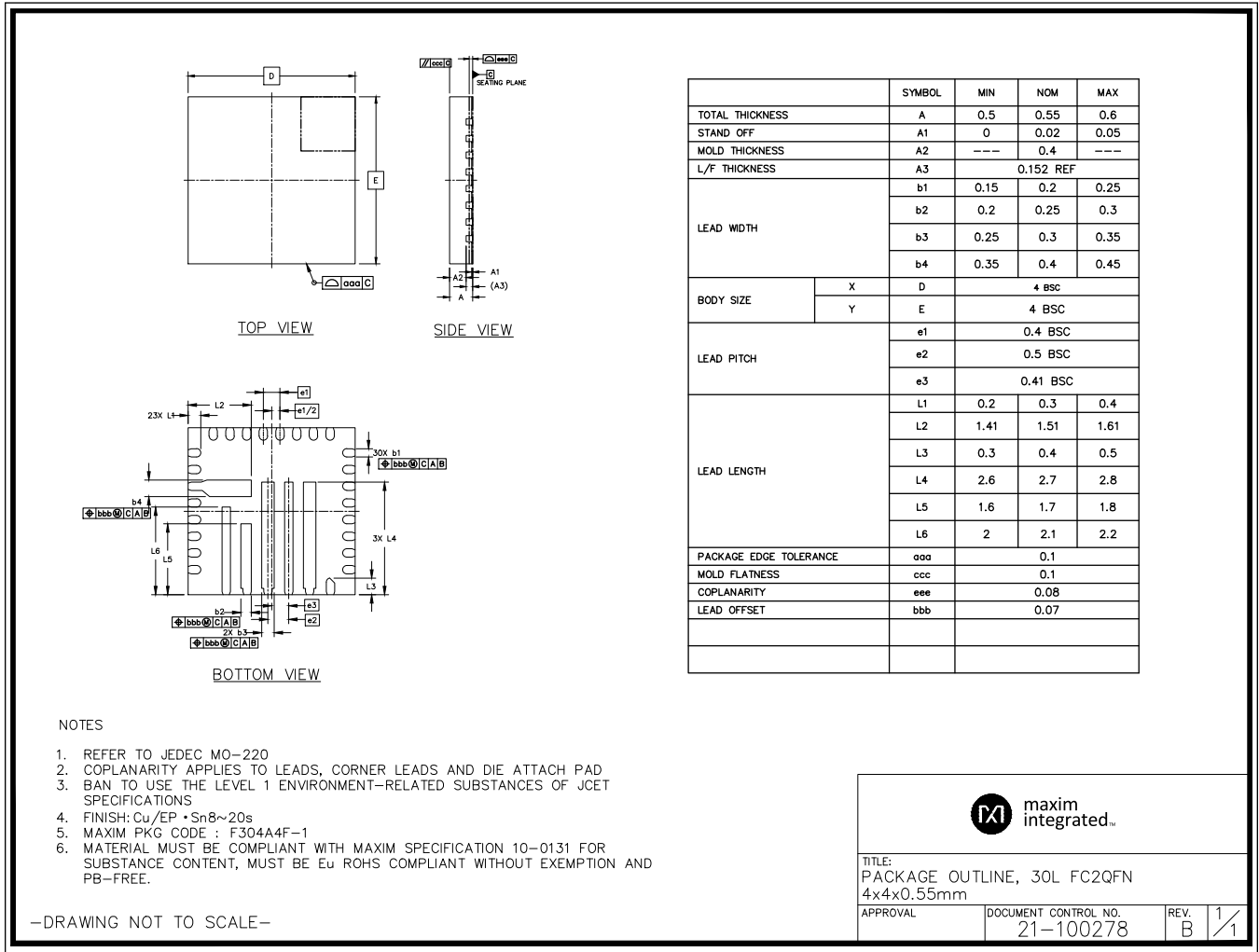
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Package Information

#### 30-Lead FC2QFN

|  |                           |
|--|---------------------------|
| Package Code   | F304A4F+1                 |
| Outline Number   | <a href="#">21-100278</a> |
| Land Pattern Number                                    | <a href="#">90-100100</a> |
| <b>Thermal Resistance, Four-Layer Board:</b>           |                           |
| Junction-to-Ambient (θ <sub>JA</sub> )                 | 24.77°C/W                 |
| Junction-to-Case Thermal Resistance (θ <sub>JC</sub> ) | 1.67°C/W                  |





For the latest package outline information and land patterns (footprints), go to [www.maximintegrated.com/packages](http://www.maximintegrated.com/packages). Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

## Electrical Characteristics

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER   | SYMBOL                    | CONDITIONS   | MIN           | TYP   | MAX             | UNITS |
|---|---------------------------|--|---------------|-------|-----------------|-------|
| <b>GENERAL ELECTRICAL CHARACTERISTICS</b>   |                           |  |               |       |                 |       |
| CHGIN Voltage Range   | V <sub>CHGIN</sub>        | Operating voltage  | 3.5           |       | 25.4            | V     |
| CHGIN Overvoltage Threshold   | V <sub>CHGIN_OVLO</sub>   | V <sub>CHGIN</sub> rising, 365mV hysteresis  | 25.4          | 26.05 | 26.7            | V     |
| CHGIN Overvoltage Delay   | t <sub>D_CHGIN_OVLO</sub> | V <sub>CHGIN</sub> rising, 100mV overdrive (Note 1)  |               | 10    |                 | μs    |
|   |                           | V <sub>CHGIN</sub> falling, 100mV overdrive (Note 1)   |               | 7     |                 | ms    |
| CHGIN Undervoltage Threshold  | V <sub>CHGIN_UVLO</sub>   | V <sub>CHGIN</sub> rising, 20% hysteresis  | 3.43          | 3.5   | 3.57            | V     |
| CHGIN Quiescent Current (I <sub>SYS</sub> = 0A)   | I <sub>CHGIN</sub>        | V <sub>CHGIN</sub> = 2.4V, the input is undervoltage and R <sub>INSD</sub> is the only loading   |               | 0.075 |                 | mA    |
|   |                           | V <sub>CHGIN</sub> = 9.0V, charger disabled  |               | 0.17  | 0.5             |       |
|   |                           | V <sub>CHGIN</sub> = 9.0V, charger enabled, V <sub>SYS</sub> = V <sub>BATT</sub> = 8.7V (2S configuration), no switching   |               | 2.7   | 4               |       |
|   | I <sub>CHGIN_STBY</sub>   | MODE[3:0] = 0x0 (DC-DC off), STBY = H or STBY_EN = 1, V <sub>CHGIN</sub> = 5V  |               |       | 1               |       |
| BATT Quiescent Current (I <sub>SYS</sub> = 0A)  | I <sub>SHDN</sub>         | FSHIP_MODE = 1 or DISQBAT = high, V <sub>CHGIN</sub> = 0V, I <sub>SYS</sub> = 0A, V <sub>BATT</sub> = 13.5V  |               | 2.3   | 5.0             | μA    |
|   | I <sub>BATT</sub>         | DISQBAT = low, I <sup>2</sup> C enabled, V <sub>CHGIN</sub> = 0V, I <sub>SYS</sub> = 0A, V <sub>BATT</sub> = 13.5V   |               | 100   | 200             |       |
|   |                           | V <sub>SYS</sub> = 7.6V, V <sub>BATT</sub> = 0V, charger disabled, T <sub>A</sub> = +25°C  |               | 0.01  | 10              |       |
|   |                           | V <sub>SYS</sub> = 7.6V, V <sub>BATT</sub> = 0V, charger disabled, T <sub>A</sub> = +85°C (Note 1)   |               | 10    |                 |       |
|   | I <sub>BATTDN</sub>       | V <sub>CHGIN</sub> = 9V, V <sub>BATT</sub> = 8.4V, Q <sub>BAT</sub> is off, battery overcurrent protection disabled, charger is enabled but in its done mode, T <sub>A</sub> = +25°C |               | 57    | 65              |       |
| V <sub>CHGIN</sub> = 9V, V <sub>BATT</sub> = 8.4V, Q <sub>BAT</sub> is off, battery overcurrent protection disabled, charger is enabled but in its done mode, T <sub>A</sub> = +85°C (Note 1) |                           |  | 57            |       |                 |       |
| SYS Operating Voltage   | V <sub>SYS</sub>          | Guaranteed by V <sub>SYSUVLO</sub> and V <sub>SYSOVLO</sub>  | SYSUVO rising |       | SYSOVL O rising | V     |
| SYS Undervoltage Lockout Threshold  | V <sub>SYSUVLO</sub>      | V <sub>SYS</sub> falling, 530mV hysteresis   | 3.95          | 4.1   | 4.25            | V     |
| SYS Overvoltage Lockout Threshold   | V <sub>SYSOVLO</sub>      | V <sub>SYS</sub> rising, 430mV hysteresis, 2S battery  | 10.65         | 10.9  | 11.15           | V     |
|   |                           | V <sub>SYS</sub> rising, 267mV hysteresis, 3S battery  | 13.75         | 14.1  | 14.45           |       |
| PVL Output Voltage  | V <sub>PVL</sub>          |  | 1.7           | 1.8   | 1.9             | V     |
| Thermal Shutdown Threshold  | T <sub>SHDN</sub>         | T <sub>J</sub> rising (Note 1)   |               | 165   |                 | °C    |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER                            | SYMBOL                | CONDITIONS   | MIN  | TYP  | MAX   | UNITS   |
|--------------------------------------|-----------------------|--|------|------|-------|---------|
| Thermal Shutdown Hysteresis          |                       | (Note 1)   |      | 15   |       | °C      |
| CHGIN Self-Discharge Resistance      | R <sub>INSD</sub>     | V <sub>CHGIN</sub> = 3V  |      | 44   |       | kΩ      |
| BATT Self-Discharge Resistance       | R <sub>BATSD</sub>    | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 5V   |      | 600  |       | Ω       |
| SYS Self-Discharge Resistance        | R <sub>SYSSD</sub>    | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 5V   |      | 600  |       | Ω       |
| Self-Discharge Latch Time            |                       | (Note 1)   |      | 300  |       | ms      |
| <b>SWITCH MODE CHARGER / CHARGER</b> |                       |  |      |      |       |         |
| BATT Regulation Voltage Range        | V <sub>BATTREG</sub>  | Programmable from 8.0V to 9.26V (2S battery) and 12.0V to 13.05V (3S battery), production tested at 8V, 8.38V, 8.8V and 9.26V only (2S battery) and 12V, 12.57V, 13.2V, and 13.89V only (3S battery) | 8.00 |      | 13.05 | V       |
| BATT Regulation Voltage Accuracy     |                       | 8.8V or 13.2V settings, T <sub>A</sub> = +25°C   | -0.9 | -0.3 | +0.3  | %       |
|                                      |                       | 8.8V or 13.2V settings, T <sub>A</sub> = 0°C to +85°C (Note 2)   | -1   | -0.3 | +0.5  |         |
| BATT Overvoltage Lockout Threshold   | V <sub>BATTOVLO</sub> | V <sub>BATT</sub> rising above V <sub>BATTREG</sub> , 2% hysteresis  | 75   | 240  | 375   | mV/cell |
| BATT Undervoltage Lockout Threshold  | V <sub>BATTUVLO</sub> | V <sub>BATT</sub> rising, 100mV hysteresis   | 2.0  | 2.5  | 3.0   | V       |
| Fast-Charge Current Program Range    | I <sub>FC</sub>       | MAX77960; 100mA to 3A; production tested at 100mA, 200mA, 500mA, 1000mA, 1500mA, 2000mA, and 3000mA settings   | 0.10 |      | 3     | A       |
|                                      |                       | MAX77961; 100mA to 6A; production tested at 100mA, 200mA, 500mA, 1000mA, 1500mA, 2000mA, 3000mA, 3500mA, and 3800mA settings   | 0.10 |      | 6     |         |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER                                       | SYMBOL                 | CONDITIONS  | MIN   | TYP  | MAX   | UNITS |
|---|------------------------|---|-------|------|-------|-------|
| Fast-Charge Current Accuracy                    |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 100mA  | 80    | 100  | 120   | mA    |
|   |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 200mA  | 180   | 200  | 220   |       |
|   |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 500mA  | 481   | 500  | 519   |       |
|   |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 1000mA   | 962   | 1000 | 1038  |       |
|   |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 2000mA   | 1925  | 2000 | 2075  |       |
|   |                        | T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 3000mA   | 2887  | 3000 | 3113  |       |
|   |                        | MAX77961. T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 3500mA                               | 3369  | 3500 | 3631  |       |
|   |                        | MAX77961. T <sub>A</sub> = +25°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 3800mA                               | 3657  | 3800 | 3943  |       |
| Fast-Charge Current Accuracy (Over Temperature) |                        | -40°C < T <sub>A</sub> < +85°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for 200mA or less (Note 2)                 | -20   |      | +20   | mA    |
|   |                        | -40°C < T <sub>A</sub> < +85°C, V <sub>BATT</sub> > V <sub>SYSTEMIN</sub> , programmed for greater than 200mA (Note 2)            | -5    |      | +5    | %     |
| CHGIN Adaptive Voltage Regulation Range         | V <sub>CHGIN_REG</sub> | I <sup>2</sup> C programmable   | 4.025 |      | 19.05 | V     |
| CHGIN Adaptive Voltage Regulation Accuracy      |                        | 4.55V setting   | 4.42  | 4.55 | 4.68  | V     |
| CHGIN Current Limit Range                       | CHGIN_ILIM             | MAX77960; programmable; production tested at 100mA, 150mA, 200mA, 500mA, 1000mA, 1500mA, and 3000mA settings only                 | 0.1   |      | 3.15  | A     |
|   |                        | MAX77961; programmable; production tested at 100mA, 150mA, 200mA, 500mA, 1000mA, 1500mA, 3000mA, 4000mA, and 6300mA settings only | 0.1   |      | 6.3   |       |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER                                       | SYMBOL                | CONDITIONS  | MIN   | TYP  | MAX   | UNITS   |
|---|-----------------------|---|-------|------|-------|---------|
| CHGIN Current Limit Accuracy                    |                       | Charger enabled, 100mA input current setting, T <sub>A</sub> = +25°C  | 88    | 98   | 108   | mA      |
|   |                       | Charger enabled, 200mA input current setting, T <sub>A</sub> = +25°C  | 175   | 195  | 215   |         |
|   |                       | Charger enabled, 500mA input current setting, T <sub>A</sub> = +25°C  | 475   | 488  | 500   |         |
|   |                       | Charger enabled, 1000mA input current setting, T <sub>A</sub> = +25°C   | 950   | 975  | 1000  |         |
|   |                       | Charger enabled, 3000mA input current setting, T <sub>A</sub> = +25°C   | 2850  | 2925 | 3000  |         |
|   |                       | MAX77961; charger enabled, 4000mA input current setting, T <sub>A</sub> = +25°C   | 3800  | 3900 | 4000  |         |
|   |                       | MAX77961; charger enabled, 6300mA input current setting, T <sub>A</sub> = +25°C   | 5985  | 6143 | 6300  |         |
| CHGIN Current Limit Accuracy (Over Temperature) |                       | Charger enabled, 200mA or less input current setting, -40°C < T <sub>A</sub> < +85°C (Note 2)   | -22.5 |      | +17.5 | %       |
|   |                       | Charger enabled, greater than 200mA input current setting, -40°C < T <sub>A</sub> < +85°C (Note 2)  | -7.5  |      | +2.5  |         |
| Precharge Voltage Threshold                     | V <sub>PRECHG</sub>   | V <sub>BATT</sub> rising, voltage threshold per cell  | 2.4   | 2.5  | 2.6   | V/Cell  |
| Precharge Current                               | I <sub>PRECHG</sub>   |   | 35    | 50   | 65    | mA      |
| Prequalification Threshold Hysteresis           | V <sub>PQ-H</sub>     | Applies to V <sub>PRECHG</sub>  |       | 150  |       | mV/Cell |
| Minimum SYS Voltage Accuracy                    | V <sub>SYSTEMIN</sub> | Programmable from 5.535V to 6.970V (2S battery) and 8.303V to 10.455V (3S battery), V <sub>BATT</sub> = 5.6V (2S battery) or 8.4V (3S battery), tested at 3V/cell setting | -3    |      | +3    | %       |
| Trickle Charge Current                          | I <sub>TRICKLE</sub>  | Default setting = enabled; I <sub>TRICKLE</sub> [1:0] = 00  | 75    | 100  | 125   | mA      |
|   |                       | Default setting = enabled; I <sub>TRICKLE</sub> [1:0] = 01 (Note 2)   | 150   | 200  | 250   |         |
|   |                       | Default setting = enabled; I <sub>TRICKLE</sub> [1:0] = 10 (Note 2)   | 225   | 300  | 375   |         |
|   |                       | Default setting = enabled; I <sub>TRICKLE</sub> [1:0] = 11  | 300   | 400  | 500   |         |
| Top-Off Current Program Range                   | I <sub>TO</sub>       | Programmable from 100mA to 600mA  | 100   |      | 600   | mA      |
| Charge Termination Deglitch Time                | t <sub>TERM</sub>     | 2mV overdrive, 100ns rise/fall time (Note 1)  |       | 160  |       | ms      |
| Charger Restart Threshold Range                 | V <sub>RSTRT</sub>    | Program options for disabled, 100mV/cell, 150mV/cell, and 200mV/cell with CHG_RSTRT[1:0]  | 100   |      | 200   | mV/cell |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER  | SYMBOL                                  | CONDITIONS   | MIN | TYP  | MAX  | UNITS |
|--|---|--|-----|------|------|-------|
| Charger Restart Deglitch Time  |   | 10mV overdrive, 100ns rise time (Note 1)   |     | 130  |      | ms    |
| Charger State Change Interrupt Deglitch Time                                   | t <sub>SCIDG</sub>                      | Excludes transition to timer fault state, watchdog timer state (Note 1)  |     | 30   |      | ms    |
| <b>SWITCH MODE CHARGER / CHARGE TIMER</b>                                      |   |  |     |      |      |       |
| Prequalification Time  | t <sub>PQ</sub>                         | Applies to both low-battery prequalification and dead-battery prequalification modes (Note 1)                          |     | 30   |      | min   |
| Fast-Charge Constant Current + Fast-Charge Constant Voltage Time               | t <sub>FC</sub>                         | Adjustable from 3hrs, 4hrs, 5hrs, 6hrs, 7hrs, 8hrs, 10hrs including a disable setting; 3hrs default (Note 1)           |     | 3    |      | hrs   |
| Top-Off Time   | t <sub>TO</sub>                         | Adjustable from 30s to 70min in 10min steps (Note 1)   |     | 30   |      | min   |
| <b>SWITCH MODE CHARGER / WATCHDOG TIMER</b>                                    |   |  |     |      |      |       |
| Watchdog Timer Period  | t <sub>WD</sub>                         | (Note 3)   | 80  |      |      | s     |
| <b>SWITCH MODE CHARGER / BUCK-BOOST</b>  |   |  |     |      |      |       |
| CHGIN OK to Start Switching Delay  | t <sub>START</sub>                      | Delay from INOKB H → L to LX_ start switching (Note 1)   |     | 150  |      | ms    |
| Buck-Boost Current Limit   | HSILIM                                  | MAX77960, V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   | 4.3 | 5    | 5.7  | A     |
|  |   | MAX77961, V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   | 8.6 | 10   | 11.4 |       |
| <b>SWITCH MODE CHARGER / BUCK-BOOST / SWITCH IMPEDANCE AND LEAKAGE CURRENT</b> |   |  |     |      |      |       |
| LX1 High-Side Resistance   | R <sub>LX1_HS</sub>                     | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   |     | 16.5 | 26   | mΩ    |
| LX1 Low-Side Resistance  | R <sub>LX1_LS</sub>                     | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   |     | 17   | 30   | mΩ    |
| LX2 High-Side Resistance   | R <sub>LX2_HS</sub>                     | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   |     | 9    | 18   | mΩ    |
| LX2 Low-Side Resistance  | R <sub>LX2_LS</sub>                     | V <sub>CHGIN</sub> = 9V, V <sub>SYS</sub> = V <sub>BATT</sub> = 7.6V   |     | 21   | 33   | mΩ    |
| LX_ Leakage Current  |   | LX1 = PGND or CHGIN, LX2 = PGND or SYS, T <sub>A</sub> = +25°C   |     | 0.01 | 10   | μA    |
|  |   | LX1 = PGND or CHGIN, LX2 = PGND or SYS, T <sub>A</sub> = +85°C (Note 1)  |     | 1    |      |       |
| BST_ Leakage Current   |   | BST_ = 1.8V, T <sub>A</sub> = +25°C  |     | 0.01 | 10   | μA    |
|  |   | BST_ = 1.8V, T <sub>A</sub> = +85°C (Note 1)   |     | 1    |      |       |
| SYS, SYSA Leakage Current  |   | V <sub>SYS</sub> = V <sub>SYSA</sub> = 8.4V, V <sub>BATT</sub> = 0V, charger disabled, T <sub>A</sub> = +25°C          |     | 0.01 | 10   | μA    |
|  |   | V <sub>SYS</sub> = V <sub>SYSA</sub> = 8.4V, V <sub>BATT</sub> = 0V, charger disabled, T <sub>A</sub> = +85°C (Note 1) |     | 1    |      |       |
| CSINP, CSINN Leakage Current   | I <sub>CSINP</sub> , I <sub>CSINN</sub> | V <sub>CHGIN</sub> = 26.05V, V <sub>CSINP</sub> = V <sub>CSINN</sub> = 26.05V, T <sub>A</sub> = +25°C                  | -1  |      | +1   | μA    |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER   | SYMBOL               | CONDITIONS   | MIN   | TYP   | MAX   | UNITS |
|---|----------------------|--|-------|-------|-------|-------|
| <b>SWITCH MODE CHARGER / SMART POWER SELECTOR</b>                   |                      |  |       |       |       |       |
| BAT to SYS Dropout Resistance                                       | R <sub>BAT2SYS</sub> |  |       | 10    | 17    | mΩ    |
| BATT to SYS Reverse Regulation Voltage                              | V <sub>BSREG</sub>   |  |       | 90    |       | mV    |
| <b>SWITCH MODE CHARGER / BATT TO SYS OVERCURRENT ALERT</b>          |                      |  |       |       |       |       |
| Battery Overcurrent Threshold Range                                 | I <sub>BOVCR</sub>   | Programmable from 3A to 10A. Option to disable.  | 3     |       | 10    | A     |
| Battery Overcurrent Debounce Time                                   | t <sub>BOVRC</sub>   | Response time for generating the overcurrent interrupt (Note 3)  |       |       | 3.3   | ms    |
| <b>SWITCH MODE CHARGER / THERMAL FOLDBACK</b>                       |                      |  |       |       |       |       |
| Junction Temperature Thermal Regulation Loop Setpoint Program Range | T <sub>REG</sub>     | Junction temperature when charge current is reduced; programmable from 85°C to 130°C in 5°C steps; default value is 115°C  | 85    |       | 130   | °C    |
| Thermal Regulation Gain   | A <sub>TJREG</sub>   | The charge current is decreased 5% of the fast-charge current setting for every degree that the junction temperature exceeds the thermal regulation temperature. This slope ensures that the full-scale current of 3A (MAX77960)/6A (MAX77961) is reduced to 0A by the time the junction temperature is 20°C above the programmed loop set point. For lower programmed charge currents such as 480mA, this slope is valid for charge current reductions down to 80mA; below 100mA the slope becomes shallower but the charge current still reduced to 0A if the junction temperature is 20°C above the programmed loop set point. (Note 1) |       | -5    |       | %/°C  |
| <b>SWITCH MODE CHARGER / THERMISTOR MONITOR</b>                     |                      |  |       |       |       |       |
| THM Threshold, COLD   | THM_COLD             | V <sub>THM</sub> /V <sub>AVL</sub> rising, 1% hysteresis (thermistor temperature falling)  | 70.05 | 74.56 | 77.43 | %     |
| THM Threshold, COOL   | THM_COOL             | V <sub>THM</sub> /V <sub>AVL</sub> rising, 1% hysteresis (thermistor temperature falling)  | 56.37 | 60    | 62.31 | %     |
| THM Threshold, WARM   | THM_WARM             | V <sub>THM</sub> /V <sub>AVL</sub> falling, 1% hysteresis (thermistor temperature rising)  | 32.58 | 34.68 | 36.01 | %     |
| THM Threshold, HOT  | THM_HOT              | V <sub>THM</sub> /V <sub>AVL</sub> falling, 1% hysteresis (thermistor temperature rising)  | 21.18 | 22.5  | 23.41 | %     |
| THM Threshold, Disabled   |                      | V <sub>THM</sub> /V <sub>AVL</sub> falling, 1% hysteresis, THM function is disabled below this voltage   | 4.67  | 5.9   | 7.01  | %     |
| THM Threshold, Battery Removal Detection                            |                      | V <sub>THM</sub> /V <sub>AVL</sub> rising, 1% hysteresis, battery removal  | 81.74 | 87    | 90.35 | %     |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER  | SYMBOL                     | CONDITIONS  | MIN  | TYP  | MAX  | UNITS |
|--|----------------------------|---|------|------|------|-------|
| THM Input Leakage Current  |                            | V <sub>THM</sub> = GND or V <sub>AVL</sub> ; T <sub>A</sub> = +25°C   |      | 0.1  | 1    | μA    |
|  |                            | V <sub>THM</sub> = GND or V <sub>AVL</sub> ; T <sub>A</sub> = +85°C (Note 1)                                |      | 0.1  |      |       |
| <b>REVERSE BUCK</b>  |                            |   |      |      |      |       |
| Buck Current Limit   | HSILIM_REV                 | f <sub>SW</sub> = 600kHz  | 4.3  | 5    | 5.7  | A     |
| Reverse Buck Quiescent Current   |                            | Not switching: output forced 200mV above its target regulation voltage                                      |      | 1150 |      | μA    |
| Minimum BATT Voltage in OTG Mode   | V <sub>BATT.MIN.OTG</sub>  | V <sub>BATT</sub> = V <sub>SYS</sub> , SYS UVLO falling threshold in OTG mode                               | 5.96 | 6.14 | 6.32 | V     |
| CHGIN Voltage in OTG Mode  | V <sub>CHGIN.OTG</sub>     | V <sub>BATT</sub> = V <sub>BATT.MIN.OTG</sub> , OTGEN = high  | 4.94 | 5.1  | 5.26 | V     |
| CHGIN Undervoltage Threshold in OTG Mode   | V <sub>CHGIN.OTG.UV</sub>  | V <sub>CHGIN</sub> falling, OTGEN = high  |      | 85   |      | %     |
| CHGIN Overvoltage Threshold in OTG Mode  | V <sub>CHGIN.OTG.OV</sub>  | V <sub>CHGIN</sub> rising, OTGEN = high   |      | 110  |      | %     |
| CHGIN Output Current Limit in OTG Mode   | I <sub>CHGIN.OTG.LIM</sub> | V <sub>BATT</sub> = V <sub>BATT.MIN.OTG</sub> , T <sub>A</sub> = +25°C, OTG_ILIM[2:0] = 0b000, OTGEN = high |      | 500  | 550  | mA    |
|  |                            | V <sub>BATT</sub> = V <sub>BATT.MIN.OTG</sub> , T <sub>A</sub> = +25°C, OTG_ILIM[2:0] = 0b001, OTGEN = high |      | 900  | 990  |       |
|  |                            | V <sub>BATT</sub> = V <sub>BATT.MIN.OTG</sub> , T <sub>A</sub> = +25°C, OTG_ILIM[2:0] = 0b011, OTGEN = high |      | 1500 | 1650 |       |
|  |                            | V <sub>BATT</sub> = V <sub>BATT.MIN.OTG</sub> , T <sub>A</sub> = +25°C, OTG_ILIM[2:0] = 0b111, OTGEN = high |      | 3000 | 3300 |       |
| CHGIN Output Voltage Ripple in OTG Mode  |                            | Discontinuous inductor current (i.e., skip mode), OTGEN = high (Note 1)                                     |      | ±150 |      | mV    |
|  |                            | Continuous inductor current, OTGEN = high (Note 1)  |      | ±150 |      |       |
| <b>IO CHARACTERISTICS</b>  |                            |   |      |      |      |       |
| R <sub>INLIM</sub> , R <sub>ISSET</sub> , R <sub>VSET</sub> , R <sub>T0</sub> , R <sub>CNFG</sub> Resistor Range | R <sub>PROG_</sub>         |   | 5.49 |      | 226  | kΩ    |
| Output Low Voltage INOKB, STAT   |                            | I <sub>SINK</sub> = 1mA, T <sub>A</sub> = +25°C   |      |      | 0.4  | V     |
| Output High Leakage INOKB, STAT  |                            | 5.5V, T <sub>A</sub> = +25°C  | -1   | 0    | +1   | μA    |
|  |                            | 5.5V, T <sub>A</sub> = +85°C (Note 1)   |      | 0.1  |      |       |
| DISQBAT, OTGEN, STBY Logic Input Low Threshold   | V <sub>IL</sub>            |   |      |      | 0.4  | V     |
| DISQBAT, OTGEN, STBY Logic Input High Threshold  | V <sub>IH</sub>            |   | 1.4  |      |      | V     |



**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER  | SYMBOL               | CONDITIONS  | MIN                    | TYP                     | MAX                    | UNITS |
|--|----------------------|---|------------------------|-------------------------|------------------------|-------|
| DISQBAT, OTGEN, STBY Logic Input Leakage Current   |                      | 5.5V (including current through pulldown resistor)        |                        | 5.5                     | 10                     | μA    |
| DISQBAT, OTGEN, STBY Pulldown Resistor   | R <sub>DISQBAT</sub> |   |                        | 1000                    | 1200                   | kΩ    |
| <b>INTERFACE / I<sup>2</sup>C INTERFACE AND INTERRUPT</b>  |                      |   |                        |                         |                        |       |
| SCL, SDA Input Low Level   |                      |   |                        |                         | 0.3 x V <sub>AVL</sub> | V     |
| SCL, SDA Input High Level  |                      |   | 0.7 x V <sub>AVL</sub> |                         |                        | V     |
| SCL, SDA Input Hysteresis  |                      |   |                        | 0.05 x V <sub>AVL</sub> |                        | V     |
| SCL, SDA Logic Input Current   |                      | SDA = SCL = 5.5V  | -10                    |                         | +10                    | μA    |
| SCL, SDA Input Capacitance   |                      | (Note 1)  |                        | 10                      |                        | pF    |
| SDA Output Low Voltage   |                      | Sinking 20mA  |                        |                         | 0.4                    | V     |
| Output Low Voltage INTB  |                      | I <sub>SINK</sub> = 1mA                                   |                        |                         | 0.4                    | V     |
| Output High Leakage INTB   |                      | V <sub>INTB</sub> = 5.5V, T <sub>A</sub> = +25°C          | -1                     | 0                       | +1                     | μA    |
|  |                      | V <sub>INTB</sub> = 5.5V, T <sub>A</sub> = +85°C (Note 1) |                        | 0.1                     |                        |       |
| <b>INTERFACE / I<sup>2</sup>C COMPATIBLE INTERFACE TIMING FOR STANDARD, FAST, AND FAST-MODE PLUS</b> |                      |   |                        |                         |                        |       |
| Clock Frequency  | f <sub>SCL</sub>     |   |                        |                         | 1000                   | kHz   |
| Hold Time (Repeated) START Condition   | t <sub>HD;STA</sub>  |   | 0.26                   |                         |                        | μs    |
| CLK Low Period   | t <sub>LOW</sub>     |   | 0.5                    |                         |                        | μs    |
| CLK High Period  | t <sub>HIGH</sub>    |   | 0.26                   |                         |                        | μs    |
| Set-Up Time Repeated START Condition   | t <sub>SU;STA</sub>  |   | 0.26                   |                         |                        | μs    |
| DATA Hold Time   | t <sub>HD;DAT</sub>  |   | 0                      |                         |                        | μs    |
| DATA Valid Time  | t <sub>VD;DAT</sub>  |   |                        |                         | 0.45                   | μs    |
| DATA Valid Acknowledge Time  | t <sub>VD;ACK</sub>  |   |                        |                         | 0.45                   | μs    |
| DATA Set-Up time   | t <sub>SU;DAT</sub>  |   | 50                     |                         |                        | ns    |
| Set-Up Time for STOP Condition   | t <sub>SU;STO</sub>  |   | 0.26                   |                         |                        | μs    |
| Bus-Free Time Between STOP and START   | t <sub>BUF</sub>     |   | 0.5                    |                         |                        | μs    |

**Electrical Characteristics (continued)**

(V<sub>SYS</sub> = 7.6V, V<sub>BATT</sub> = 7.6V, V<sub>CHGIN</sub> = 9V, T<sub>A</sub> = -40°C to +85°C. T<sub>A</sub> = +25°C (typ). Limits are production tested at T<sub>A</sub> = +25°C. Limits over the operating temperature range and relevant supply voltage range are guaranteed by design and characterization.)

| PARAMETER   | SYMBOL              | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---------------------|------------|-----|-----|-----|-------|
| Pulse Width of Spikes that Must be Suppressed by the Input Filter                                 |                     |            |     | 50  |     | ns    |
| <b>INTERFACE / I<sup>2</sup>C COMPATIBLE INTERFACE TIMING FOR HS-MODE (C<sub>B</sub> = 100pF)</b> |                     |            |     |     |     |       |
| Clock Frequency   | f <sub>SCL</sub>    |            |     |     | 3.4 | MHz   |
| Set-Up Time Repeated START Condition  | t <sub>SU;STA</sub> |            | 160 |     |     | ns    |
| Hold Time (Repeated) START Condition  | t <sub>HD;STA</sub> |            | 160 |     |     | ns    |
| CLK Low Period  | t <sub>LOW</sub>    |            | 160 |     |     | ns    |
| CLK High Period   | t <sub>HIGH</sub>   |            | 60  |     |     | ns    |
| DATA Set-Up Time  | t <sub>SU;DAT</sub> |            | 10  |     |     | ns    |
| DATA Hold Time  | t <sub>HD;DAT</sub> |            | 0   |     |     | ns    |
| Set-Up Time for STOP Condition  | t <sub>SU;STO</sub> |            | 160 |     |     | ns    |
| Pulse Width of Spikes that Must be Suppressed by the Input Filter                                 |                     |            |     | 10  |     | ns    |
| <b>INTERFACE / I<sup>2</sup>C COMPATIBLE INTERFACE TIMING FOR HS-MODE (C<sub>B</sub> = 400pF)</b> |                     |            |     |     |     |       |
| Clock Frequency   | f <sub>SCL</sub>    |            |     |     | 1.7 | MHz   |
| Set-Up Time Repeated START Condition  | t <sub>SU;STA</sub> |            | 160 |     |     | ns    |
| Hold Time (Repeated) START Condition  | t <sub>HD;STA</sub> |            | 160 |     |     | ns    |
| CLK Low Period  | t <sub>LOW</sub>    |            | 320 |     |     | ns    |
| CLK High Period   | t <sub>HIGH</sub>   |            | 120 |     |     | ns    |
| DATA Set-Up time  | t <sub>SU;DAT</sub> |            | 10  |     |     | ns    |
| DATA Hold Time  | t <sub>HD;DAT</sub> |            | 0   |     |     | ns    |
| Set-Up Time for STOP Condition  | t <sub>SU;STO</sub> |            | 160 |     |     | ns    |
| Pulse Width of Spikes that Must be Suppressed by the Input Filter                                 |                     |            |     | 10  |     | ns    |

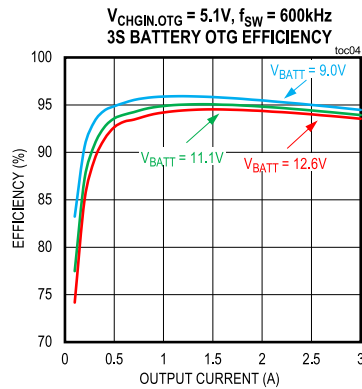
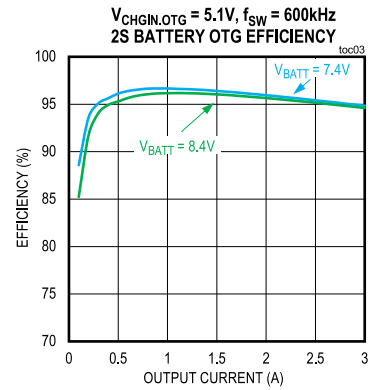
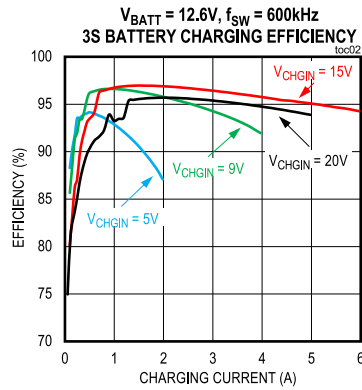
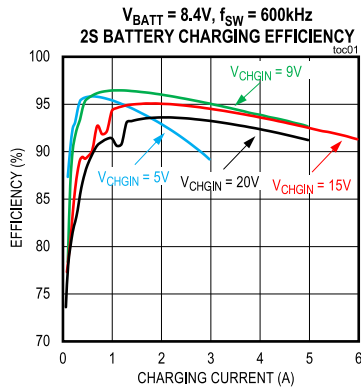
**Note 1:** Internal design target.

**Note 2:** Guaranteed by design. Not production tested.

**Note 3:** Guaranteed by design. Production tested through scan.

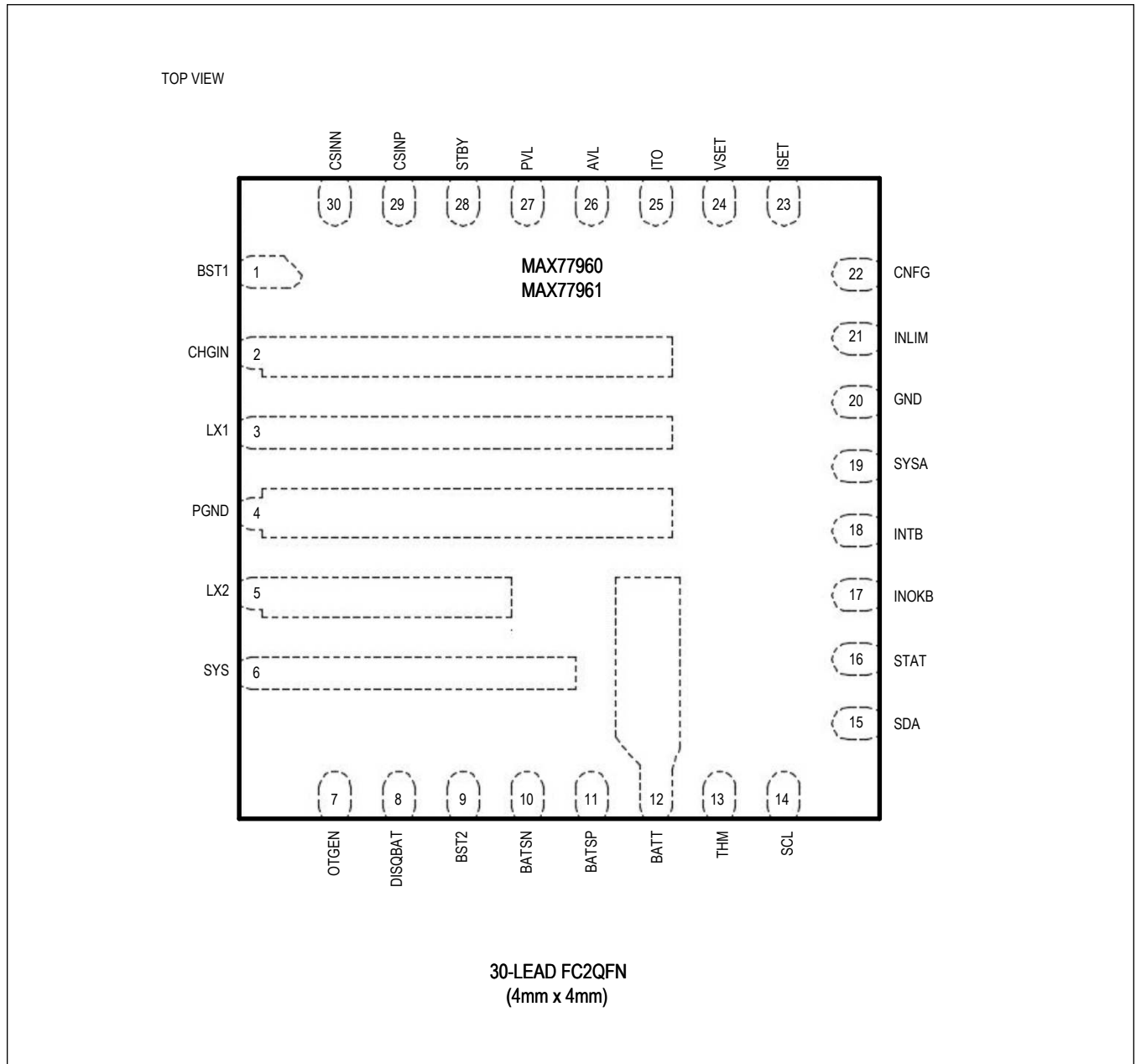
Typical Operating Characteristics

(C<sub>CHGIN</sub> = 10μF, C<sub>SYS</sub> = 2x47μF, L = 3.3μH (CMLE063T-3R3MS), T<sub>A</sub> = +25°C unless otherwise noted.)



Pin Configuration

MAX77960/MAX77961



## Pin Description

| PIN | NAME    | FUNCTION   |
|-----|---------|--|
| 1   | BST1    | High-Side Input MOSFET Driver Supply. Bypass BST1 to LX1 with a 0.22μF/6.3V capacitor.   |
| 2   | CHGIN   | Buck-Boost Charger Input. CHGIN is also the buck output when the charger is operating in the reverse mode. Bypass with two 10μF/35V ceramic capacitors from CHGIN to PGND.   |
| 3   | LX1     | Inductor Connection One. Connect an inductor between LX1 and LX2.  |
| 4   | PGND    | Power Ground for Buck-Boost Low-Side MOSFETs   |
| 5   | LX2     | Inductor Connection Two. Connect an inductor between LX1 and LX2.  |
| 6   | SYS     | System Supply Output. Bypass SYS to PGND with two 47μF/25V ceramic capacitors.   |
| 7   | OTGEN   | Active-High Input. Connect the OTGEN pin to high enables the OTG function. When OTGEN pin is pulled low, the OTG enable function is controlled by I <sup>2</sup> C. To pull the OTGEN pin low with a pulldown resistor, the resistance must be lower than 44kΩ.  |
| 8   | DISQBAT | Active-High Input. Connect high to disable the integrated Q <sub>BAT</sub> FET between SYS and BATT. Charging is disabled when DISQBAT connects to high. When DISQBAT is pulled low, Q <sub>BAT</sub> FET control is defined in the <a href="#">Q<sub>BAT</sub> and DC-DC Control—Configuration Table</a> . To pull the DISQBAT pin low with a pulldown resistor, the resistance must be lower than 44kΩ.  |
| 9   | BST2    | High-Side Output MOSFET Driver Supply. Bypass BST2 to LX2 with a 0.22μF/6.3V capacitor.  |
| 10  | BATSN   | Battery Voltage Differential Sense Negative Input. Connect to the negative terminal of the battery pack.   |
| 11  | BATSP   | Battery Voltage Differential Sense Positive Input. Connect to the positive terminal of the battery pack.   |
| 12  | BATT    | Battery Power Connection. Connect to the positive terminal of the battery pack. Bypass BATT to PGND with a 10μF/25V capacitor. All BATT pins must be connected together externally.  |
| 13  | THM     | Thermistor Input. Connect a negative temperature coefficient (NTC) thermistor from THM to GND. Connect a resistor equal to the thermistor +25°C resistance from THM to AVL. JEITA-controlled charging available with JEITA_EN = 1. Charging is suspended when the thermistor voltage is outside of the hot and cold limits. Connect THM to GND to disable the thermistor temperature sensor. Connect THM to AVL to emulate battery removal and prevent charging. |
| 14  | SCL     | Serial Interface I <sup>2</sup> C Clock Input  |
| 15  | SDA     | Serial Interface I <sup>2</sup> C Data. Open-drain output.   |
| 16  | STAT    | Charger Status Output. Active-low, open-drain output, connect to the pullup through a 10kΩ resistor. Pulls low when the charging is in progress. Otherwise, STAT is high impedance.<br><br>STAT toggles between low and high (when connected to a pullup rail) during charge. STAT becomes low when top-off threshold is detected and charger enters the done state. STAT becomes high (when connected to a pullup rail) when charge faults are detected.        |
| 17  | INOKB   | Input Power-OK/OTG Power-OK Output. Active-low, open-drain output pulls low when the CHGIN voltage is valid.   |
| 18  | INTB    | Active-Low Open-Drain Interrupt Output. Connect a pullup resistor to the pullup power source.  |
| 19  | SYSA    | SYS Voltage Sensing Input for SYS UVLO and OVLO Detection  |
| 20  | GND     | Analog Ground  |
| 21  | INLIM   | Charger Input Current Limit Setting Input. Connect a resistor (R <sub>INLIM</sub> ) from INLIM to GND programs the charger input current limit. Refer to <a href="#">Table 5</a> .   |
| 22  | CNFG    | Device Configuration Input. Connect a resistor (R <sub>CNFG</sub> ) from CNFG to GND to program the following parameter, see <a href="#">Table 1</a> . <ul style="list-style-type: none"> <li>Number of battery cells in series connection (2S or 3S)</li> </ul>   |

## Pin Description (continued)

| PIN | NAME  | FUNCTION  |
|-----|-------|---|
| 23  | ISET  | Fast-Charge Current Setting Input. Connect a resistor ( $R_{ISET}$ ) from ISET to GND programs the fast charge current. See <a href="#">Table 6</a> .   |
| 24  | VSET  | Charge Termination Voltage Setting Input. Connect a resistor ( $R_{VSET}$ ) from VSET to GND programs the charge termination voltage. See <a href="#">Table 8</a> .   |
| 25  | ITO   | Top-Off Current Setting Input. Connect a resistor ( $R_{ITO}$ ) from ITO to GND programs the top-off current. See <a href="#">Table 7</a> .   |
| 26  | AVL   | Analog Voltage Supply for On-Chip, Low-Noise Circuits. Bypass with a 4.7 $\mu$ F/6.3V ceramic capacitor to GND and connect AVL to PVL with a 4.7 $\Omega$ resistor.   |
| 27  | PVL   | Internal Bias Regulator High Current Output Bypass. Supports internal noisy and high current gate drive loads. Bypass to GND with a minimum 4.7 $\mu$ F/6.3V ceramic capacitor, and connect AVL to PVL with a 4.7 $\Omega$ resistor. Powering external loads from PVL is not recommended, other than pullup resistors.  |
| 28  | STBY  | Active-High Input. Connect high to disable the DC-DC between CHGIN input and SYS output. Battery supplies the system power if the Q <sub>BAT</sub> is on. See <a href="#">Table 2</a> . Connect low to control the DC-DC with the power-path state machine. To pull the STBY pin low with a pulldown resistor, the resistance must be lower than 44k $\Omega$ . |
| 29  | CSINP | Input Current-Sense Positive Input  |
| 30  | CSINN | Input Current-Sense Negative Input  |

## Detailed Description

### Charger Configuration

The MAX77960/MAX77961 are highly flexible, highly integrated switch mode charger. Autonomous charging inputs configure the charger without host I<sup>2</sup>C interface, see the [Autonomous Charging](#) section for more details. The MAX77960/MAX77961 have an I<sup>2</sup>C interface that allows the host controller to program and monitor the charger. Charger configuration registers, interrupt, interrupt mask, and status registers are described in the [Register Map](#).

### Device Configuration Input (CNFG)

The CNFG is the MAX77960/MAX77961's configuration input for the number of battery cells in series connection (2S or 3S).

Connect a resistor (R<sub>CNFG</sub>) from CNFG to GND to program. See [Table 1](#).

**Table 1. CNFG Program Options Lookup Table**

| PART NUMBER                      | SWITCHING FREQUENCY (MHz) | NUMBER OF SERIES BATTERY CELLS | R <sub>CNFG</sub> (Ω) |
|----------------------------------|---------------------------|--------------------------------|-----------------------|
| MAX77960EFV06+<br>MAX77961EFV06+ | 0.6                       | 2                              | Tied to PVL or 86600  |
|                                  |                           | 3                              | 8660                  |

### CHGIN Standby Input (STBY)

The host can reduce the MAX77960/MAX77961's CHGIN supply current by driving STBY pin to high or setting STBY\_EN bit to 1. When STBY is pulled high or STBY\_EN bit is set to 1, the DC-DC turns off. When STBY is pulled low and STBY\_EN bit is set to 0, the DC-DC is controlled by the power-path state machine. To pull the STBY pin low with a pulldown resistor, the resistance must be lower than 44kΩ.

### Battery to SYS Q<sub>BAT</sub> Disable Input (DISQBAT)

The host can disable the Q<sub>BAT</sub> switch by setting DISIBS bit to 1 or driving DISQBAT pin to high. Charging stops when Q<sub>BAT</sub> switch is disabled.

When DISQBAT is pulled low and DISIBS bit is set to 0, Q<sub>BAT</sub> FET control is defined in [Table 2](#). To pull the DISQBAT pin low with a pulldown resistor, the resistance must be lower than 44kΩ.

**Q<sub>BAT</sub> and DC-DC Control—Configuration Table**

The Q<sub>BAT</sub> control and the DC-DC control depend on both hardware pins (OTGEN, DISQBAT, and STBY) and their associated I<sup>2</sup>C registers.

**Table 2. Q<sub>BAT</sub> and DC-DC Control Configuration Table**

| OTGEN (PIN) OR<br>MODE [3:0] = 0xA<br>(I <sup>2</sup> C) | DISQBAT (PIN)<br>OR DISIBS (I <sup>2</sup> C) | STBY (PIN) OR<br>STBY_EN (I <sup>2</sup> C) | Q <sub>BAT</sub>   | DC-DC   |
|--|---|---|--|---|
| 0  | 0   | 0   | Power-path state machine/internal logic control  | Power-path state machine/internal logic control |
| 0  | 0   | 1   | Enable<br>(SYS is powered from battery through Q <sub>BAT</sub> switch while DC-DC is disabled)      | Disable   |
| 0  | 1   | 0   | Disable  | Power-path state machine/internal logic control |
| 0  | 1   | 1   | Disable<br>(SYS is powered from battery through Q <sub>BAT</sub> body diode while DC-DC is disabled) | Disable   |
| 1  | x   | x   | Enable   | Power-path state machine/internal logic control |

**Thermistor Input (THM)**

The thermistor input can be utilized to achieve functions include charge suspension, JEITA-compliant charging and battery removal detection. Thermistor monitoring feature can be disabled by connecting the THM pin to ground.

**Charge Suspension**

The THM input connects to an external negative temperature coefficient (NTC) thermistor to monitor battery or system temperature. Charging stops when the thermistor temperature is out of range ( $T < T_{COLD}$  or  $T > T_{HOT}$ ). The charge timers are reset and the CHG\_DTLS[3:0], CHG\_OK register bits report the charging suspension status and CHG\_I interrupt bit is set. When the thermistor comes back into range ( $T_{COLD} < T < T_{HOT}$ ), charging resumes and the charge timer restarts.

**JEITA-Compliant Charging**

JEITA-compliant charging is available with JEITA\_EN = 1. See the [JEITA Compliance](#) section for more details.

**Battery Removal Detection**

Connecting THM to AVL emulates battery removal and prevents charging.

**Disable Thermistor Monitoring**

Connecting THM to GND disables the thermistor monitoring function, and JEITA-controlled charging is unavailable in this configuration. The MAX77960/MAX77961 detect an always-connected battery when THM is grounded, and charging starts automatically when a valid adapter is plugged in. In applications with removable batteries, do not connect THM to GND because the MAX77960/MAX77961 cannot detect battery removal when THM is grounded. Instead, connecting THM to the thermistor pin in the battery pack is recommended.



Since the thermistor monitoring circuit employs an external bias resistor from THM to AVL, the thermistor is not limited only to 10kΩ (at +25°C). Any resistance thermistor can be used as long as the value is equivalent to the thermistors +25°C resistance. For example, with a 10kΩ at R<sub>TB</sub> resistor, the charger enters a temperature suspend state when the thermistor resistance falls below 3.97kΩ (too hot) or rises above 28.7kΩ (too cold). This corresponds to 0°C to +50°C range when using a 10kΩ NTC thermistor with a beta of 3500. The general relation of thermistor resistance to temperature is defined by the following equation:

$$R_T = R_{25} \times e^{\left\{ \beta \times \left( \frac{1}{T+273^\circ\text{C}} - \frac{1}{298^\circ\text{C}} \right) \right\}}$$

where:

R<sub>T</sub> = The resistance in Ω of the thermistor at temperature T in Celsius

R<sub>25</sub> = The resistance in Ω of the thermistor at +25°C

β = The material constant of the thermistor, which typically ranges from 3000k to 5000k

T = The temperature of the thermistor in °C

Some designs might prefer other thermistor temperature limits. Threshold adjustment can be accommodated by changing R<sub>TB</sub>, connecting a resistor in series and/or in parallel with the thermistor, or using a thermistor with different β. For example, a +45°C hot threshold and 0°C cold threshold can be realized by using a thermistor with a β to 4250 and connecting 120kΩ in parallel. Since the thermistor resistance near 0°C is much higher than it is near +50°C, a large parallel resistance lowers the cold threshold, while only slightly lowering the hot threshold. Conversely, a small series resistance raises the cold threshold, while only slightly raising the hot threshold. Raising R<sub>TB</sub> raises both the hot and cold threshold, while lowering R<sub>TB</sub> lowers both thresholds.

Since AVL is active whenever a valid input power is connected at DC, thermistor bias current flows at all times, even when charging is disabled. When using a 10kΩ thermistor and a 10kΩ pullup to ADCREF, this results in an additional 250μA load. This load can be reduced to 25μA by instead using a 100kΩ thermistor and 100kΩ pullup resistor.

**Table 3. Trip Temperatures for Different Thermistors**

| THERMISTOR          |      |                     |                     |                     | TRIP TEMPERATURES      |                        |                        |                       |
|---------------------|------|---------------------|---------------------|---------------------|------------------------|------------------------|------------------------|-----------------------|
| R <sub>25</sub> (Ω) | β    | R <sub>TB</sub> (Ω) | R <sub>15</sub> (Ω) | R <sub>45</sub> (Ω) | T <sub>COLD</sub> (°C) | T <sub>COOL</sub> (°C) | T <sub>WARM</sub> (°C) | T <sub>HOT</sub> (°C) |
| 10000               | 3380 | 10000               | 14826               | 4900                | -0.8                   | +14.7                  | +42.6                  | +61.4                 |
| 10000               | 3940 | 10000               | 15826               | 4354                | +2.6                   | +16.1                  | +40.0                  | +55.7                 |
| 47000               | 4050 | 47000               | 75342               | 19993               | +3.2                   | +16.4                  | +39.6                  | +54.8                 |
| 100000              | 4250 | 100000              | 164083              | 40781               | +4.1                   | +16.8                  | +38.8                  | +53.2                 |

### Autonomous Charging

The MAX77960/MAX77961 support autonomous charging without I<sup>2</sup>C. In applications without I<sup>2</sup>C serial communication, use the following pins to configure the MAX77960/MAX77961 charger:

CNFG, INLIM, ITO, ISET, VSET, OTGEN, DISQBAT, STBY.

The INLIM, ITO, ISET, and VSET pins are used to program the charger's input current limit, top-off current, constant charging current, and termination voltage.

Connect a valid resistor from each of these pins to ground to program the charger. See the [Pin Description](#) for details.

Connect all four pins (INLIM, ITO, ISET, VSET) to PVL to use the default values for the associated charger registers.

For autonomous charging, it is considered an abnormal condition if some of these pins (INLIM, ITO, ISET, VSET) connect to a valid resistor, but others do not (for example open or connects to PVL or connects to a resistor that is out of range). When this happens, the MAX77960/MAX77961 allow the DC-DC to switch and regulate the SYS voltage, but disable charging for safety reasons. The STAT pin reports no charge.

**Table 4. INLIM, ITO, ISET, and VSET Pin Connections for Autonomous Charging**

| INLIM PIN             | ITO PIN        | ISET PIN       | VSET PIN       | AUTONOMOUS CHARGING                                      |
|-----------------------|----------------|----------------|----------------|--|
| Valid resistor        | Valid resistor | Valid resistor | Valid resistor | Normal, charger configuration is programmed by resistors |
| Tied to PVL           | Tied to PVL    | Tied to PVL    | Tied to PVL    | Normal, charger configuration uses default values        |
| All other connections |                |                |                | Abnormal, no charging                                    |

**Charger Input Current Limit Setting Input (INLIM)**

When a valid charge source is applied to CHGIN, the MAX77960/MAX77961 limit the current drawn from the charge source to the value programmed with INLIM pin.

The default charger input current limit is programmed with the resistance from INLIM to GND. See [Table 5](#).

If I<sup>2</sup>C is used in the application, the CHGIN input current limit can also be reprogrammed with CHGIN\_ILIM[6:0] register bits after the devices power up. Connect INLIM pin to PVL to use I<sup>2</sup>C default settings.

**Table 5. INLIM Program Options Lookup Table**

| R <sub>INLIM</sub> (Ω) | MAX77960   | MAX77961   |
|------------------------|--|--|
|                        | CHGIN INPUT CURRENT LIMIT (mA)<br>DEFAULT VALUE OF CHGIN_ILIM[6:0] | CHGIN INPUT CURRENT LIMIT (mA)<br>DEFAULT VALUE OF CHGIN_ILIM[6:0] |
| Tied to PVL            | 500  | 500  |
| 226000                 | 100  | 100  |
| 178000                 | 200  | 200  |
| 140000                 | 300  | 300  |
| 110000                 | 400  | 400  |
| 86600                  | 500  | 500  |
| 69800                  | 1000   | 1000   |
| 54900                  | 1500   | 1500   |
| 39200                  | 2000   | 2000   |
| 22600                  | 2500   | 2500   |
| 17800                  | 3000   | 3000   |
| 14000                  | N/A  | 3500   |
| 11000                  | N/A  | 4000   |
| 8660                   | N/A  | 4500   |
| 6980                   | N/A  | 5000   |
| 5490                   | N/A  | 6000   |

**Fast-Charge Current Setting Input (ISET)**

When a valid input source is present, the battery charger attempts to charge the battery with a fast-charge current programmed with ISET pin.

The default fast-charge current is programmed with the resistance from ISET to GND. See [Table 6](#).

If I<sup>2</sup>C is used in the application, the fast-charge current can also be reprogrammed with CHGCC[5:0] register bits after the devices power up. Connect ISET pin to PVL to use I<sup>2</sup>C default settings.

**Table 6. ISET Program Options Lookup Table**

| R <sub>ISET</sub> (Ω) | MAX77960<br>FAST-CHARGE CURRENT SELECTION (mA)<br>DEFAULT VALUE OF CHGCC[5:0] | MAX77961<br>FAST-CHARGE CURRENT SELECTION (mA)<br>DEFAULT VALUE OF CHGCC[5:0] |
|-----------------------|---|---|
| Tied to PVL           | 450   | 450   |
| 226000                | 100   | 100   |
| 178000                | 200   | 200   |
| 140000                | 300   | 300   |
| 110000                | 400   | 400   |
| 86600                 | 500   | 500   |
| 69800                 | 1000  | 1000  |
| 54900                 | 1500  | 1500  |
| 39200                 | 2000  | 2000  |
| 22600                 | 2500  | 2500  |
| 17800                 | 3000  | 3000  |
| 14000                 | N/A   | 3500  |
| 11000                 | N/A   | 4000  |
| 8660                  | N/A   | 4500  |
| 6980                  | N/A   | 5000  |
| 5490                  | N/A   | 6000  |

**Top-Off Current Setting Input (ITO)**

When the battery charger is in the top-off state, the top-off charge current is programmed by ITO pin.

The default top-off charge current is programmed with the resistance from ITO to GND. See [Table 7](#).

If I<sup>2</sup>C is used in the application, the top-off current can also be reprogrammed with TO\_ITH[2:0] register bits after the device powers up. Connect ITO pin to PVL to use I<sup>2</sup>C default settings.

**Table 7. ITO Program Options Lookup Table**

| R <sub>ITO</sub> (Ω) | TOP-OFF CURRENT THRESHOLD (mA)<br>DEFAULT VALUE OF TO_ITH[2:0] |
|----------------------|--|
| Tied to PVL          | 100  |
| 226000               | 100  |
| 178000               | 200  |
| 140000               | 300  |
| 110000               | 400  |
| 86600                | 500  |
| 69800                | 600  |

**Charge Termination Voltage Setting Input (VSET)**

The default charge termination voltage is programmed with the resistance from VSET to GND. See [Table 8](#).

If I<sup>2</sup>C is used in the application, the charge termination voltage can also be reprogrammed with CHG\_CV\_PRM[5:0] register bits after the device powers up. Connect the VSET pin to PVL to use I<sup>2</sup>C default settings.

**Table 8. VSET Program Options Lookup Table**

| R <sub>VSET</sub> (Ω) | CHARGE TERMINATION VOLTAGE SETTING - 2S (V)<br>DEFAULT VALUE OF CHG_CV_PRM[5:0] | CHARGE TERMINATION VOLTAGE SETTING - 3S (V)<br>DEFAULT VALUE OF CHG_CV_PRM[5:0] |
|-----------------------|---|---|
| Tied to PVL           | 8.0   | 12.0  |
| 226000                | 8.0   | 12.0  |
| 178000                | 8.1   | 12.15   |
| 140000                | 8.2   | 12.3  |
| 110000                | 8.3   | 12.45   |
| 86600                 | 8.4   | 12.6  |
| 69800                 | 8.5   | 12.75   |
| 54900                 | 8.6   | 12.9  |
| 39200                 | 8.7   | 13.05   |
| 22600                 | 8.8   | N/A   |
| 17800                 | 8.9   | N/A   |
| 14000                 | 9.0   | N/A   |
| 11000                 | 9.1   | N/A   |
| 8660                  | 9.2   | N/A   |
| 6980                  | 9.26  | N/A   |
| 5490                  | 9.26  | N/A   |

### Switch Mode Charger

The MAX77960/MAX77961 feature a switch mode buck-boost charger for a two-cell or three-cell lithium ion (Li+) or lithium polymer (Li-polymer) battery. The charger operates from a wide input range from 3.5V to 25.4V, ideal for USB-C charging applications. The charger input current limit is programmable from 100mA to 3.15A (MAX77960)/100mA to 6.3A (MAX77961), which is flexible to operate from either an AC-to-DC wall charger or a USB-C adapter.

The MAX77960/MAX77961 offer a high level of integration and do not require any external MOSFETs to operate, which significantly reduces the solution size. They operate with a fixed switching frequency of 600kHz. The battery charging current is programmable from 100mA to 3A (MAX77960)/100mA to 6A (MAX77961) to accommodate small or large capacity batteries.

When the input source is not available, the MAX77960/MAX77961 can be enabled in a reverse buck mode, delivering energy from the battery to the input, CHGIN, commonly known as USB on-the-go (OTG). In OTG mode, the regulated CHGIN voltage is 5.1V with programmable current limit up to 3A.

Maxim's Smart Power Selector architecture makes the best use of the limited adapter power and the battery power to power the system. Adapter power that is not used for the system charges the battery. When system load exceeds the input limit, battery provides additional current to the system up to the BAT to SYS overcurrent threshold, programmable with B2SOVRC[3:0] I<sup>2</sup>C register bits. All power switches for charging and switching the system load between battery and adapter power are integrated on chip—no external MOSFETs required.

Maxim's proprietary process technology allows for low-R<sub>DS(ON)</sub> devices in a small solution size. The resistance between BAT to SYS is 10mΩ (typ), allowing low power dissipation and long battery life.

A multitude of safety features ensure reliable charging. Features include charge timers, watchdog, junction thermal regulation, and over-/undervoltage protection.

### Smart Power Selector (SPS)

The smart power selector (SPS) architecture includes a network of internal switches and control loops that efficiently distributes energy between an external power source (CHGIN), the battery (BAT) and the system (SYS). This architecture allows power path operation with system instant on with a dead battery.

The [Simplified Block Diagram](#) shows the smart power selector switches and gives them the following names: Q<sub>1</sub>, Q<sub>2</sub>, Q<sub>3</sub>, Q<sub>4</sub> and Q<sub>BAT</sub>.

### Power Switches and Current Sense Resistor Descriptions

- CHGIN Current-Sense Resistor: As shown in the [Simplified Block Diagram](#), the CHGIN current is monitored with the input current sensing resistor, R<sub>CS1</sub>, connected between CSINP and CSINN pins.
- DC-DC Switches: Q<sub>1</sub>, Q<sub>2</sub>, Q<sub>3</sub>, and Q<sub>4</sub> are the DC-DC switches that can operate as a buck (step down) or a boost (step up), depending on the external power source and battery voltage conditions.
- Battery-to-System Switch: Q<sub>BAT</sub> is used to control battery charging and discharging operations.

### I<sup>2</sup>C Configuration Register Bits

- MODE[3:0] configures the Smart Power Selector mode to be Charging, OTG or DC-DC mode respectively. See MODE[3:0] register bits in the [Register Map](#) for details.
- VCHGIN\_REG[4:0] sets the CHGIN regulation voltage, when the MAX77960/MAX77961 operate in forward mode (CHGIN has a valid power source). See the [CHGIN Regulation Voltage](#) section for details.
- MINVSYS[2:0] sets the minimum system regulation voltage. See the [SYS Regulation Voltage](#) section for details.
- B2SOVRC[3:0] sets the battery to system discharge overcurrent protection threshold.

### Energy Distribution Priority

- With a valid external power source at CHGIN:
  - The external power source is the primary source of energy.
  - The battery is the secondary source of energy.
  - Energy delivery to SYS has the highest priority.
  - Any remaining energy from the power source that is not required by the system is available to the battery charger.
- With no valid external power source at CHGIN:
  - The battery is the primary source of energy.
  - When OTG mode is enabled, energy delivery to SYS has the highest priority.
  - Any remaining energy from the battery that is not required by the system is available to power the CHGIN.

### CHGIN Regulation Voltage

- In forward mode (when CHGIN is powered from a valid external source), CHGIN voltage is regulated to VCHGIN\_REG[4:0] when a high impedance or current limited source is applied. VCHGIN might experience significant voltage droop from the high-impedance source when the MAX77960/MAX77961 extract high power from the source. Regulating VCHGIN allows the MAX77960/MAX77961 to extract the most power from the power source. See the [Adaptive Input Current Limit \(AICL\) and Input Voltage Regulation](#) section for more detail.
- In reverse mode (OTG), CHGIN voltage is regulated to 5.1V with programmable current limit up to 3A (OTG\_ILIM[2:0]).

**SYS Regulation Voltage**

With a valid external power source at CHGIN:

- When the DC-DC is disabled ( $MODE[3:0] = 0x00$  or  $STBY\_EN = 0b1$  or  $STBY$  pin = high), the  $Q_{BAT}$  switch is fully on and  $V_{SYS} = V_{BATT} - I_{BATT} \times R_{BAT2SYS}$ .
- When the DC-DC is enabled and the charger is disabled ( $MODE[3:0] = 0x04$ ),  $V_{SYS}$  is regulated to  $V_{BATTREG}$  ( $CHG\_CV\_PRM$ ) and  $Q_{BAT}$  is off.
- When the DC-DC is enabled and the charger is enabled ( $MODE[3:0] = 0x05$ ), but in a noncharging state such as Done, Thermistor Suspend, Watchdog Suspend, or Timer Fault,  $V_{SYS}$  is regulated to  $V_{BATTREG}$  ( $CHG\_CV\_PRM$ ) and  $Q_{BAT}$  is off.
- When the DC-DC is enabled and the charger is enabled ( $MODE[3:0] = 0x05$ ) and in a valid charging state such as Precharge or Trickle Charge ( $V_{BATT} < V_{SYSTEMIN} - 500mV$ ),  $V_{SYS}$  is regulated to  $V_{SYSTEMIN}$ . The charger operates as a linear regulator, and the power dissipation can be calculated with  $P = (V_{SYSTEMIN} - V_{BATT}) \times I_{BATT}$ .
- When the DC-DC is enabled and the charger is enabled ( $MODE[3:0] = 0x05$ ) and in a valid charging state such as Fast Charge (CC or CV) or Top-Off ( $V_{BATT} > V_{SYSTEMIN} - 500mV$ ), the  $Q_{BAT}$  switch is fully on, and  $V_{SYS} = V_{BATT} + I_{BATT} \times R_{BAT2SYS}$ .
- In all the modes described above when the power demand on SYS exceeds the input source power limit, the battery automatically provides supplemental power to the system. If the  $Q_{BAT}$  switch is initially off when  $V_{SYS}$  drops to  $V_{BATT} - V_{BSREG}$ , the  $Q_{BAT}$  switch turns on, and  $V_{SYS}$  is regulated to  $V_{BATT} - V_{BSREG}$ .

Without a valid external power source at CHGIN, including with OTG mode ( $MODE[3:0] = 0x0A$ ):

- The  $Q_{BAT}$  switch is fully on, and  $V_{SYS} = V_{BATT} - I_{BATT} \times R_{BAT2SYS}$ .

**Power States**

The MAX77960/MAX77961 transition between power states as input/battery and load conditions dictate.

The MAX77960/MAX77961 provide four (4) power states and one (1) no power state. Under power limited conditions, the power path feature maintains SYS and USB-OTG loads at the expense of battery charge current. In addition, the battery supplements the input power when needed. See the [Smart Power Selector \(SPS\)](#) section for more details. As shown, transitions between power states are initiated by detection/removal of valid power sources, OTG events, and undervoltage conditions.

1. NO INPUT POWER,  $MODE[3:0] = \text{undefined}$ : No input adapter or battery is detected. The charger and system are off. Battery is disconnected.
2. BATTERY-ONLY,  $MODE[3:0] = \text{any mode}$ : CHGIN is invalid or outside the input voltage operating range. Battery is connected to power the SYS load ( $Q_{BAT} = \text{on}$ ).
3. NO CHARGE - DC-DC in FORWARD mode,  $MODE[3:0] = 0x04$ : CHGIN input is valid, DC-DC supplies power to SYS. DC-DC operates from a valid input. Battery is disconnected ( $Q_{BAT} = \text{off}$ ) when SYS load is less than the power that DC-DC can supply.
4. CHARGE - DC-DC in FORWARD mode,  $MODE[3:0] = 0x05$ : CHGIN input is valid, DC-DC supplies power to SYS and charges the battery with  $I_{BATT}$ . DC-DC operates from a valid input.
5. OTG - DC-DC in REVERSE mode (OTG),  $MODE[3:0] = 0x0A$ : OTG is active. Battery is connected to support SYS and OTG loads ( $Q_{BAT} = \text{on}$ ), and charger operates in REVERSE buck mode.

### Powering Up with the Charger Disabled by Default

The MAX77960/MAX77961's default power state is CHARGE - DC-DC in FORWARD mode, MODE[3:0] = 0x05. For battery authentication/safety purposes, the MAX77960/MAX77961 can be configured to keep charging disabled while allowing the DC-DC to switch and regulate the SYS voltage when power is applied to CHGIN. To implement this and enable the charger when appropriate:

- Connect at least one of the INLIM, ITO, ISET or VSET pins to a valid resistor while tying the others (at least one) to PVL. CHG\_DTLS = 0x05 and CHG\_OK = 0.
- The system processor can configure the charger through the I<sup>2</sup>C interface.
- The system processor enables charging by setting COMM\_MODE to 1 (default is 0).

See [Wide-Input I<sup>2</sup>C Programmable Charger with Charger Disabled](#) for a pin connection example. Pin INLIM is connected to a valid resistor while ITO, ISET and VSET tie to PVL. The default input current limit is programmed by R<sub>INLIM</sub>, while default top-off current, constant charging current, and termination voltage use their default value. The system processor can re-program all four settings through the I<sup>2</sup>C interface if needed.

### Input Validation

The charger input is compared with several voltage thresholds to determine if it is valid. A charger input must meet the following characteristics to be valid:

- CHGIN must be above V<sub>CHGIN\_UVLO</sub> to be valid. Once CHGIN is above UVLO threshold, the information is latched and can only be reset when charger is in adaptive input current loop (AICL) and input current is lower than IULO threshold of 30mA.
- CHGIN must be below its overvoltage lockout threshold (V<sub>CHGIN\_OVLO</sub>).

The devices generate a CHGIN\_I interrupt (maskable with CHGIN\_M bit) when the CHGIN status changes. Read the CHGIN input status with CHGIN\_OK and CHGIN\_DTLS[1:0] register bits.

### Adaptive Input Current Limit (AICL) and Input Voltage Regulation

The MAX77960/MAX77961 feature input power management to extract maximum input power while avoiding input source overload. The adaptive input current limit (AICL) and the input voltage regulation (CHGIN\_REG) features allow the charger to extract more energy from relatively high resistance charge sources with long cables, noncompliant USB hubs or current limited adapters. In addition, the input power management allows the MAX77960/MAX77961 to perform well with adapters that have poor transient load responses.

With a high-resistance source, the charger input voltage drops substantially when it draws large current from the source. The charger's input voltage regulation loop automatically reduces the current drawn from the input to regulate the input voltage at V<sub>CHGIN\_REG</sub>. If the input current is reduced to I<sub>CHGIN\_REG\_OFF</sub> (50mA typ) and the input voltage is still below V<sub>CHGIN\_REG</sub>, the charger input turns off. V<sub>CHGIN\_REG</sub> is programmable with VCHGIN\_REG[4:0] register bits.

With a current limited source, if the MAX77960/MAX77961's input current limit is programmed above the current limit of the adapter, the charger input voltage starts to drop when the input current drawn exceeds the source current limit. The charger's input voltage regulation loop allows the MAX77960/MAX77961 to reduce its input current and operate at the current limit of the adapter.

When operating with the input voltage regulation loop active, an AICL\_I interrupt is generated, AICL\_OK sets to 0. The device prioritize system energy delivery over battery charging. See the [Smart Power Selector \(SPS\)](#) section for more details.

To extract most input power from a current limited charge source, monitor the AICL\_OK status while decreasing the CHGIN\_ILIM[6:0] register setting. Setting the CHGIN\_ILIM[6:0] to a reduced to a value below the current limit of the adapter causes the input voltage to rise. Although the CHGIN\_ILIM[6:0] is lowered, more power can be extracted from the adapter when the input voltage rises.

**Input Self-Discharge**

To ensure that a rapid removal and reinsertion of a charge source always results in a charger input interrupt, the charger input presents loading to the input capacitor to ensure that when the charge source is removed, the input voltage decays below the UVLO threshold in a reasonable time (t<sub>INSD</sub>). The input self-discharge is implemented by with a 44kΩ resistor (R<sub>INSD</sub>) from CHGIN input to ground.

**System Self-Discharge with No Power**

To ensure a timely, complete, repeatable, and reliable reset behavior when the system has no power, the MAX77960/MAX77961 actively discharge the BATT and SYS nodes when the adapter is missing, the battery is removed and V<sub>SYS</sub> is less than V<sub>SYSUVLO</sub>. The BATT and SYS discharge resistors are both 600Ω.

**Charger States**

The MAX77960/MAX77961 utilize several charging states to safely and quickly charge batteries as shown in [Figure 1](#) and [Figure 2](#). [Figure 1](#) shows an exaggerated view of a Li+/Li-Poly battery progressing through the following charge states when there is no system load and the die and battery are close to room temperature: Prequalification → Fast-charge → Top-off → Done.

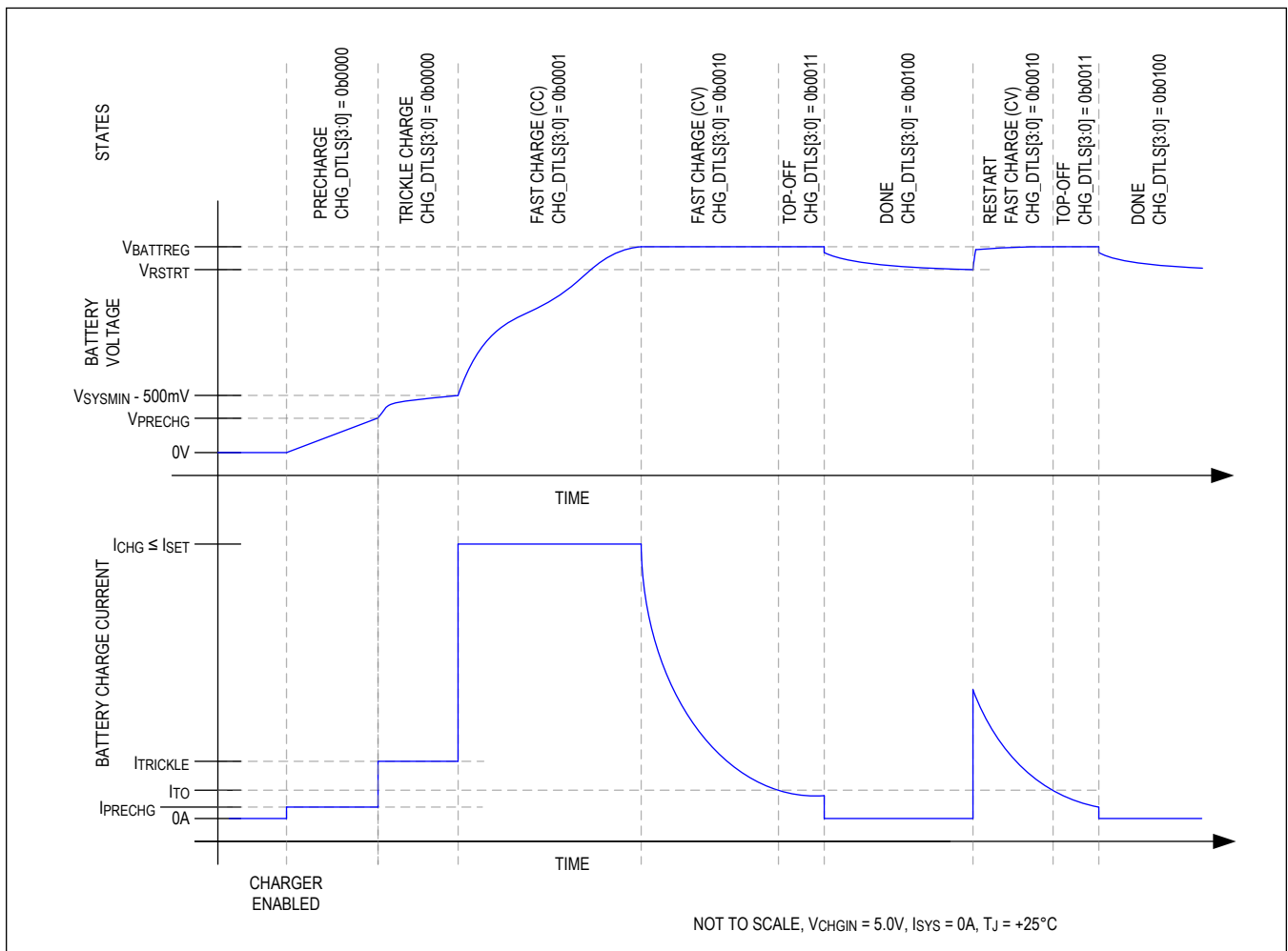


Figure 1. Li Battery Charge Profile



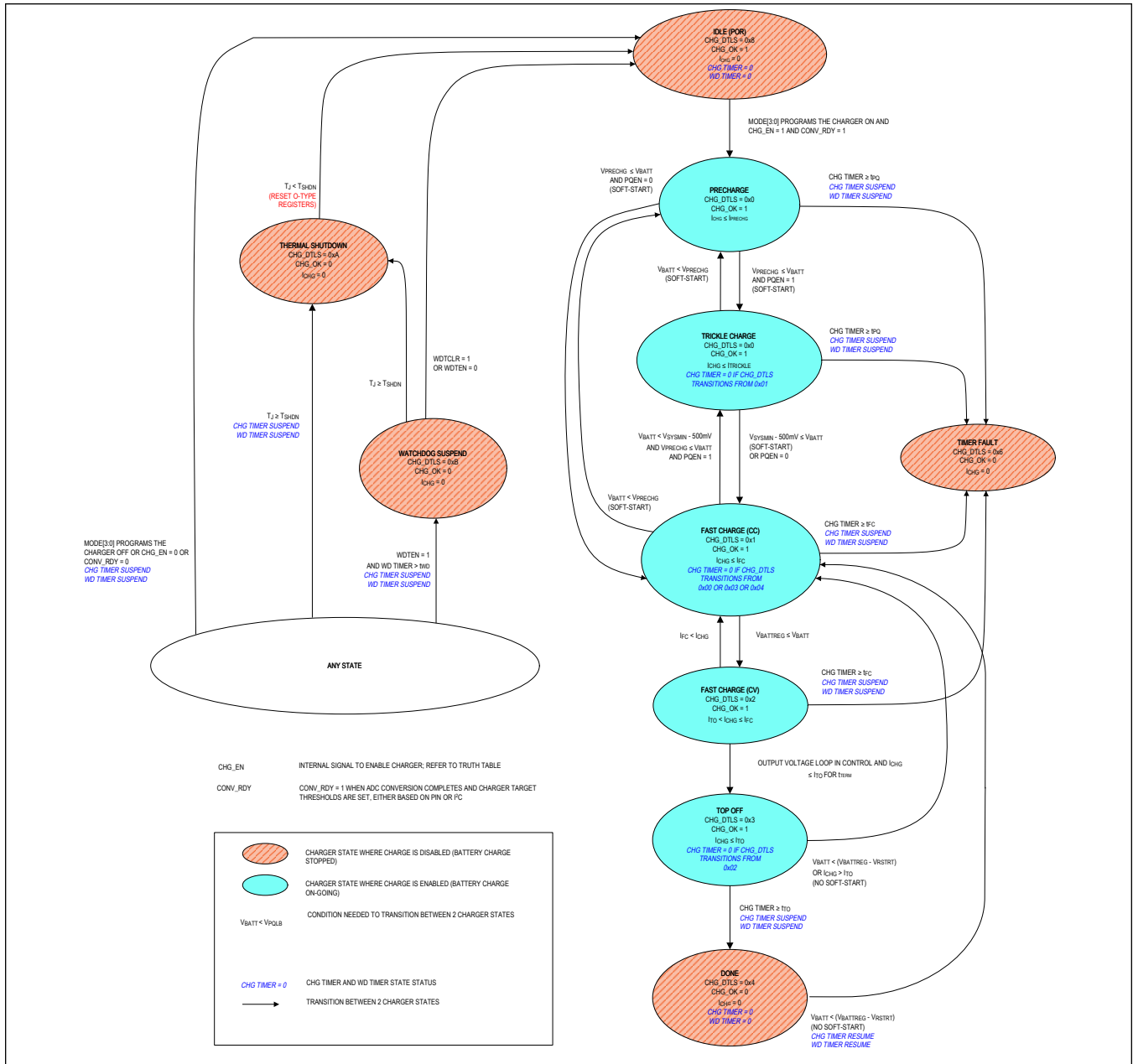


Figure 2. Charger State Diagram

### No Input Power or Charger Disabled Idle State

From any state shown in Figure 2 except thermal shutdown, the no input power or charger disabled state is entered whenever the charger is programmed to be off or the charger input CHGIN is invalid. After being in this state for  $t_{SCIDG}$ , CHG\_DTLS is set to 0x08 and CHG\_OK is set to 1. A CHG\_I interrupt is generated if CHG\_OK was 0 previously.

While in the no input power or charger disabled state, the charger current is 0mA, the watchdog and charge timers are forced to 0, and the power to the system is provided by either the battery or the adapter. When both battery and adapter power are available, the adapter provides primary power to the system and the battery contributes supplemental energy to the system if necessary.

To exit the no input power or charger disabled state, the charger input must be valid and the charger must be enabled.

### Precharge State

As shown in [Figure 2](#), the charger enters the precharge state when the battery voltage is less than  $V_{PRECHG}$ . After being in this state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated if CHG\_OK was 0 previously, CHG\_OK is set to 1 and CHG\_DTLS is set to 0x00. In the precharge state, charge current into the battery is  $I_{PRECHG}$ .

The following events cause the state machine to exit this state:

- Battery voltage rises above  $V_{PRECHG}$  and the charger enters the next state in the charging cycle: Trickle Charge.
- If the battery charger remains in this state for longer than  $t_{PQ}$ , the charger state machine transitions to the Timer Fault state.
- If the watchdog timer is not serviced, the charger state machine transitions to the “Watchdog Suspend” state.

Note that the precharge state works with battery voltages down to 0V. The 0V operation typically allows this battery charger to recover batteries that have an open internal pack protector. Typically, a battery pack's internal protection circuit opens if the battery has seen an overcurrent, undervoltage, or overvoltage. When a battery with an open internal pack protector is used with this charger, the precharge mode current flows into the 0V battery; this current raises the pack's terminal voltage to the level where the internal pack protection switch closes.

Note that a normal battery typically stays in the precharge state for several minutes or less. Therefore a battery that stays in the precharge for longer than  $t_{PQ}$  might be experiencing a problem.

### Trickle Charge State

As shown in [Figure 2](#), the charger state machine is in trickle charge state when  $V_{PRECHG} < V_{BATT} < V_{SYSTEMIN} - 500mV$ . After being in this state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated if CHG\_OK was 0 previously, CHG\_OK is set to 1 and CHG\_DTLS = 0x00.

With PQEN = 1 (default) and the MAX77960/MAX77961 are in the trickle charge state, the current in the battery is less than or equal to  $I_{TRICKLE}$ . When PQEN = 0, the charger skips trickle charge state and transitions directly to fast charge state and the battery charging current is less than or equal to  $I_{FC}$ .

Charge current may be less than  $I_{TRICKLE}/I_{FC}$  for any of the following reasons:

- The charger input is in input current limit.
- The charger input voltage is low.
- The charger is in thermal foldback.
- The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

Typical systems operate with PQEN = 1. When operating with PQEN = 0, the system's software usually sets  $I_{FC}$  to a low value such as 200mA and then monitors the battery voltage. When the battery exceeds a relatively low voltage such as 6V, then the system's software usually increases  $I_{FC}$ .

The following events cause the state machine to exit this state:

- When the battery voltage rises above  $V_{SYSTEMIN} - 500mV$  or the PQEN bit is cleared, the charger enters the next state in the charging cycle: Fast Charge (CC).
- If the battery charger remains in this state for longer than  $t_{PQ}$ , the charger state machine transitions to the Timer Fault state.
- If the watchdog timer is not serviced, the charger state machine transitions to the Watchdog Suspend state.

Note that a normal battery typically stays in the trickle charge state for several minutes or less. Therefore, a battery that stays in trickle charge for longer than  $t_{PQ}$  might be experiencing a problem.

### Fast-Charge Constant Current State

As shown in [Figure 2](#), the charger enters the fast-charge constant current (CC) state when  $V_{SYSTEMIN} - 500mV$  (typ)  $< V_{BATT} < V_{BATTREG}$ . After being in the fast-charge CC state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated if CHG\_OK was 0 previously, CHG\_OK is set to 1 and CHG\_DTLS = 0x01.

In the fast-charge CC state, the battery charging current is less than or equal to  $I_{FC}$ . Charge current can be less than  $I_{FC}$  for any of the following reasons:

- The charger input is in input current limit.
- The charger input voltage is low.
- The charger is in thermal foldback.
- The system load is consuming adapter current. Note that the system load always gets priority over the battery charging current.

The following events cause the state machine to exit this state:

- When the battery voltage rises above  $V_{BATTREG}$ , the charger enters the next state in the charging cycle: Fast Charge (CV).
- If the battery charger remains in this state for longer than  $t_{FC}$ , the charger state machine transitions to the Timer Fault state.
- If the watchdog timer is not serviced, the charger state machine transitions to the Watchdog Suspend state.

The battery charger dissipates the most power in the fast-charge constant current state, which causes the die temperature to rise. If the die temperature exceeds  $T_{REG}$ , the thermal foldback loop is engaged and  $I_{FC}$  is reduced. See the [Thermal Foldback](#) section for more information.

### Fast-Charge Constant Voltage State

As shown in [Figure 2](#), the charger enters the fast-charge constant voltage (CV) state when the battery voltage rises to  $V_{BATTREG}$  from the fast-charge CC state. After being in the fast-charge CV state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated if CHG\_OK was 0 previously, CHG\_OK is set to 1 and CHG\_DTLS = 0x02.

In the fast-charge CV state, the battery charger maintains  $V_{BATTREG}$  across the battery and the charge current is less than or equal to  $I_{FC}$ . As shown in [Figure 1](#), charger current decreases exponentially in this state as the battery becomes fully charged.

The smart power selector control circuitry can reduce the charge current for any of the following reasons:

- The charger input is in input current limit.
- The charger input voltage is low.
- The charger is in thermal foldback.
- The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

The following events cause the state machine to exit this state:

- When the charger current is below  $I_{TO}$  for  $t_{TERM}$ , the charger enters the [Top-Off State](#).
- If the battery charger remains in this state for longer than  $t_{FC}$ , the charger state machine transitions to the [Timer Fault State](#).
- If the watchdog timer is not serviced, the charger state machine transitions to the [Watchdog Timer Suspend State](#).

### Top-Off State

As shown in [Figure 2](#), the top-off state can only be entered from the fast-charge CV state when the charger current decreases below  $I_{TO}$  for  $t_{TERM}$ . After being in the top-off state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated if CHG\_OK was 0 previously, CHG\_OK is set to 1, and CHG\_DTLS = 0x03. In the top-off state the battery charger maintains  $V_{BATTREG}$  across the battery and typically the charge current is less than or equal to  $I_{TO}$ .

The smart power selector control circuitry can reduce the charge current for any of the following reasons:

- The charger input is in input current limit.
- The charger input voltage is low.
- The charger is in thermal foldback.
- The system load is consuming adapter current. Note that the system load always gets priority over the battery charge current.

The following events cause the state machine to exit this state:

- After being in this state for the top-off time ( $t_{TO}$ ), the charger enters the [Done State](#).
- If  $V_{BATT} < V_{BATTREG} - V_{RSTRT}$ , the charger goes back to the [Fast-Charge Constant Current State](#).
- If the watchdog timer is not serviced, the charger state machine transitions to the [Watchdog Timer Suspend State](#).

### Done State

As shown in [Figure 2](#), the battery charger enters its done state after the charger has been in the top-off state for  $t_{TO}$ . After being in this state for  $t_{SCIDG}$ , a CHG\_I interrupt is generated only if CHG\_OK was 0 previously, CHG\_OK is set to 0 and CHG\_DTLS = 0x04.

The following events cause the state machine to exit this state:

- If  $V_{BATT} < V_{BATTREG} - V_{RSTRT}$ , the charger goes back to the [Fast-Charge Constant Current State](#).
- If the watchdog timer is not serviced, the charger state machine transitions to the [Watchdog Timer Suspend State](#).

In the done state, the battery charging current ( $I_{CHG}$ ) is 0A and the charger presents a very low load ( $I_{MBDN}$ ) to the battery. If the system load presented to the battery is low ( $\ll 100\mu A$ ), then a typical system can remain in the done state for many days. If left in the done state long enough, the battery voltage decays below the charging restart threshold ( $V_{RSTRT}$ ) and the charger state machine transitions back into the fast-charge CC state. There is no soft-start (di/dt limiting) during the done to fast-charge state transition.

### Timer Fault State

The battery charger provides both a charge timer and a watchdog timer to ensure safe charging. As shown in [Figure 2](#), the charge timer prevents the battery from charging indefinitely. The time that the charger is allowed to remain in its prequalification states is  $t_{PQ}$ . The time that the charger is allowed to remain in the fast-charge CC and CV states is  $t_{FC}$ , which is programmable with FCHGTIME. Finally the time that the charger is in the top-off state is  $t_{TO}$  which is programmable with TO\_TIME. Upon entering the timer fault state a CHG\_I interrupt is generated without a delay, CHG\_OK is cleared and CHG\_DTLS = 0x06.

The charger is off in the timer fault state. The charger can exit the timer fault state when the charger is programmed to be off then on again through the MODE bits or when DISQBAT pin is toggled from L-H-L. Alternatively, the charger input can be removed and reinserted to exit the timer fault state (see the ANY STATE bubble in [Figure 2](#)).

### Watchdog Timer Suspend State

The battery charger provides both a charge timer and a watchdog timer to ensure safe charging. As shown in [Figure 2](#), the watchdog timer protects the battery from charging indefinitely in the event that the host hangs or otherwise cannot communicate correctly. The watchdog timer is disabled by default with WDTEN = 0. Enable the feature by setting WDTEN = 1. With watchdog timer enabled, the host controller must reset the watchdog timer within the timer period ( $t_{WDT}$ ) in order for the charger to operate properly. Reset the watchdog timer by programming WDTCLR = 0x01.

If the watchdog timer expires, charging stops, a CHG\_I interrupt is generated if CHG\_OK was 1 previously, CHG\_OK is cleared, and CHG\_DTLS indicates that the charger is off because the watchdog timer expired. Once the watchdog timer expires, the charger can be restarted by programming WDTCLR = 0x01. The SYS node can be supported by the battery and/or the adapter through the DC-DC buck while the watchdog timer is expired.

### Thermal Shutdown State

As shown in [Figure 2](#), the state machine enters the thermal shutdown state when the junction temperature ( $T_J$ ) exceeds the device's thermal shutdown threshold ( $T_{SHDN}$ ). When  $T_J$  is close to  $T_{SHDN}$ , the charger would have already folded back the input current to 0A, (see the [Thermal Foldback](#) section for more details), so the charger and the DC-DC are effectively off. Upon entering this state, CHG\_I interrupt is generated if CHG\_OK was 1 previously, CHG\_OK is cleared, and CHG\_DTLS = 0x0A.

In the thermal shutdown state, the charger is off. MODE register (CHG\_CNFG\_00[3:0]) is reset to its default value as well as all O type registers.

**Thermal Management**

The MAX77960/MAX77961 charger use several thermal management techniques to prevent excessive battery and die temperatures.

**Thermal Foldback**

Thermal foldback maximizes the battery charge current while regulating the MAX77960/MAX77961 junction temperature. As shown in [Figure 3](#), when the die temperature exceeds the value programmed by REGTEMP (T<sub>REG</sub>), a thermal limiting circuit reduces the battery charger’s target current by 5%/°C (A<sub>TJREG</sub>) with an analog control loop. When the charger transitions in and out of the thermal foldback loop, a CHG\_I interrupt is generated and the host microprocessor can read the status of the thermal regulation loop with the TREG status bit. Note that an active thermal foldback loop is not an abnormal operation and the thermal foldback loop status does not affect the CHG\_OK bit (only information contained within CHG\_DTLS affects CHG\_OK).

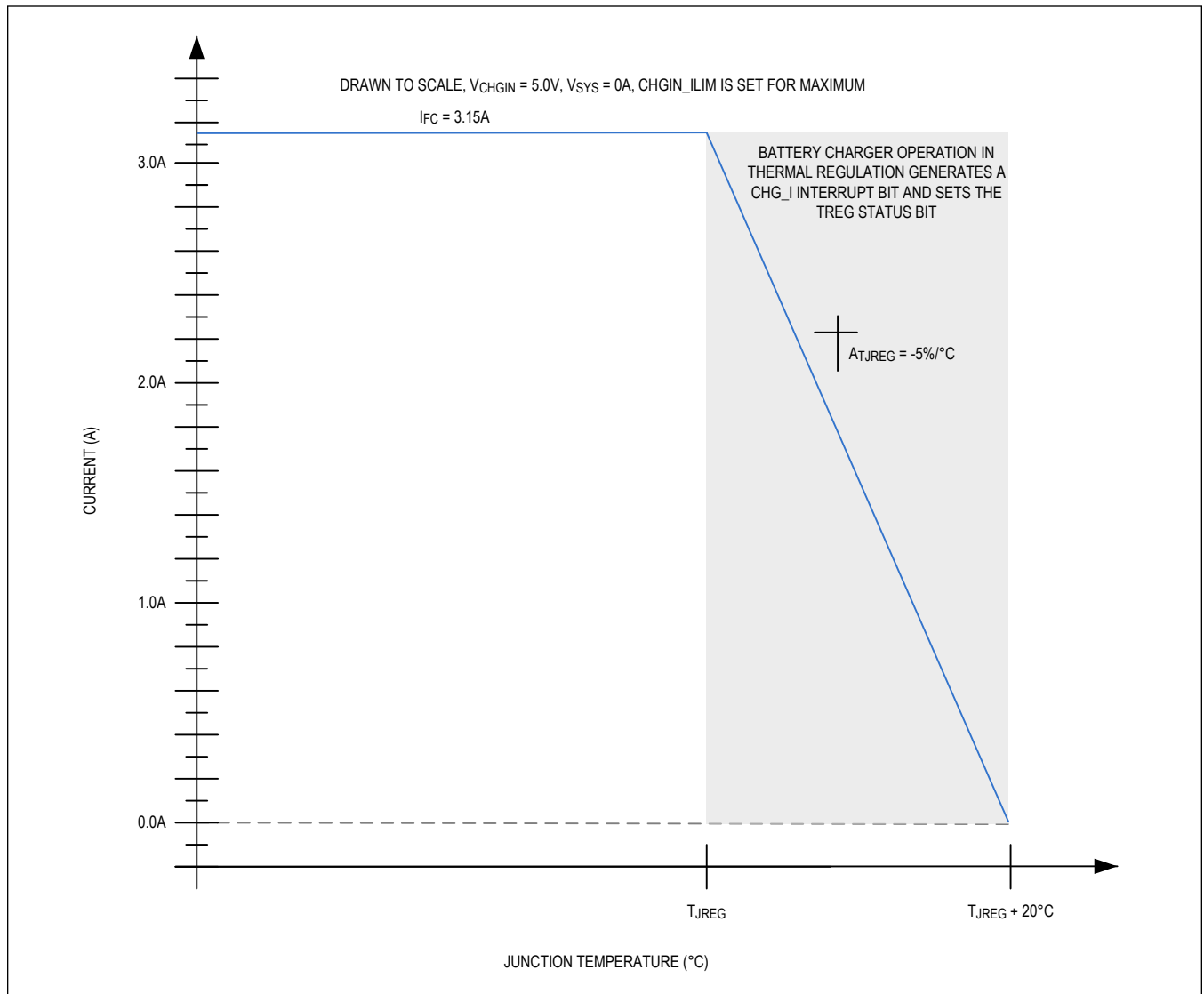


Figure 3. Charge Currents vs. Junction Temperature

**JEITA Compliance**

The MAX77960/MAX77961 safely charge Li+ batteries in accordance with JEITA specifications. The MAX77960/MAX77961 monitor the battery temperature with a NTC thermistor connected at THM pin and automatically adjust the fast-charge current and/or charge termination voltage as the battery temperature varies. JEITA-controlled charging can be disabled by setting JEITA\_EN to 0. CHG\_DTLS and THM\_DTLS registers report JEITA-controlled charging status.

The JEITA controlled fast-charging current (I<sub>CHGCC\_JEITA</sub>) and charge termination voltage (V<sub>CHGCV\_JEITA</sub>) for T<sub>COLD</sub> < T < T<sub>COOL</sub> are programmable with I<sup>2</sup>C bits I<sub>CHGCC\_COOL</sub> and V<sub>CHGCV\_COOL</sub>.

The charge termination voltage for T<sub>WARM</sub> < T < T<sub>HOT</sub> is reduced to (CHG\_CV\_PRM - 180mV/cell), as shown in [Figure 4](#).

Charging is suspended when the battery temperature is too cold or too hot (T < T<sub>COLD</sub> or T<sub>HOT</sub> < T).

Temperature thresholds (T<sub>COLD</sub>, T<sub>COOL</sub>, T<sub>WARM</sub>, and T<sub>HOT</sub>) depend on the thermistor selection. See the [Thermistor Input \(THM\)](#) section for more details.

When battery charge current is reduced by 50%, the charger timer is doubled.

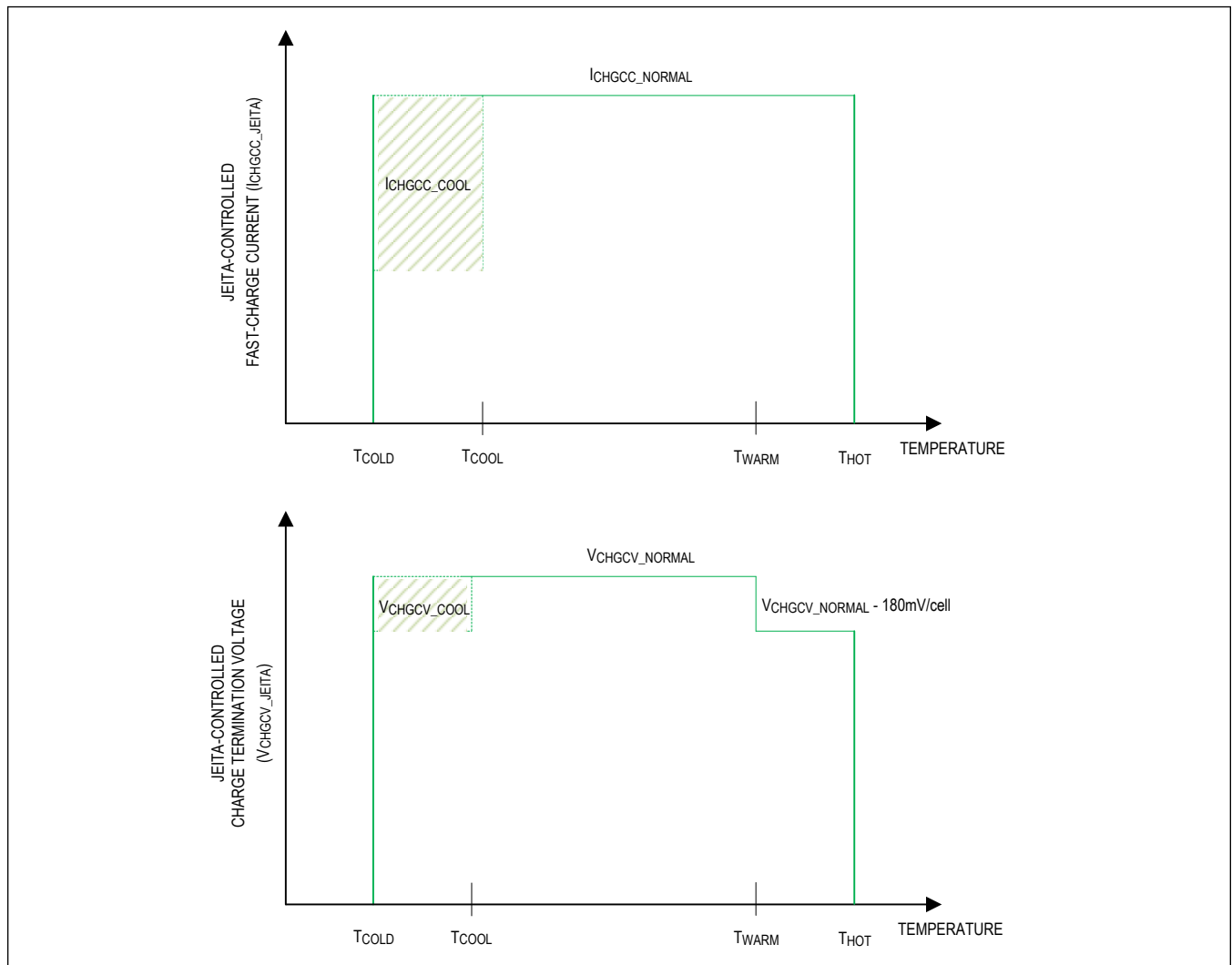


Figure 4. JEITA Compliance

### Thermal Shutdown

The MAX77960/MAX77961 have a die temperature sensing circuit. When the die temperature exceeds the thermal shutdown threshold,  $T_{SHDN}$ , the MAX77960/MAX77961 shut down and reset O type I<sup>2</sup>C registers. There is a 15°C thermal hysteresis. After thermal shutdown, if the die temperature reduces by 15°C, the thermal shutdown bus deasserts and the devices reenables. The battery charger has an independent thermal regulation loop. See the [Thermal Shutdown State](#) section for more details.

### Factory Ship Mode

The MAX77960/MAX77961 support factory ship mode with low battery quiescent current,  $I_{SHDN}$ .

When the input source is not valid, and the device is powered by battery, the devices enter factory ship mode if DISQBAT is pulled high or FSHIP\_MODE bit is set to 1. I<sup>2</sup>C communication is unavailable in factory ship mode. When a valid input source is applied to the device's CHGIN pin, the devices exit factory ship mode. I<sup>2</sup>C communication is enabled, charging is enabled if all conditions to charge are met (e.g., DISQBAT pin is pulled low and MODE[3:0] = 0x05).

### Minimum System Voltage

The system voltage is regulated to the minimum SYS voltage ( $V_{SYSMIN}$ ) when the battery is low ( $V_{BATT} < V_{SYSMIN} - 500mV$ ).

- The charging current is  $I_{PRECHG}$  when  $V_{BATT} < V_{PRECHG}$ .
- The charging current is  $I_{TRICKLE}$  when  $V_{PRECHG} < V_{BATT} < V_{SYSMIN} - 500mV$ .
- The charging current is  $I_{FC}$  when  $V_{SYSMIN} - 500mV < V_{BATT}$ .

### Battery Differential Voltage Sense (BATSP, BATSN)

BAT\_SP and BAT\_SN are differential remote voltage sense lines for the battery. The MAX77960/MAX77961's remote sensing feature improves accuracy and decreases charging time. The thermistor voltage is interpreted with respect to BAT\_SN. For best results, connect BATSP and BATSN as close as possible to the battery connector.

### Battery Overcurrent Alert

Excessive battery discharge current can occur for several reasons such as exposure to moisture, a software problem, an IC failure, a component failure, or a mechanical failure that causes a short circuit. The battery overcurrent alert feature is enabled with B2SOVRC[3:0]; disabling this feature reduces the battery current consumption by  $I_{BOVRC}$ .

When the battery (BATT) to system (SYS) discharge current ( $I_{BATT}$ ) exceeds the programmed overcurrent threshold for at least  $t_{BOVRC}$ , the  $Q_{BAT}$  switch closes to reduce the power loss in the MAX77960/MAX77961. A B2SOVRC\_I and a BAT\_I interrupt are generated, BAT\_OK is cleared, and BAT\_DTLS reports an overcurrent condition. Typically, when the host processor detects this overcurrent interrupt, it executes a housekeeping routine that tries to mitigate the overcurrent situation. If the processor cannot correct the overcurrent within  $t_{OCP}$ , then the MAX77960/MAX77961 turn off the DC-DC.

$t_{OCP}$  time duration can be set through the B2SOVRC\_DTC register bit (Battery to SYS Overcurrent Debounce Time Control): 0x0 (dflt):  $t_{OCP} = 6ms$ , 0x1:  $t_{OCP} = 100ms$ .

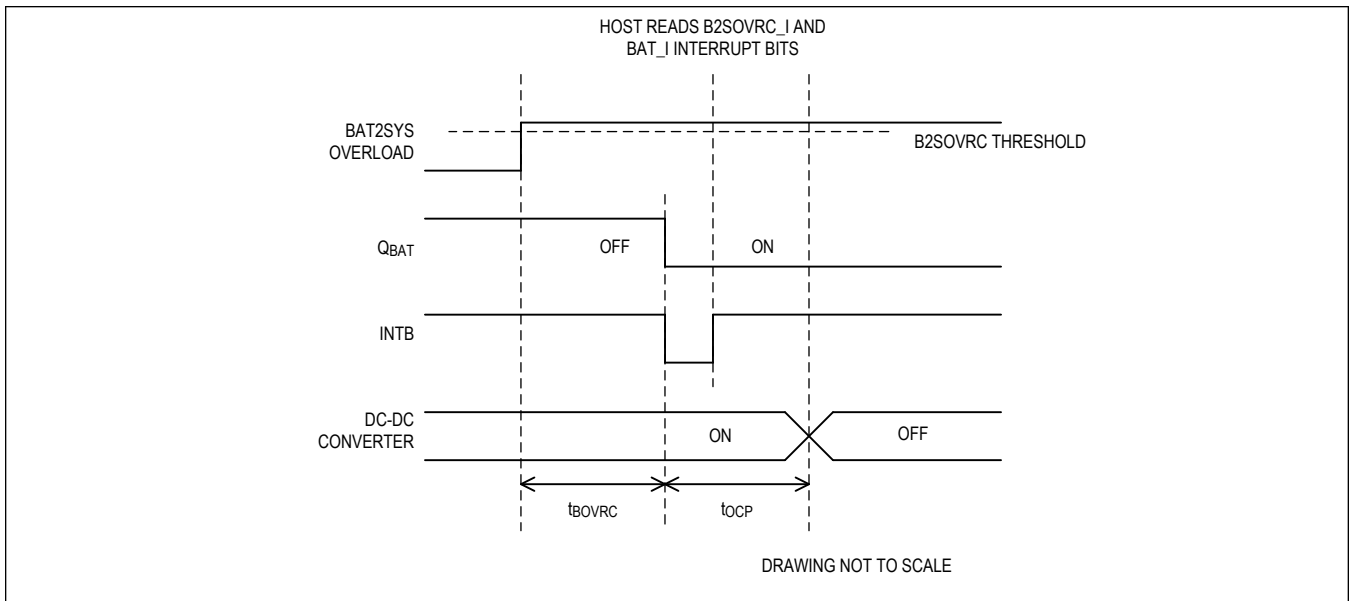


Figure 5. B2SOVRC

**Charger Interrupt Debounce Time**

**Table 9. List of Charger Interrupt Debounce Time**

| INTERRUPT                                      | DEBOUNCE TIME |       |         |     |
|--|---------------|-------|---------|-----|
|  | RISING        |       | FALLING |     |
|  | MIN           | MAX   | MIN     | MAX |
| AICL_I   | 30ms          | —     | 30ms    | —   |
| CHGIN_I  | 7ms           | —     | None    | —   |
| B2SOVRC_I                                      | —             | 3.3ms | None    | —   |
| BAT_I (OV)                                     | 30ms          | —     | None    | —   |
| OTG_PLIM_I (OTG Fault)                         | 37.5ms        | —     | None    | —   |
| OTG_PLIM_I (Buck-Boost Positive Current Limit) | 450µs         | —     | None    | —   |

**Input Power-OK/OTG Power-OK Output (INOKB)**

INOKB is an open-drain and active-low output that indicates CHGIN power-OK status.

When OTG mode is disabled, (OTGEN = low and MODE[3:0] ≠ 0x0A), INOKB pulls low when a valid input source is inserted at CHGIN,  $V_{CHGIN\_UVLO} < V_{CHGIN} < V_{CHGIN\_OVLO}$ .

When OTG mode is enabled, (OTGEN = high or MODE[3:0] = 0x0A), INOKB pulls low to indicate the OTG output power OK when  $V_{CHGIN.OTG.UV} < V_{CHGIN} < V_{CHGIN.OTG.OV}$ .

INOKB can be used as a logic output by adding a 200kΩ pullup resistor to a system IO voltage.

INOKB can be also used as a LED indicator driver by adding a current limiting resistor and a LED to a pullup voltage source.

**Charge Status Output (STAT)**

STAT is an open-drain and active-low output that indicates charge status. STAT can be used as a logic input to the host processor by adding a 200kΩ pullup resistor to a system IO rail and a rectifier (a diode and a capacitor).



**Table 10. Charge Status Indicator by STAT**

| CHARGE STATUS  | STAT  | LOGIC STATE   |
|--|---|---|
| No input   | High impedance  | High  |
| No DC-DC/no charge:<br>valid adapter with STBY_EN = 1 or MODE<br>= 0x0/1/2/3/4 | High impedance  | High  |
| Trickle, precharge, fast charge  | Repeat low and high impedance with 1Hz,<br>50% duty cycle | High, rectified with an external diode<br>and a capacitor |
| Top-off and done   | Low   | Low   |
| Faults   | High impedance  | High  |

**Reverse Buck Mode (OTG)**

The DC-DC converter topology of the MAX77960/MAX77961 allows it to operate as a forward buck-boost converter or as a reverse buck converter. The modes of the DC-DC converter are controlled with MODE[3:0] register bits. When MODE[3:0] = 0x0A or OTGEN = high, the DC-DC converter operates in reverse buck mode, allowing it to source current to CHGIN, commonly referred to as USB OTG mode.

In OTG mode, the DC-DC converter operates in reverse buck mode and regulates V<sub>CHGIN</sub> to V<sub>CHGIN.OTG</sub> (5.1V typ). The current through the CHGIN current-sensing resistor (CSINN, CSINP) is limited to the value programmed by OTG\_ILIM[2:0]. There are eight OTG\_ILIM options to program CHGIN current limit from 500mA to 3A. When the OTG mode is enabled, the unipolar CHGIN transfer function measures current going out of CHGIN. When OTG mode is disabled, the unipolar CHGIN transfer function measures current going into CHGIN.

OTG\_I, OTG\_M, OTG\_OK are the interrupt bit, interrupt mask bit and interrupt status bit associated with OTG function. OTG\_DTLS[1:0] reports the status of the OTG operation. OTG\_DTLS[1:0] is latched until the host reads the register.

If the external OTG load at CHGIN exceeds I<sub>CHGIN.OTG.LIM</sub> current limit for a minimum of 37.5ms, an OTG\_I interrupt is generated, OTG\_OK = 0 and OTG\_DTLS[1:0] = 01. The reverse buck operates as a current limited voltage source when overloaded. The DC-DC converter stops switching when the OTG\_ILIM condition lasts for 60ms and automatically resumes switching after 300ms off time. If the OTG\_ILIM fault condition at CHGIN persists, the DC-DC toggles on and off with ~60ms on and ~300ms off.

When CHGIN voltage drops below V<sub>CHGIN.OTG.UVLO</sub>, the DC-DC stops switching and an OTG\_I interrupt is generated. OTG\_OK = 0 and OTG\_DTLS[1:0] = 00.

When CHGIN voltage exceeds V<sub>CHGIN.OTG.OV</sub>, the DC-DC stops switching and an OTG\_I interrupt is generated. OTG\_OK = 0 and OTG\_DTLS[1:0] = 10.

If the DC-DC stops switching due to a OTG\_UV or OTG\_OV fault condition, it automatically retries after 300ms off time.

INOKB is the hardware indication of the OTG power good. See the [Input Power-OK/OTG Power-OK Output \(INOKB\)](#) section for details.

**OTG Enable (OTGEN)**

The OTGEN is an active high input. When OTGEN pin is pulled high, the OTG function is enabled. When the OTGEN pin is pulled low, the OTG function can be enabled through I<sup>2</sup>C by setting MODE[3:0] = 0x0A. To pull the OTGEN pin low with a pulldown resistor, the resistance must be lower than 44kΩ.

The devices enable reverse buck operation only when the voltage on the CHGIN bypass cap, V<sub>CHGIN</sub>, falls below V<sub>CHGIN\_UVLO</sub>.

In case V<sub>CHGIN</sub> is above V<sub>CHGIN\_UVLO</sub> threshold at the OTG enable, the devices ensure V<sub>CHGIN</sub> node discharge through a 8kΩ pulldown resistor before enabling the OTG function and reverse buck switching.

Pulldown is released once V<sub>CHGIN\_UVLO</sub> is reached.

### Analog Low-Noise Power Input (AVL)

AVL is the power input for the MAX77960/MAX77961's analog circuitry. Do not power external devices from this pin. Bypass with a 4.7Ω resistor between AVL and PVL and a 4.7μF capacitor from AVL to GND.

### Low-Side Gate Driver Power Supply (PVL)

PVL is an internal 1.8V LDO output that powers the MAX77960/MAX77961's low-side gate driver circuitry. Do not power external devices other than pullup resistors from this pin. Bypass with a 4.7μF capacitor to GND.

## System Faults

### V<sub>SYS</sub> Fault

The MAX77960/MAX77961 monitor the V<sub>SYS</sub> node for undervoltage and overvoltage events. The following sections describe the devices' behavior if any of these events is to occur.

### V<sub>SYS</sub> Undervoltage Lockout (V<sub>SYSU</sub>VLO)

When the voltage from SYS to GND (V<sub>SYS</sub>) is less than the undervoltage lockout threshold (V<sub>SYSU</sub>VLO), the MAX77960/MAX77961 generate a SYSU<sub>VLO</sub>\_I interrupt immediately. If V<sub>SYS</sub> is undervoltage for greater than 8ms, the device shuts down and resets O Type I<sup>2</sup>C registers.

### V<sub>SYS</sub> Overvoltage Lockout (V<sub>SYSO</sub>VLO)

When the V<sub>SYS</sub> exceeds V<sub>SYSO</sub>VLO, the MAX77960/MAX77961 generate a SYSO<sub>VLO</sub>\_I interrupt immediately and the device shuts down and resets O Type I<sup>2</sup>C registers.

### Thermal Fault

The MAX77960/MAX77961 have a die temperature sensing circuit. When the die temperature exceeds the thermal shutdown threshold, 165°C (T<sub>SHDN</sub>), the MAX77960/MAX77961 shut down and reset O Type I<sup>2</sup>C registers. There is a 15°C thermal hysteresis. After thermal shutdown, if the die temperature reduces by 15°C, the thermal shutdown bus deasserts and IC reenables. The battery charger has an independent thermal regulation loop. See the [Thermal Foldback](#) section for more details.

### Interrupt Output (INTB)

The INTB is an active-low, open-drain output. Connect a pullup resistor to the pullup power source.

The MAX77960/MAX77961's INTB can be connected to the host's interrupt input and signals to the host when unmasked interrupt events occur within the MAX77960/MAX77961.

## I<sup>2</sup>C Serial Interface

The I<sup>2</sup>C serial bus consists of a bidirectional serial-data line (SDA) and a serial clock (SCL). I<sup>2</sup>C is an open-drain bus. SDA and SCL require pullup resistors (500Ω or greater). Optional 24Ω resistors in series with SDA and SCL help to protect the device inputs from high-voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus lines.

### System Configuration

The I<sup>2</sup>C bus is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.

[Figure 6](#) shows an example of a typical I<sup>2</sup>C system. A device on I<sup>2</sup>C bus that sends data to the bus is called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. When the MAX77960/MAX77961 I<sup>2</sup>C-compatible interface is operating, it is a slave on I<sup>2</sup>C bus and it can be both a transmitter and a receiver.

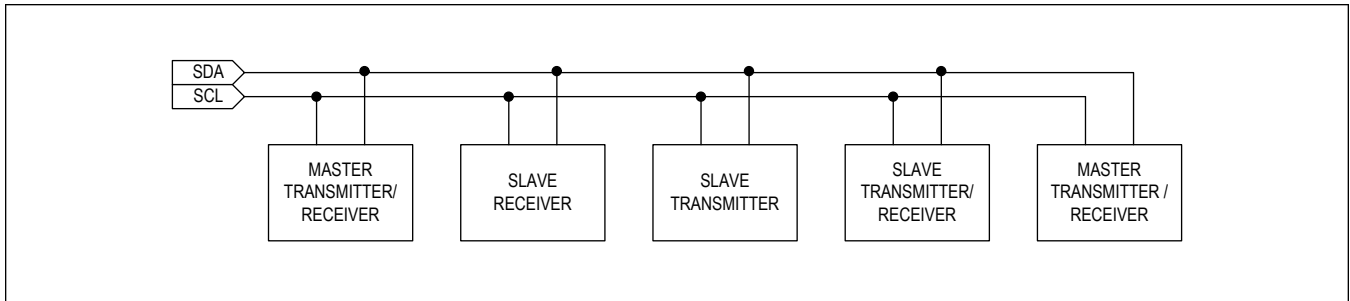


Figure 6. Functional Logic Diagram for Communications Controller

**Bit Transfer**

One data bit is transferred for each SCL clock cycle. The data on SDA must remain stable during the high portion of SCL clock pulse. Changes in SDA while SCL is high are control signals (START and STOP conditions).

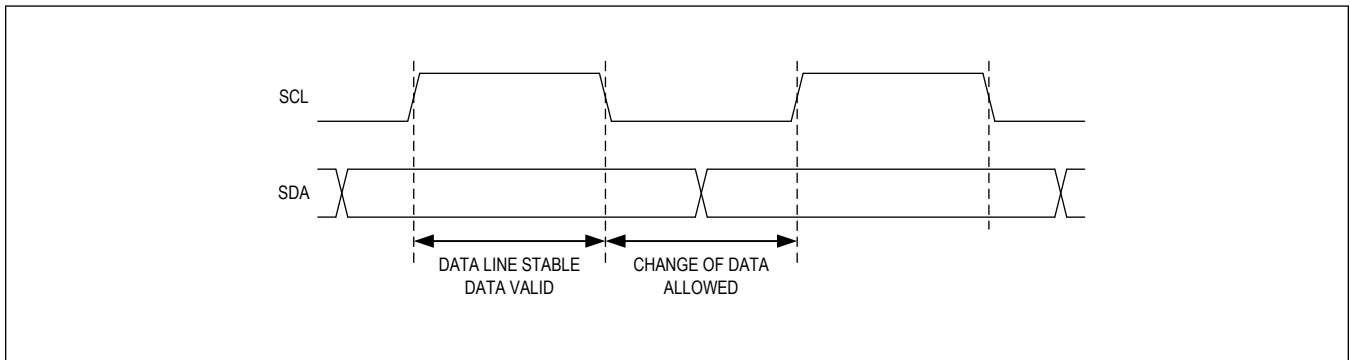


Figure 7. I<sup>2</sup>C Bit Transfer

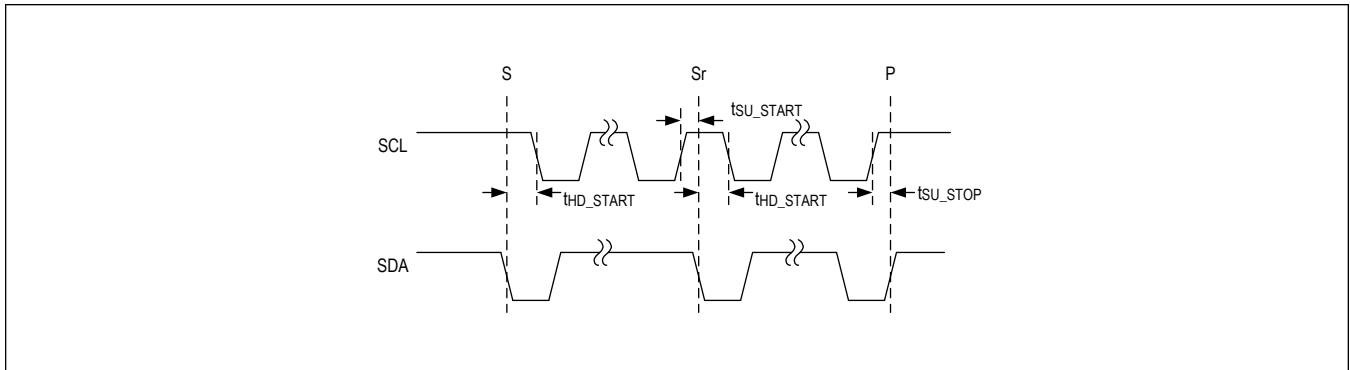
**START and STOP Conditions**

When I<sup>2</sup>C serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high.

A START condition from the master signals the beginning of a transmission to the IC. The master terminates transmission by issuing a NOT ACKNOWLEDGE followed by a STOP condition.

A STOP condition frees the bus. To issue a series of commands to the slave, the master can issue REPEATED START (Sr) commands instead of a STOP command in order to maintain control of the bus. In general, a REPEATED START command is functionally equivalent to a regular START command.

When a STOP condition or incorrect address is detected, the ICs internally disconnect SCL from the I<sup>2</sup>C serial interface until the next START condition, minimizing digital noise and feed-through.

Figure 8. I<sup>2</sup>C Start Stop

### Acknowledge

Both the I<sup>2</sup>C bus master and the IC (slave) generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each nine bit data packet. To generate an ACKNOWLEDGE (A), the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. To generate a NOT-ACKNOWLEDGE (nA), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.

Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

### Slave Address

The devices act as a slave transmitter/receiver. The slave address of the IC is 0xD2h/0xD3h. The least significant bit is the read/write indicator (1 for read, 0 for write).

### Clock Stretching

In general, the clock signal generation for I<sup>2</sup>C bus is the responsibility of the master device. I<sup>2</sup>C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The IC does not use any form of clock stretching to hold down the clock line.

### General Call Address

The devices do not implement an I<sup>2</sup>C specification general call address. If the devices see a general call address (0000000b), they do not issue an ACKNOWLEDGE (A).

### Communication Speed

The devices provide I<sup>2</sup>C 3.0-compatible (1MHz) serial interface.

- I<sup>2</sup>C Revision 3 Compatible Serial Communications Channel
  - 0Hz to 100kHz (standard mode)
  - 0Hz to 400kHz (fast mode)
  - 0Hz to 1MHz (fast-mode plus)
- Does not utilize I<sup>2</sup>C clock stretching

Operating in standard mode, fast mode, and fast-mode plus does not require any special protocols. The main consideration when changing the bus speed through this range is the combination of the bus capacitance and pullup resistors. Higher time constants created by the bus capacitance and pullup resistance ( $C \times R$ ) slow the bus operation. Therefore, when increasing bus speeds the pullup resistance must be decreased to maintain a reasonable time constant. Refer to the *Pullup Resistor Sizing* section of the I<sup>2</sup>C revision 3.0 specification for detailed guidance on the pullup resistor

selection. In general, for bus capacitance of 200pF, a 100kHz bus needs 5.6kΩ pullup resistors, a 400kHz bus needs about a 1.5kΩ pullup resistors, and a 1MHz bus needs 680Ω pullup resistors. Note that the pullup resistor dissipates power when the open-drain bus is low. The lower the value of the pullup resistor, the higher the power dissipation ( $V^2/R$ ). Operating in high-speed mode requires some special considerations. For the full list of considerations, see the I<sup>2</sup>C 3.0 specification. The major considerations with respect to the IC are:

- I<sup>2</sup>C bus master uses current source pullups to shorten the signal rise times.
- I<sup>2</sup>C slave must use a different set of input filters on its SDA and SCL lines to accommodate for the higher bus speed.
- The communication protocols need to utilize the high-speed master code.

At power-up and after each STOP condition, the IC input filters are set for standard mode, fast mode, or fast-mode plus (i.e., 0Hz to 1MHz). To switch the input filters for high-speed mode, use the high-speed master code protocols that are described in the *Communication Protocols* section.

### Communication Protocols

The devices support both writing and reading from their registers.

#### Writing to a Single Register

Figure 9 shows the protocol for the I<sup>2</sup>C master device to write one byte of data to the ICs. This protocol is the same as SMBus specification's Write Byte protocol.

The Write Byte protocol is as follows:

1. The master sends a START command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\bar{W} = 0$ ).
3. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a data byte.
7. The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data becomes active.
8. The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

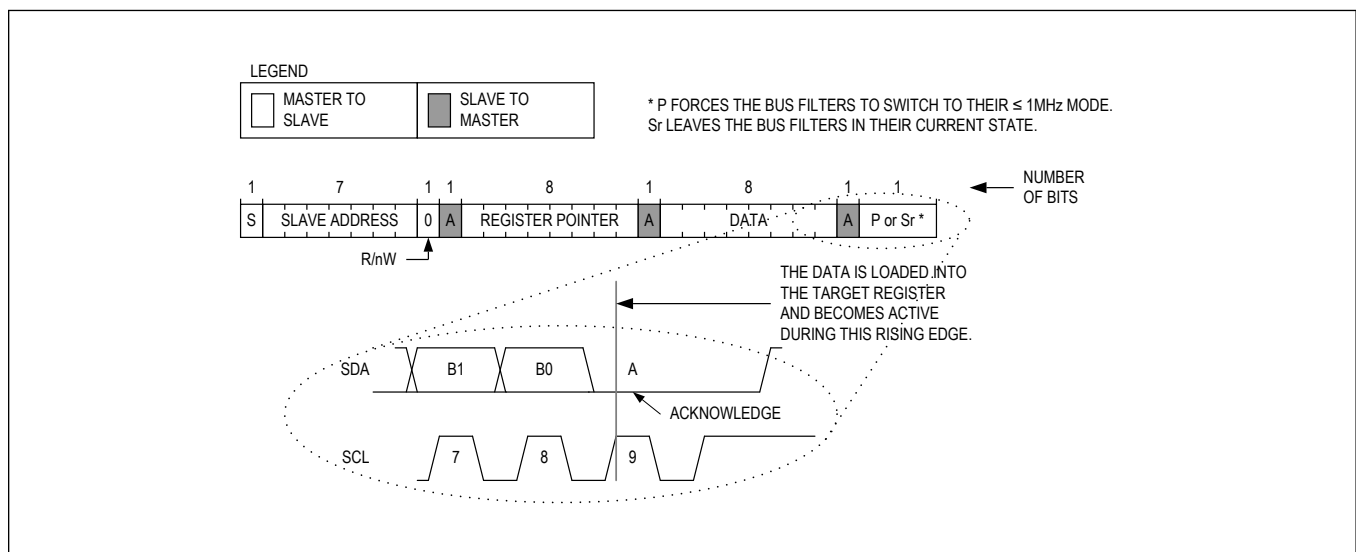


Figure 9. Writing to a Single Register

**Writing to Sequential Registers**

Figure 10 shows the protocol for writing to sequential registers. This protocol is similar to the Write Byte protocol, except the master continues to write after it receives the first byte of data. When the master is done writing, it issues a STOP or REPEATED START.

The Writing to Sequential Registers protocol is as follows:

1. The master sends a START command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a data byte.
7. The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data becomes active.
8. Steps 6 to 7 are repeated as many times as the master requires.
9. During the last acknowledge related clock pulse, the slave issues an ACKNOWLEDGE (A).
10. The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

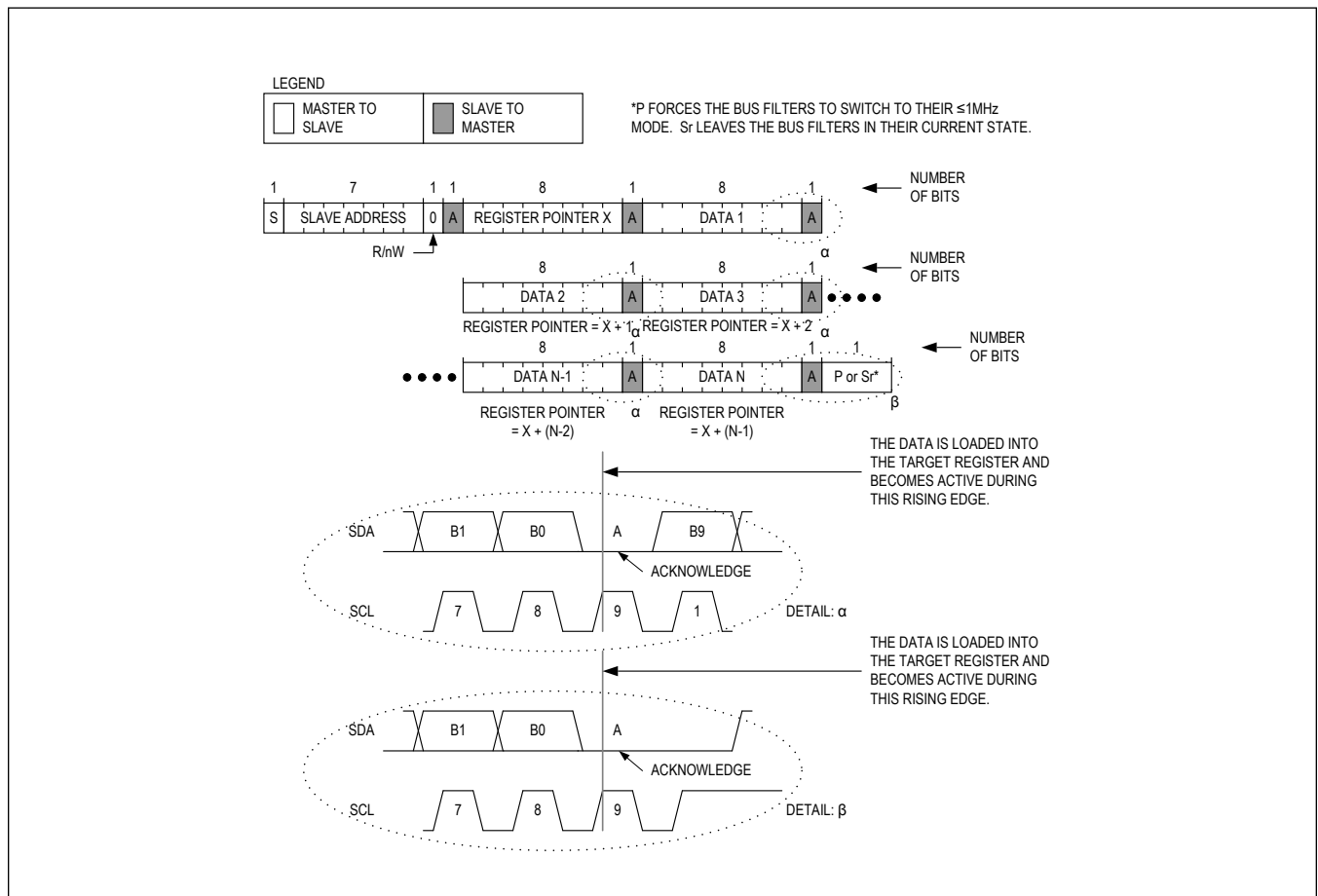


Figure 10. Writing to Sequential Registers

**Writing Multiple Bytes using Register-Data Pairs**

Figure 11 shows the protocol for the I<sup>2</sup>C master device to write multiple bytes to the devices using register data pairs. This protocol allows the I<sup>2</sup>C master device to address the slave only once and then send data to multiple registers in a random order. Registers can be written continuously until the master issues a STOP condition.

The Multiple Byte Register Data Pair protocol is as follows:

1. The master sends a START command.
2. The master sends the 7-bit slave address followed by a write bit.
3. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a data byte.
7. The slave acknowledges the data byte. At the rising edge of SCL, the data byte is loaded into its target register and the data becomes active.
8. Steps 4 to 7 are repeated as many times as the master requires.
9. The master sends a STOP condition. During the rising edge of the stop related SDA edge, the data byte that was previously written is loaded into the target register and becomes active.

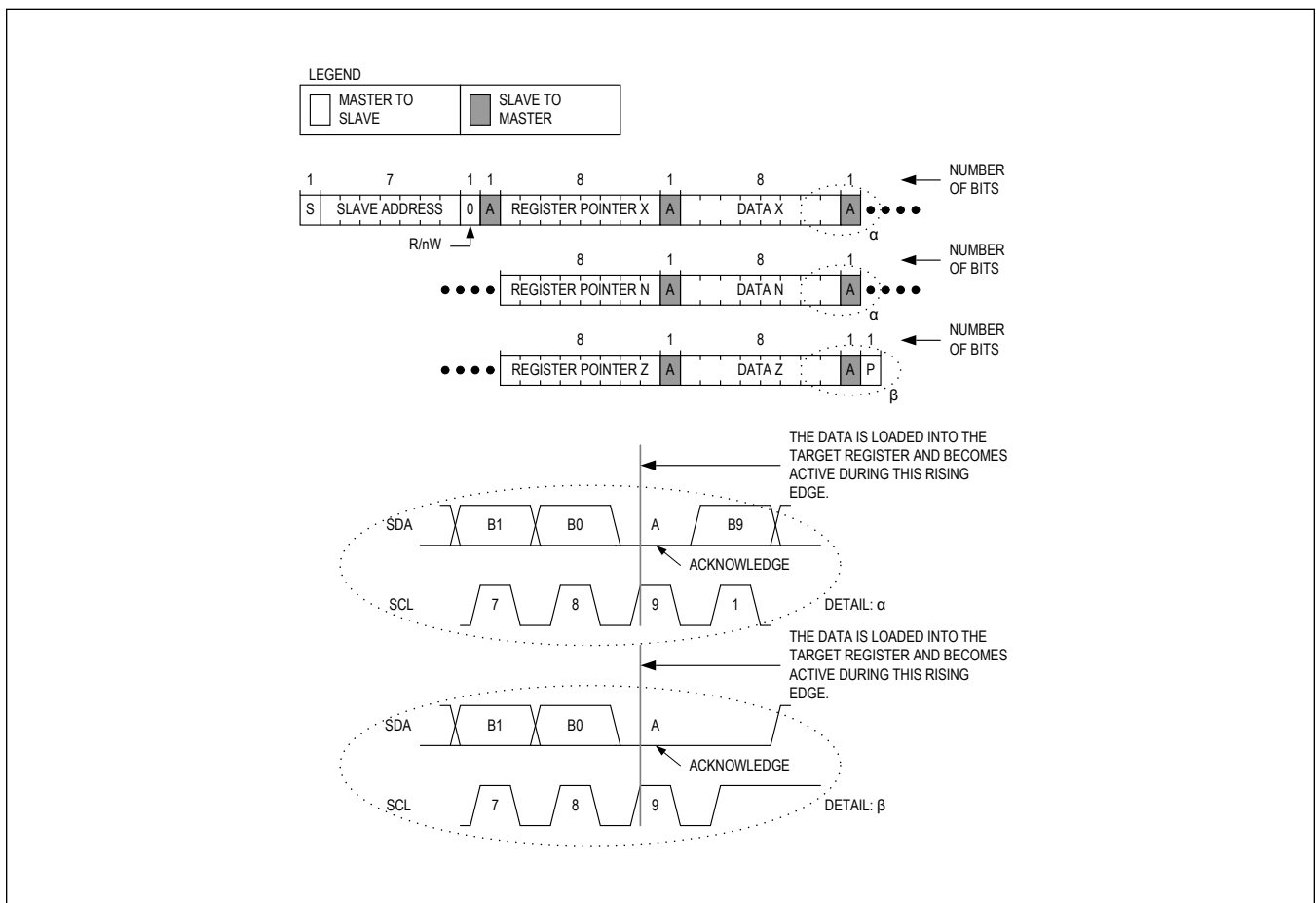


Figure 11. Writing to Multiple Registers with “Multiple Byte Register-Data Pairs” Protocol

**Reading from a Single Register**

The I<sup>2</sup>C master device reads one byte of data to the devices. This protocol is the same as SMBus specification’s Read Byte protocol.

The Read Byte protocol is as follows:

1. The master sends a START command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a REPEATED START command (Sr).
7. The master sends the 7-bit slave address followed by a read bit ( $R/\overline{W} = 1$ ).
8. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
9. The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
10. The master issues a NOT-ACKNOWLEDGE (nA).
11. The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

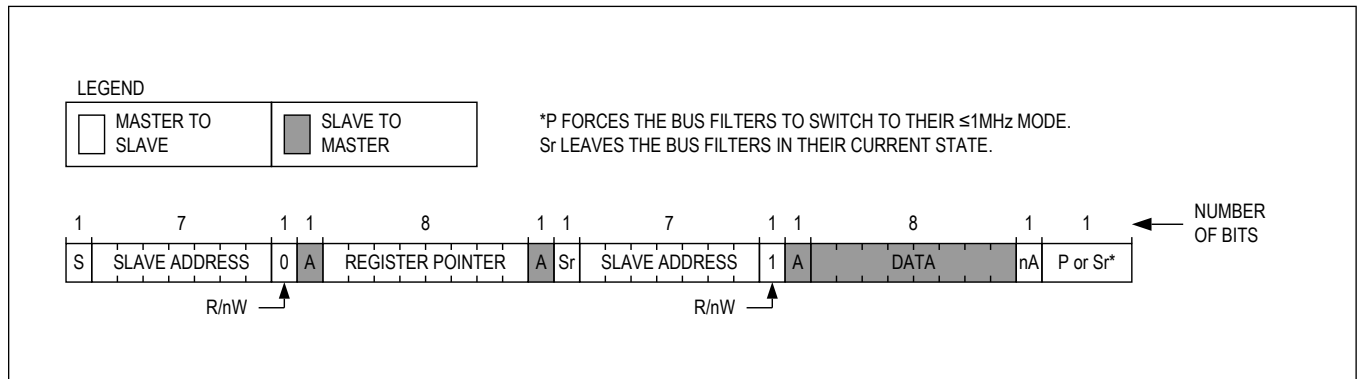


Figure 12. Reading from a Single Register



**Reading from Sequential Registers**

Figure 13 shows the protocol for reading from sequential registers. This protocol is similar to the Read Byte protocol except the master issues an ACKNOWLEDGE (A) to signal the slave that it wants more data—when the master has all the data it requires, it issues a not-acknowledge (nA) and a STOP (P) to end the transmission.

The Continuous Read from Sequential Registers protocol is as follows:

1. The master sends a START command (S).
2. The master sends the 7-bit slave address followed by a write bit ( $R/\overline{W} = 0$ ).
3. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
4. The master sends an 8-bit register pointer.
5. The slave acknowledges the register pointer.
6. The master sends a REPEATED START command (Sr).
7. The master sends the 7-bit slave address followed by a read bit ( $R/\overline{W} = 1$ ).
8. The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
9. The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
10. The master issues an ACKNOWLEDGE (A) signaling the slave that it wishes to receive more data.
11. Steps 9 to 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a NOT-ACKNOWLEDGE (nA) to signal that it wishes to stop receiving data.
12. The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a STOP (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

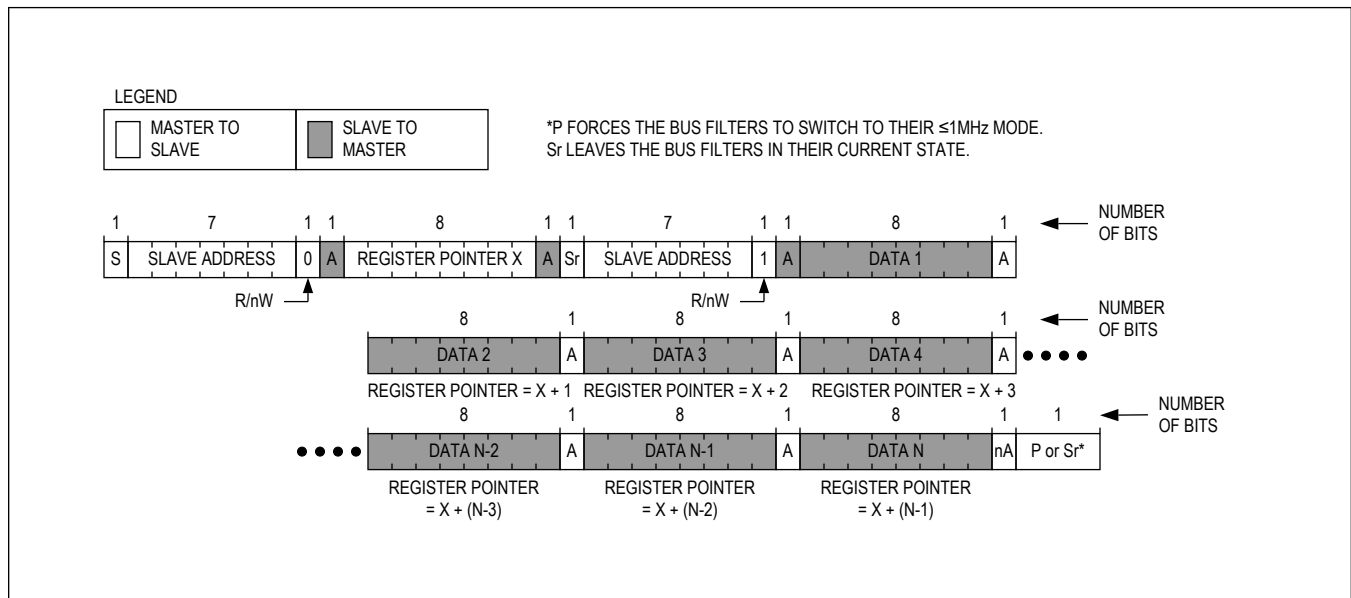


Figure 13. Reading from Sequential Registers

## Register Map

## FUNC

| ADDRESS             | NAME                                | MSB            |                 |                 |               |               |               |             | LSB          |
|---------------------|-------------------------------------|----------------|-----------------|-----------------|---------------|---------------|---------------|-------------|--------------|
| <b>TOP</b>          |                                     |                |                 |                 |               |               |               |             |              |
| 0x00                | <a href="#">CID[7:0]</a>            | REVISION[2:0]  |                 |                 | VERSION[4:0]  |               |               |             |              |
| 0x01                | <a href="#">SWRST[7:0]</a>          | SW_RST[7:0]    |                 |                 |               |               |               |             |              |
| 0x02                | <a href="#">TOP_INT[7:0]</a>        | SPR[4:0]       |                 |                 |               | TSHDN_I       | SYSOVL_O_I    | SYSUVL_O_I  |              |
| 0x03                | <a href="#">TOP_INT_MASK[7:0]</a>   | SPR[4:0]       |                 |                 |               | TSHDN_M       | SYSOVL_O_M    | SYSUVL_O_M  |              |
| 0x04                | <a href="#">TOP_INT_OK[7:0]</a>     | SPR[4:0]       |                 |                 |               | TSHDN_OK      | SYSOVL_O_OK   | SYSUVL_O_OK |              |
| <b>CHARGER_FUNC</b> |                                     |                |                 |                 |               |               |               |             |              |
| 0x10                | <a href="#">CHG_INT[7:0]</a>        | AICL_I         | CHGIN_I         | B2SOVR_C_I      | CHG_I         | BAT_I         | CHGINIL_IM_I  | DISQBA_T_I  | OTG_PL_IM_I  |
| 0x11                | <a href="#">CHG_INT_MASK[7:0]</a>   | AICL_M         | CHGIN_M         | B2SOVR_C_M      | CHG_M         | BAT_M         | CHGINIL_IM_M  | DISQBA_T_M  | OTG_PL_IM_M  |
| 0x12                | <a href="#">CHG_INT_OK[7:0]</a>     | AICL_OK        | CHGIN_OK        | B2SOVR_C_OK     | CHG_OK        | BAT_OK        | CHGINIL_IM_OK | DISQBA_T_OK | OTG_PL_IM_OK |
| 0x13                | <a href="#">CHG_DETAILS_00[7:0]</a> | SPR7           | CHGIN_DTLS[1:0] |                 | OTG_DTLS[1:0] |               | SPR2_1[1:0]   |             | QB_DTLS      |
| 0x14                | <a href="#">CHG_DETAILS_01[7:0]</a> | TREG           | BAT_DTLS[2:0]   |                 |               | CHG_DTLS[3:0] |               |             |              |
| 0x15                | <a href="#">CHG_DETAILS_02[7:0]</a> | SPR            | THM_DTLS[2:0]   |                 |               | APP_MODE_DTLS | FSW_DTLS[1:0] |             | NUM_CELLS    |
| 0x16                | <a href="#">CHG_CNFG_00[7:0]</a>    | COMM_MODE      | DISIBS          | STBY_EN         | WDTEN         | MODE[3:0]     |               |             |              |
| 0x17                | <a href="#">CHG_CNFG_01[7:0]</a>    | PQEN           | LPM             | CHG_RSTRT[1:0]  |               | STAT_EN       | FCHGTIME[2:0] |             |              |
| 0x18                | <a href="#">CHG_CNFG_02[7:0]</a>    | SPR[1:0]       |                 | CHGCC[5:0]      |               |               |               |             |              |
| 0x19                | <a href="#">CHG_CNFG_03[7:0]</a>    | SYS_TR_ACK_DS  | B2SOVR_C_DTC    | TO_TIME[2:0]    |               |               | TO_ITH[2:0]   |             |              |
| 0x1A                | <a href="#">CHG_CNFG_04[7:0]</a>    | SPR[1:0]       |                 | CHG_CV_PRM[5:0] |               |               |               |             |              |
| 0x1B                | <a href="#">CHG_CNFG_05[7:0]</a>    | RESERVED[1:0]  |                 | ITRICKLE[1:0]   |               | B2SOVRC[3:0]  |               |             |              |
| 0x1C                | <a href="#">CHG_CNFG_06[7:0]</a>    | SPR7           | RESERVED[1:0]   |                 | SPR4          | CHGPROT[1:0]  |               | WDTCLR[1:0] |              |
| 0x1D                | <a href="#">CHG_CNFG_07[7:0]</a>    | JEITA_EN       | REGTEMP[3:0]    |                 |               | VCHGC_V_COOL  | ICHGCC_COOL   | FSHIP_MODE  |              |
| 0x1E                | <a href="#">CHG_CNFG_08[7:0]</a>    | RESERVED       | CHGIN_ILIM[6:0] |                 |               |               |               |             |              |
| 0x1F                | <a href="#">CHG_CNFG_09[7:0]</a>    | INLIM_CLK[1:0] |                 | OTG_ILIM[2:0]   |               |               | MINVSYS[2:0]  |             |              |
| 0x20                | <a href="#">CHG_CNFG_10[7:0]</a>    | SPR[1:0]       |                 | VCHGIN_REG[4:0] |               |               |               |             | DISKIP       |

## Register Details

CID (0x0)

| BIT         | 7             | 6 | 5 | 4            | 3 | 2 | 1 | 0 |
|-------------|---------------|---|---|--------------|---|---|---|---|
| Field       | REVISION[2:0] |   |   | VERSION[4:0] |   |   |   |   |
| Reset       | 0x5           |   |   | 0x0          |   |   |   |   |
| Access Type | Read Only     |   |   | Read Only    |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION        |
|----------|------|--------------------|
| REVISION | 7:5  | Silicon Revision   |
| VERSION  | 4:0  | OTP Recipe Version |

SWRST (0x1)

| BIT         | 7           | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|---|---|---|---|---|---|
| Field       | SW_RST[7:0] |   |   |   |   |   |   |   |
| Reset       | 0x00        |   |   |   |   |   |   |   |
| Access Type | Write, Read |   |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION    | DECODE   |
|----------|------|----------------|--|
| SW_RST   | 7:0  | Software Reset | 0xA5: Type O registers are reset. SW_RST register is autoclear as under O-type reset control<br>All others: No reset |

TOP\_INT (0x2)

| BIT         | 7               | 6 | 5 | 4 | 3               | 2               | 1               | 0   |
|-------------|-----------------|---|---|---|-----------------|-----------------|-----------------|-----|
| Field       | SPR[4:0]        |   |   |   | TSHDN_I         | YSOVLO_I        | YSUVLO_I        |     |
| Reset       | 0x0             |   |   |   | 0x0             | 0x0             | 0x0             | 0x0 |
| Access Type | Read Clears All |   |   |   | Read Clears All | Read Clears All | Read Clears All |     |

| BITFIELD | BITS | DESCRIPTION                | DECODE  |
|----------|------|----------------------------|---|
| SPR      | 7:3  | Spare Bit                  |   |
| TSHDN_I  | 2    | Thermal Shutdown Interrupt | 0b0: No interrupt detected<br>0b1: Interrupt detected |
| YSOVLO_I | 1    | YSOVLO Interrupt           | 0b0: No interrupt detected<br>0b1: Interrupt detected |
| YSUVLO_I | 0    | YSUVLO Interrupt           | 0b0: No interrupt detected<br>0b1: Interrupt detected |

TOP\_INT\_MASK (0x3)

| BIT         | 7           | 6 | 5 | 4 | 3           | 2           | 1           | 0 |
|-------------|-------------|---|---|---|-------------|-------------|-------------|---|
| Field       | SPR[4:0]    |   |   |   | TSHDN_M     | YSOVLO_M    | YSUVLO_M    |   |
| Reset       | 0x1F        |   |   |   | 0x1         | 0x1         | 0x1         |   |
| Access Type | Write, Read |   |   |   | Write, Read | Write, Read | Write, Read |   |

| BITFIELD  | BITS | DESCRIPTION                     | DECODE                       |
|-----------|------|---------------------------------|------------------------------|
| SPR       | 7:3  | Spare Bit                       |                              |
| TSHDN_M   | 2    | Thermal Shutdown Interrupt Mask | 0b0: Unmasked<br>0b1: Masked |
| YSOVLO_M  | 1    | YSOVLO Interrupt Mask           | 0b0: Unmasked<br>0b1: Masked |
| SYSUVLO_M | 0    | SYSUVLO Interrupt Mask          | 0b0: Unmasked<br>0b1: Masked |

**TOP\_INT\_OK (0x4)**

| BIT         | 7         | 6 | 5 | 4 | 3 | 2         | 1         | 0          |
|-------------|-----------|---|---|---|---|-----------|-----------|------------|
| Field       | SPR[4:0]  |   |   |   |   | TSHDN_OK  | YSOVLO_OK | SYSUVLO_OK |
| Reset       | 0x0       |   |   |   |   | 0x1       | 0x1       | 0x1        |
| Access Type | Read Only |   |   |   |   | Read Only | Read Only | Read Only  |

| BITFIELD   | BITS | DESCRIPTION                       | DECODE   |
|------------|------|-----------------------------------|--|
| SPR        | 7:3  | Spare Bit                         |  |
| TSHDN_OK   | 2    | Thermal shutdown Status Indicator | 0b0: Device is in thermal shutdown<br>0b1: Device is not in thermal shutdown               |
| YSOVLO_OK  | 1    | YSOVLO Status Indicator           | 0b0: SYS voltage is above YSOVLO threshold<br>0b1: SYS voltage is below YSOVLO threshold   |
| SYSUVLO_OK | 0    | SYSUVLO Status Indicator          | 0b0: SYS voltage is below SYSUVLO threshold<br>0b1: SYS voltage is above SYSUVLO threshold |

**CHG\_INT (0x10)**

Interrupt status register for the charger block.

| BIT         | 7                  | 6                  | 5                  | 4                  | 3                  | 2                  | 1                  | 0                  |
|-------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Field       | AICL_I             | CHGIN_I            | B2SOVRC_I          | CHG_I              | BAT_I              | CHGINILIM_I        | DISQBAT_I          | OTG_PLIM_I         |
| Reset       | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                | 0x0                |
| Access Type | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All | Read<br>Clears All |

| BITFIELD  | BITS | DESCRIPTION       | DECODE   |
|-----------|------|-------------------|--|
| AICL_I    | 7    | AICL Interrupt    | 0b0: The AICL_OK bit has not changed since the last time this bit was read.<br>0b1: The AICL_OK bit has changed since the last time this bit was read.       |
| CHGIN_I   | 6    | CHGIN Interrupt   | 0b0: The CHGIN_OK bit has not changed since the last time this bit was read.<br>0b1: The CHGIN_OK bit has changed since the last time this bit was read.     |
| B2SOVRC_I | 5    | B2SOVRC Interrupt | 0b0: The B2SOVRC_OK bit has not changed since the last time this bit was read.<br>0b1: The B2SOVRC_OK bit has changed since the last time this bit was read. |

| BITFIELD    | BITS | DESCRIPTION                  | DECODE   |
|-------------|------|------------------------------|--|
| CHG_I       | 4    | Charger Interrupt            | 0b0: The CHG_OK bit has not changed since the last time this bit was read.<br>0b1: The CHG_OK bit has changed since the last time this bit was read.   |
| BAT_I       | 3    | Battery Interrupt            | 0b0: The BAT_OK bit has not changed since the last time this bit was read.<br>0b1: The BAT_OK bit has changed since the last time this bit was read.   |
| CHGINILIM_I | 2    | CHGINILIM Interrupt          | 0b0: The CHGINILIM_OK bit has not changed since the last time this bit was read.<br>0b1: The CHGINILIM_OK bit has changed since the last time this bit was read.   |
| DISQBAT_I   | 1    | DISQBAT Interrupt            | 0b0: The DISQBAT_OK bit has not changed since the last time this bit was read.<br>0b1: The DISQBAT_OK bit has changed since the last time this bit was read.   |
| OTG_PLIM_I  | 0    | OTG Interrupt/PLIM Interrupt | 0b0: Mode = 0xA: The OTG_OK bit has not changed since the last time this bit was read.<br>Mode ≠ 0xA: PLIM_OK bit has not changed since the last time this bit was read.<br>0b1: Mode = 0xA: The OTG_OK bit has changed since the last time this bit was read.<br>Mode ≠ 0xA: The PLIM_OK bit has changed since the last time this bit was read. |

**CHG\_INT\_MASK (0x11)**

Mask register to mask the corresponding charger interrupts.

| BIT         | 7           | 6           | 5           | 4           | 3           | 2           | 1           | 0           |
|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Field       | AICL_M      | CHGIN_M     | B2SOVRC_M   | CHG_M       | BAT_M       | CHGINILIM_M | DISQBAT_M   | OTG_PLIM_M  |
| Reset       | 0x1         | 0x1         | 0x1         | 0x1         | 0x1         | 0x1         | 0x1         | 0x1         |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |

| BITFIELD    | BITS | DESCRIPTION              | DECODE                       |
|-------------|------|--------------------------|------------------------------|
| AICL_M      | 7    | AICL Interrupt Mask      | 0b0: Unmasked<br>0b1: Masked |
| CHGIN_M     | 6    | CHGIN Interrupt Mask     | 0b0: Unmasked<br>0b1: Masked |
| B2SOVRC_M   | 5    | B2SOVRC Interrupt Mask   | 0b0: Unmasked<br>0b1: Masked |
| CHG_M       | 4    | Charger Interrupt Mask   | 0b0: Unmasked<br>0b1: Masked |
| BAT_M       | 3    | Battery Interrupt Mask   | 0b0: Unmasked<br>0b1: Masked |
| CHGINILIM_M | 2    | CHGINILIM Interrupt Mask | 0b0: Unmasked<br>0b1: Masked |
| DISQBAT_M   | 1    | DISQBAT Interrupt Mask   | 0b0: Unmasked<br>0b1: Masked |

| BITFIELD   | BITS | DESCRIPTION             | DECODE                       |
|------------|------|-------------------------|------------------------------|
| OTG_PLIM_M | 0    | OTG/PLIM Interrupt Mask | 0b0: Unmasked<br>0b1: Masked |

**CHG\_INT\_OK (0x12)**

| BIT         | 7         | 6         | 5          | 4         | 3         | 2            | 1          | 0           |
|-------------|-----------|-----------|------------|-----------|-----------|--------------|------------|-------------|
| Field       | AICL_OK   | CHGIN_OK  | B2SOVRC_OK | CHG_OK    | BAT_OK    | CHGINILIM_OK | DISQBAT_OK | OTG_PLIM_OK |
| Reset       | 0x1       | 0x0       | 0x1        | 0x1       | 0x1       | 0x1          | 0x1        | 0x1         |
| Access Type | Read Only | Read Only | Read Only  | Read Only | Read Only | Read Only    | Read Only  | Read Only   |

| BITFIELD     | BITS | DESCRIPTION   | DECODE   |
|--------------|------|---|--|
| AICL_OK      | 7    | AICL_OK Status  | 0b0: AICL mode<br>0b1: Not in AICL mode  |
| CHGIN_OK     | 6    | CHGIN Input Status Indicator. See CHGIN_DTLS for more information.  | 0b0: The CHGIN input is invalid. CHGIN_DTLS ≠ 0x03.<br>0b1: The CHGIN input is valid. CHGIN_DTLS = 0x03.   |
| B2SOVRC_OK   | 5    | B2SOVRC Status  | 0b0: BATT to SYS exceeds current limit.<br>0b1: BATT to SYS does not exceed current limit.   |
| CHG_OK       | 4    | Charger Status Indicator. See CHG_DTLS for more information.  | 0b0: The charger has reduced charge current or charge termination voltage based on JEITA control, suspended charging, or TREG = 1.<br>0b1: The charger is OK or the charger is off.  |
| BAT_OK       | 3    | Battery Status Indicator. See BAT_DTLS for more information.  | 0b0: The battery has an issue or the charger has been suspended. BAT_DTLS ≠ 0x03 and ≠ 0x07.<br>0b1: The battery is OK. BAT_DTLS = 0x03 or BAT_DTLS = 0x07.  |
| CHGINILIM_OK | 2    | CHGINILIM Status  | 0b0: The CHGIN input has reached the current limit.<br>0b1: The CHGIN input has not reached the current limit.   |
| DISQBAT_OK   | 1    | DISQBAT Status  | 0b0: DISQBAT pin is high or DISIBS bit is set to 1 and Q <sub>BAT</sub> disabled.<br>0b1: DISQBAT is low and DISIBS bit is 0 and Q <sub>BAT</sub> not disabled.  |
| OTG_PLIM_OK  | 0    | Mode = 0xA: OTG Status Indicator. See OTG_DTLS for more information.<br>Mode ≠ 0xA: PLIM status indicator (buck-boost limit reached). | 0b0: Mode = 0xA: There is a fault in OTG mode. OTG_DTLS ≠ 0x11.<br>Mode ≠ 0xA: Buck-boost reaches positive current limit.<br>0b1: Mode = 0xA: The OTG operation is OK. OTG_DTLS = 0x11.<br>Mode ≠ 0xA: Buck-boost does not reach positive current limit. |

**CHG\_DETAILS\_00 (0x13)**

| BIT         | 7         | 6               | 5 | 4             | 3 | 2           | 1 | 0         |
|-------------|-----------|-----------------|---|---------------|---|-------------|---|-----------|
| Field       | SPR7      | CHGIN_DTLS[1:0] |   | OTG_DTLS[1:0] |   | SPR2_1[1:0] |   | QB_DTLS   |
| Reset       | 0x0       | 0x0             |   | 0x0           |   | 0x0         |   | 0x0       |
| Access Type | Read Only | Read Only       |   | Read Only     |   | Read Only   |   | Read Only |

| BITFIELD   | BITS | DESCRIPTION   | DECODE  |
|------------|------|---|---|
| SPR7       | 7    | Spare Bit   |   |
| CHGIN_DTLS | 6:5  | CHGIN Details   | 0b00: V <sub>BUS</sub> is invalid. V <sub>CHGIN</sub> < V <sub>CHGIN_UVLO</sub><br>0b01: RSVD<br>0b10: V <sub>BUS</sub> is invalid. V <sub>CHGIN</sub> > V <sub>CHGIN_OVLO</sub><br>0b11: V <sub>BUS</sub> is valid. V <sub>CHGIN</sub> > V <sub>CHGIN_UVLO</sub> and V <sub>CHGIN</sub> < V <sub>CHGIN_OVLO</sub>  |
| OTG_DTLS   | 4:3  | OTG Details   | 0b00: OTG output (V <sub>CHGIN</sub> ) is in undervoltage condition. V <sub>CHGIN</sub> < V <sub>OTG_UVLO</sub><br>0b01: OTG output (V <sub>CHGIN</sub> ) is in current limit (OTG_ILIM) within the last 37.5ms.<br>0b10: OTG output (V <sub>CHGIN</sub> ) is in overvoltage condition. V <sub>CHGIN</sub> > V <sub>OTG_OVLO</sub><br>0b11: OTG is disabled (OTGEN = low and MODE ≠ 0xA) or OTG output (V <sub>CHGIN</sub> ) is valid. V <sub>CHGIN</sub> > V <sub>OTG_UVLO</sub> and V <sub>CHGIN</sub> < V <sub>OTG_OVLO</sub> and it's not in current limit. |
| SPR2_1     | 2:1  | Spare Bit   |   |
| QB_DTLS    | 0    | QBAT status<br>Read back value of QB_DTLS reflects the actual QBAT state. | 0b0: QBAT is off.<br>0b1: QBAT is on.   |

**CHG\_DETAILS\_01 (0x14)**

| BIT         | 7         | 6             | 5 | 4 | 3             | 2 | 1 | 0 |
|-------------|-----------|---------------|---|---|---------------|---|---|---|
| Field       | TREG      | BAT_DTLS[2:0] |   |   | CHG_DTLS[3:0] |   |   |   |
| Reset       | 0x0       | 0x7           |   |   | 0x8           |   |   |   |
| Access Type | Read Only | Read Only     |   |   | Read Only     |   |   |   |

| BITFIELD | BITS | DESCRIPTION                   | DECODE  |
|----------|------|-------------------------------|---|
| TREG     | 7    | Temperature Regulation Status | 0b0: The junction temperature is less than the threshold set by REGTEMP and the full charge current limit is available.<br>0b1: The junction temperature is greater than the threshold set by REGTEMP and the charge current limit can be folding back to reduce power dissipation. |

| BITFIELD | BITS | DESCRIPTION   | DECODE   |
|----------|------|---|--|
| BAT_DTLS | 6:4  | <p>Battery Details<br/>                     Note: Only B2SOVRC is reported in Battery Only mode. As a consequence, BAT_OK = 1 is also reported in BAT_DTLS = 0x07.</p> <p>In the event that multiple faults occur within the battery details category, overcurrent has priority followed by no battery, then overvoltage, then timer fault, then below prequal.</p> | <p>0b000: Battery removal is detected on THM pin.<br/>                     0b001: <math>V_{BATT} &lt; V_{PRECHG}</math>. This condition is also reported in the CHG_DTLS as 0x00.<br/>                     0b010: The battery is taking longer than expected to charge. This could be due to high system currents, an old battery, a damaged battery or something else. Charging has suspended and the charger is in its timer fault mode. This condition is also reported in the CHG_DTLS as 0x06.<br/>                     0b011: The battery is OK and its voltage is greater than the minimum system voltage (<math>V_{SYSMIN} - 500mV &lt; V_{BATT}</math>). Q<sub>BAT</sub> is on and V<sub>SYS</sub> is approximately equal to V<sub>BATT</sub>.<br/>                     0b100: The battery is okay but its voltage is low: <math>V_{PRECHG} &lt; V_{BATT} &lt; V_{SYSMIN} - 500mV</math>. This condition is also reported in the CHG_DTLS as 0x00.<br/>                     0b101: The battery voltage has been greater than the battery overvoltage threshold (<math>CHG\_CV\_PRM + 240mV/cell</math>) for the last 30ms. This flag is only generated when there is a valid input.<br/>                     0b110: The battery has been overcurrent for at least 3ms since the last time this register has been read.<br/>                     0b111: Battery level not available. In battery only mode, all battery comparators are off except for B2SOVRC.</p> |



| BITFIELD | BITS | DESCRIPTION     | DECODE   |
|----------|------|-----------------|--|
| CHG_DTLS | 3:0  | Charger Details | <p>0x00: Charger is in precharge or trickle charge mode<br/>CHG_OK = 1 and V<sub>BATT</sub> &lt; V<sub>SYSTEMIN</sub> - 500mV and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x01: Charger is in fast-charge constant current mode<br/>CHG_OK = 1 and V<sub>BATT</sub> &lt; V<sub>BATTREG</sub> and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x02: Charger is in fast-charge constant voltage mode<br/>CHG_OK = 1 and V<sub>BATT</sub> = V<sub>BATTREG</sub> and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x03: Charger is in top-off mode<br/>CHG_OK = 1 and V<sub>BATT</sub> = V<sub>BATTREG</sub> and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x04: Charger is in done mode<br/>CHG_OK = 0 and V<sub>BATT</sub> &gt; V<sub>BATTREG</sub> - V<sub>RSTRT</sub> and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x05: Charger is off because at least one pin of INLIM, ITO, ISET, or VSET has valid resistance while others don't (invalid resistance, open or tied to PVL). Configure charger with I<sup>2</sup>C, then set COMM_MODE to 1 enables charging.<br/>CHG_OK = 0</p> <p>0x06: Charger is in timer fault mode<br/>CHG_OK = 0 and if BAT_DTLS = 0b001 then V<sub>BATT</sub> &lt; V<sub>SYSTEMIN</sub> - 500mV or V<sub>BATT</sub> &lt; V<sub>PRECHG</sub> and T<sub>J</sub> &lt; T<sub>SHDN</sub></p> <p>0x07: Charger is suspended because Q<sub>BAT</sub> is disabled (DISQBAT = high or DISIBS = 1)<br/>CHG_OK = 0</p> <p>0x08: Charger is off, charger input invalid and/or charger is disabled<br/>CHG_OK = 1</p> <p>0x09: Reserved</p> <p>0x0A: Charger is off and the junction temperature is &gt; T<sub>SHDN</sub><br/>CHG_OK = 0</p> <p>0x0B: Charger is off because the watchdog timer expired<br/>CHG_OK = 0</p> <p>0x0C: Charger is suspended or charge current or voltage is reduced based on JEITA control. This condition is also reported in THM_DTLS.<br/>CHG_OK = 0</p> <p>0x0D: Charger is suspended because battery removal is detected on THM pin. This condition is also reported in THM_DTLS.<br/>CHG_OK = 0</p> <p>0x0E: Reserved</p> <p>0x0F: Reserved</p> |

**CHG\_DETAILS\_02 (0x15)**

| BIT         | 7         | 6             | 5 | 4 | 3             | 2             | 1 | 0             |
|-------------|-----------|---------------|---|---|---------------|---------------|---|---------------|
| Field       | SPR       | THM_DTLS[2:0] |   |   | APP_MODE_DTLS | FSW_DTLS[1:0] |   | NUM_CELL_DTLS |
| Reset       | 0x0       | 0x2           |   |   | 0x0           | 0x0           |   | 0x0           |
| Access Type | Read Only | Read Only     |   |   | Read Only     | Read Only     |   | Read Only     |

| BITFIELD      | BITS | DESCRIPTION  | DECODE  |
|---------------|------|--|---|
| SPR           | 7    | Spare bit  |   |
| THM_DTLS      | 6:4  | Thermistor Status.<br>This is also reported in the CHG_DTLS as 0x0C. | 0b000: Low temperature and charging suspended (COLD)<br>0b001: Low temperature charging (cool)<br>0b010: Normal temperature charging (normal)<br>0b011: High temperature charging (warm)<br>0b100: High temperature and charging suspended (hot)<br>0b101: Battery removal detected on THM pin<br>0b110: Thermistor monitoring is disabled<br>0b111: Reserved |
| APP_MODE_DTLS | 3    | Application Mode Status  | 0b0: Device is configured to operate as a standalone DC-DC converter.<br>0b1: Device is configured to operate as a charger.   |
| FSW_DTLS      | 2:1  | Programmed Switching Frequency Details                               | 0b00: 600kHz<br>0b01: Reserved<br>0b10: Reserved<br>0b11: Reserved  |
| NUM_CELL_DTLS | 0    | Number of Serially Connected Battery Cells Details                   | 0b0: Device is configured to support a 2-cell battery.<br>0b1: Device is configured to support a 3-cell battery.  |

**CHG\_CNFG\_00 (0x16)**

Charger configuration 0

| BIT         | 7           | 6           | 5           | 4           | 3           | 2 | 1 | 0 |
|-------------|-------------|-------------|-------------|-------------|-------------|---|---|---|
| Field       | COMM_MODE   | DISIBS      | STBY_EN     | WDTEN       | MODE[3:0]   |   |   |   |
| Reset       | 0x0         | 0x0         | 0x0         | 0x0         | 0x5         |   |   |   |
| Access Type | Write, Read | Write, Read | Write, Read | Write, Read | Write, Read |   |   |   |

| BITFIELD  | BITS | DESCRIPTION   | DECODE  |
|-----------|------|---|---|
| COMM_MODE | 7    | I <sup>2</sup> C Mode Enable  | <p>0b0: Autonomous Mode<br/>CHGIN_ILIM, CHGCC, CHG_CV_PRM, and TO_ITH registers are programmed by external resistors on INLIM, ISET, VSET and ITO pins.</p> <p>Writing 0 to COMM_MODE is ignored.<br/>0b1: I<sup>2</sup>C Mode Enabled<br/>CHGIN_ILIM, CHGCC, CHG_CV_PRM and TO_ITH registers are programmed by I<sup>2</sup>C.</p> <p>Writing 1 to COMM_MODE is allowed.<br/>Writing COMM_MODE=1 clears any charger suspension due to invalid resistance detected on INLIM, ISET, VSET, and ITO pins. Charger starts with I<sup>2</sup>C programmed settings in CHGIN_ILIM, CHGCC, CHG_CV_PRM, and TO_ITH registers.</p> |
| DISIBS    | 6    | BATT to SYS FET Disable Control<br>Read back value of DISIBS register bit reflects the actual DISIBS command or DISQBAT PIN state.  | <p>0b0: BATT to SYS FET is controlled by the power path state machine.</p> <p>0b1: BATT to SYS FET is forced off.</p>   |
| STBY_EN   | 5    | CHGIN Standby Enable<br>Read back value of the STBY_EN register bit reflects the actual CHGIN standby setting.  | <p>0b0: DC-DC is controlled by the power path state machine.</p> <p>0b1: Force DC-DC off. Device goes to CHGIN low quiescent current standby.</p>   |
| WDTEN     | 4    | <p>Watchdog Timer Enable.</p> <p>While enabled, the system controller must reset the watchdog timer within the timer period (<math>t_{WD}</math>) for the charger to operate normally. Reset the watchdog timer by programming WDTCLR = 0x01.</p> | <p>0b0: Watchdog timer disabled</p> <p>0b1: Watchdog timer enabled</p>  |

| BITFIELD | BITS | DESCRIPTION  | DECODE  |
|----------|------|--|---|
| MODE     | 3:0  | Smart Power Selector Configuration. Read back value of the MODE register reflects the actual smart power selector configuration. | 0x0: Charger = off, OTG = off, DC-DC = off. When the Q <sub>BAT</sub> switch is on (DISQBAT = low and DISIBS = 0), the battery powers the system.<br>0x1: Same as 0b0000<br>0x2: Same as 0b0000<br>0x3: Same as 0b0000<br>0x4: Charger = off, OTG = off, DC-DC = on. When there is a valid input, the DC-DC converter regulates the system voltage to be the maximum of (V <sub>SYSTEMIN</sub> and V <sub>BATT</sub> + 4%).<br>0x5: Charger = on, OTG = off, DC-DC = on. When there is a valid input, the battery is charging. V <sub>SYS</sub> is the larger of V <sub>SYSTEMIN</sub> and ~V <sub>BATT</sub> + I <sub>BATT</sub> × R <sub>BAT2SYS</sub> .<br>0x6: Same as 0b0101<br>0x7: Same as 0b0101<br>0x8: RSVD<br>0x9: RSVD<br>0xA: Charger = off, OTG = on, DC-DC = off. The Q <sub>BAT</sub> switch is on to allow the battery to support the system, the charger's DC-DC operates in reverse mode as a buck converter. The OTG output, CHGIN, can source current up to I <sub>CHGIN.OTG.LIM</sub> . The CHGIN target voltage is V <sub>CHGIN.OTG</sub> .<br>0xB: RSVD<br>0xC: RSVD<br>0xD: RSVD<br>0xE: RSVD<br>0xF: RSVD |

**CHG CNFG 01 (0x17)**

Charger configuration 1

| BIT                | 7           | 6           | 5              | 4 | 3           | 2             | 1 | 0 |
|--------------------|-------------|-------------|----------------|---|-------------|---------------|---|---|
| <b>Field</b>       | PQEN        | LPM         | CHG_RSTRT[1:0] |   | STAT_EN     | FCHGTIME[2:0] |   |   |
| <b>Reset</b>       | 0x1         | 0x0         | 0x1            |   | 0x1         | 0x1           |   |   |
| <b>Access Type</b> | Write, Read | Write, Read | Write, Read    |   | Write, Read | Write, Read   |   |   |

| BITFIELD  | BITS | DESCRIPTION                              | DECODE  |
|-----------|------|--|---|
| PQEN      | 7    | Low-Battery Prequalification Mode Enable | 0b0: Low-Battery Prequalification mode is disabled.<br>0b1: Low-Battery Prequalification mode is enabled.   |
| LPM       | 6    | Low Power Mode control                   | 0b0: Q <sub>BAT</sub> charge pump runs in Normal mode.<br>0b1: Q <sub>BAT</sub> charge pump is in Low Power Mode.   |
| CHG_RSTRT | 5:4  | Charger Restart Threshold                | 0b00: 100mV/cell below the value programmed by CHG_CV_PRM<br>0b01: 150mV/cell below the value programmed by CHG_CV_PRM<br>10: 200mV/cell below the value programmed by CHG_CV_PRM<br>11: Disabled |

| BITFIELD | BITS | DESCRIPTION                                       | DECODE  |
|----------|------|---|---|
| STAT_EN  | 3    | Charge Indicator Output Enable                    | 0b0: Disable STAT output<br>0b1: Enable STAT output   |
| FCHGTIME | 2:0  | Fast-Charge Timer setting (t <sub>FC</sub> , hrs) | 0b000: Disable<br>0b001: 3<br>0b010: 4<br>0b011: 5<br>0b100: 6<br>0b101: 7<br>0b110: 8<br>0b111: 10 |

**CHG\_CNFG\_02 (0x18)**

Charger configuration 2

| BIT         | 7           | 6 | 5           | 4 | 3 | 2 | 1 | 0 |
|-------------|-------------|---|-------------|---|---|---|---|---|
| Field       | SPR[1:0]    |   | CHGCC[5:0]  |   |   |   |   |   |
| Reset       | 0x0         |   | 0x7         |   |   |   |   |   |
| Access Type | Write, Read |   | Write, Read |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|-------------|--------|
| SPR      | 7:6  | Spare Bit   |        |

| BITFIELD | BITS | DESCRIPTION   | DECODE   |
|----------|------|---|--|
| CHGCC    | 5:0  | <p>Fast-Charge Current Selection (mA). When the charger is enabled, the charge current limit is set by these bits.</p> <p>Read back value of the CHGCC register reflects the actual fast charge current programmed in the charger.</p> <p>The thermal foldback loop can reduce the battery charger's target current by A<sub>TJREG</sub>.</p> | <p>0x00: 100<br/>0x01: 150<br/>0x02: 200<br/>0x03: 250<br/>0x04: 300<br/>0x05: 350<br/>0x06: 400<br/>0x07: 450<br/>0x08: 500<br/>0x09: 600<br/>0x0A: 700<br/>0x0B: 800<br/>0x0C: 900<br/>0x0D: 1000<br/>0x0E: 1100<br/>0x0F: 1200<br/>0x10: 1300<br/>0x11: 1400<br/>0x12: 1500<br/>0x13: 1600<br/>0x14: 1700<br/>0x15: 1800<br/>0x16: 1900<br/>0x17: 2000<br/>0x18: 2100<br/>0x19: 2200<br/>0x1A: 2300<br/>0x1B: 2400<br/>0x1C: 2500<br/>0x1D: 2600<br/>0x1E: 2700<br/>0x1F: 2800<br/>0x20: 2900<br/>0x21: 3000<br/>0x22: 3100<br/>0x23: 3200<br/>0x24: 3300<br/>0x25: 3400<br/>0x26: 3500<br/>0x27: 3600<br/>0x28: 3700<br/>0x29: 3800<br/>0x2A: 3900<br/>0x2B: 4000<br/>0x2C: 4100<br/>0x2D: 4200<br/>0x2E: 4300<br/>0x2F: 4400<br/>0x30: 4500<br/>0x31: 4600<br/>0x32: 4700<br/>0x33: 4800<br/>0x34: 4900<br/>0x35: 5000<br/>0x36: 5100<br/>0x37: 5200<br/>0x38: 5300</p> |

| BITFIELD | BITS | DESCRIPTION | DECODE   |
|----------|------|-------------|--|
|          |      |             | 0x39: 5400<br>0x3A: 5500<br>0x3B: 5600<br>0x3C: 5700<br>0x3D: 5800<br>0x3E: 5900<br>0x3F: 6000 |

**CHG\_CNFG\_03 (0x19)**

Charger configuration 3

| BIT            | 7                 | 6               | 5            | 4 | 3 | 2           | 1 | 0 |
|----------------|-------------------|-----------------|--------------|---|---|-------------|---|---|
| Field          | SYS_TRAC<br>K_DIS | B2SOVRC_<br>DTC | TO_TIME[2:0] |   |   | TO_ITH[2:0] |   |   |
| Reset          | 0x1               | 0x0             | 0x3          |   |   | 0x0         |   |   |
| Access<br>Type | Write, Read       | Write, Read     | Write, Read  |   |   | Write, Read |   |   |

| BITFIELD          | BITS | DESCRIPTION   | DECODE  |
|-------------------|------|---|---|
| SYS_TRACK<br>_DIS | 7    | SYS Tracking Disable Control  | 0x0: SYS tracking is enabled. SYS is regulated to MAX of (V <sub>BATT</sub> + 4%, V <sub>SYSTEMIN</sub> ). This is also valid in Charge Done state.<br>0x1: SYS tracking is disabled. SYS is regulated to V <sub>CHG_CV_PRM</sub> . |
| B2SOVRC_D<br>TC   | 6    | Battery to SYS Overcurrent Debounce Time Control.<br>While under OVRC condition, after t <sub>OCP</sub> switcher (and therefore charge) is disabled.  | 0x0: t <sub>OCP</sub> = 6ms<br>0x1: t <sub>OCP</sub> = 100ms  |
| TO_TIME           | 5:3  | Top-Off Timer Setting (min)   | 0b000: 30s<br>0b001: 10<br>0b010: 20<br>0b011: 30<br>0b100: 40<br>0b101: 50<br>0b110: 60<br>0b111: 70   |
| TO_ITH            | 2:0  | Top-Off Current Threshold (mA). The charger transitions from its fast-charge constant voltage mode to its top-off mode when the charger current decays to the value programmed by this register. This transition generates a CHG_I interrupt and causes the CHG_DTLS register to report top-off mode. This transition also starts the top-off time as programmed by TO_TIME.<br>Read back value of the TO_ITH register reflects the actual top-off current programmed in the charger. | 0b000: 100<br>0b001: 200<br>0b010: 300<br>0b011: 400<br>0b100: 500<br>0b101: 600<br>0b110: 600<br>0b111: 600  |

**CHG\_CNFG\_04 (0x1A)**

Charger configuration 4

| BIT                | 7           | 6           | 5               | 4 | 3      | 2 | 1 | 0 |
|--------------------|-------------|-------------|-----------------|---|--------|---|---|---|
| <b>Field</b>       | SPR[1:0]    |             | CHG_CV_PRM[5:0] |   |        |   |   |   |
| <b>Reset</b>       | 0x0         |             | 0x00            |   |        |   |   |   |
| <b>Access Type</b> | Write, Read |             | Write, Read     |   |        |   |   |   |
| BITFIELD           | BITS        | DESCRIPTION |                 |   | DECODE |   |   |   |
| SPR                | 7:6         | Spare Bit   |                 |   |        |   |   |   |



| BITFIELD       | BITS | DESCRIPTION   | DECODE  |
|----------------|------|---|---|
| CHG_CV_P<br>RM | 5:0  | <p>Charge Termination Voltage Setting (V).<br/>Read back value of the CHG_CV_PRM register reflects the actual charge termination voltage programmed in the charger when JEITA_EN = 0.<br/>When JEITA_EN = 1, charge termination voltage is controlled by V<sub>CHGCV_COOL</sub> and V<sub>CHGCV_WARM</sub> register settings.</p> | <p>2 Cell Battery<br/>0x00: 8.000<br/>0x01: 8.020<br/>0x02: 8.040<br/>0x03: 8.060<br/>0x04: 8.080<br/>0x05: 8.100<br/>0x06: 8.120<br/>0x07: 8.140<br/>0x08: 8.160<br/>0x09: 8.180<br/>0x0A: 8.200<br/>0x0B: 8.220<br/>0x0C: 8.240<br/>0x0D: 8.260<br/>0x0E: 8.280<br/>0x0F: 8.300<br/>0x10: 8.320<br/>0x11: 8.340<br/>0x12: 8.360<br/>0x13: 8.380<br/>0x14: 8.400<br/>0x15: 8.420<br/>0x16: 8.440<br/>0x17: 8.460<br/>0x18: 8.480<br/>0x19: 8.500<br/>0x1A: 8.520<br/>0x1B: 8.540<br/>0x1C: 8.560<br/>0x1D: 8.580<br/>0x1E: 8.600<br/>0x1F: 8.620<br/>0x20: 8.640<br/>0x21: 8.660<br/>0x22: 8.680<br/>0x23: 8.700<br/>0x24: 8.720<br/>0x25: 8.740<br/>0x26: 8.760<br/>0x27: 8.780<br/>0x28: 8.800<br/>0x29: 8.820<br/>0x2A: 8.840<br/>0x2B: 8.860<br/>0x2C: 8.880<br/>0x2D: 8.900<br/>0x2E: 8.920<br/>0x2F: 8.940<br/>0x30: 8.960<br/>0x31: 8.980<br/>0x32: 9.000<br/>0x33: 9.020<br/>0x34: 9.040<br/>0x35: 9.060<br/>0x36: 9.080<br/>0x37: 9.100</p> |

| BITFIELD | BITS | DESCRIPTION | DECODE   |
|----------|------|-------------|--|
|          |      |             | 0x38: 9.120<br>0x39: 9.140<br>0x3A: 9.160<br>0x3B: 9.180<br>0x3C: 9.200<br>0x3D: 9.220<br>0x3E: 9.240<br>0x3F: 9.260<br>3 Cell Battery<br>0x00: 12.000<br>0x01: 12.030<br>0x02: 12.060<br>0x03: 12.090<br>0x04: 12.120<br>0x05: 12.150<br>0x06: 12.180<br>0x07: 12.210<br>0x08: 12.240<br>0x09: 12.270<br>0x0A: 12.300<br>0x0B: 12.330<br>0x0C: 12.360<br>0x0D: 12.390<br>0x0E: 12.420<br>0x0F: 12.450<br>0x10: 12.480<br>0x11: 12.510<br>0x12: 12.540<br>0x13: 12.570<br>0x14: 12.600<br>0x15: 12.630<br>0x16: 12.660<br>0x17: 12.690<br>0x18: 12.720<br>0x19: 12.750<br>0x1A: 12.780<br>0x1B: 12.810<br>0x1C: 12.840<br>0x1D: 12.870<br>0x1E: 12.900<br>0x1F: 12.930<br>0x20: 12.960<br>0x21: 12.990<br>0x22: 13.020<br>0x23: 13.050 |

**CHG\_CNFG\_05 (0x1B)**

Charger configuration 5

| BIT                | 7             | 6 | 5             | 4 | 3            | 2 | 1 | 0 |
|--------------------|---------------|---|---------------|---|--------------|---|---|---|
| <b>Field</b>       | RESERVED[1:0] |   | ITRICKLE[1:0] |   | B2SOVRC[3:0] |   |   |   |
| <b>Reset</b>       | 0x1           |   | 0x0           |   | 0x4          |   |   |   |
| <b>Access Type</b> | Write, Read   |   | Write, Read   |   | Write, Read  |   |   |   |

| BITFIELD | BITS | DESCRIPTION                           | DECODE  |
|----------|------|---------------------------------------|---|
| RESERVED | 7:6  | Reserved                              |   |
| ITRICKLE | 5:4  | Trickle Charge Current Selection (mA) | 0b00: 100<br>0b01: 200<br>0b10: 300<br>0b11: 400  |
| B2SOVRC  | 3:0  | BATT to SYS Overcurrent Threshold (A) | 0x00: Disable<br>0x01: 3.000<br>0x02: 3.500<br>0x03: 4.000<br>0x04: 4.500<br>0x05: 5.000<br>0x06: 5.500<br>0x07: 6.000<br>0x08: 6.500<br>0x09: 7.000<br>0x0A: 7.500<br>0x0B: 8.000<br>0x0C: 8.500<br>0x0D: 9.000<br>0x0E: 9.500<br>0x0F: 10.000 |

**CHG\_CNFG\_06 (0x1C)**

Charger configuration 6

| BIT         | 7           | 6             | 5 | 4           | 3            | 2 | 1           | 0 |
|-------------|-------------|---------------|---|-------------|--------------|---|-------------|---|
| Field       | SPR7        | RESERVED[1:0] |   | SPR4        | CHGPROT[1:0] |   | WDTCLR[1:0] |   |
| Reset       | 0x0         | 0x0           |   | 0x0         | 0x0          |   | 0x0         |   |
| Access Type | Write, Read | Write, Read   |   | Write, Read | Write, Read  |   | Write, Read |   |

| BITFIELD | BITS | DESCRIPTION  | DECODE   |
|----------|------|--|--|
| SPR7     | 7    | Spare bit  |  |
| RESERVED | 6:5  | Reserved   |  |
| SPR4     | 4    | Spare bit  |  |
| CHGPROT  | 3:2  | Charger Settings Protection Bit.<br><br>Writing 11 to these bits unlocks the write capability for the registers that are Protected with CHGPROT. Writing any value besides 11 locks the protected registers. | 0b00: Write capability locked<br>0b01: Write capability locked<br>0b10: Write capability locked<br>0b11: Write capability unlocked                                   |
| WDTCLR   | 1:0  | Watchdog Timer Clear Bit.<br>Writing 01 to these bits clears the watchdog timer when the watchdog timer is enabled.  | 0b00: the watchdog timer is not cleared<br>0b01: the watchdog timer is cleared<br>0b10: the watchdog timer is not cleared<br>0b11: the watchdog timer is not cleared |

**CHG\_CNFG\_07 (0x1D)**

Charger configuration 7

| BIT                | 7           | 6            | 5 | 4 | 3 | 2           | 1           | 0           |
|--------------------|-------------|--------------|---|---|---|-------------|-------------|-------------|
| <b>Field</b>       | JEITA_EN    | REGTEMP[3:0] |   |   |   | VCHGCV_COOL | ICHGCC_COOL | FSHIP_MODE  |
| <b>Reset</b>       | 0x0         | 0x6          |   |   |   | 0x0         | 0x1         | 0x0         |
| <b>Access Type</b> | Write, Read | Write, Read  |   |   |   | Write, Read | Write, Read | Write, Read |

| BITFIELD    | BITS | DESCRIPTION  | DECODE   |
|-------------|------|--|--|
| JEITA_EN    | 7    | JEITA Enable   | 0b0: JEITA disabled.<br>Fast-charge current and charge termination voltage do not change based on thermistor temperature.<br>0b1: JEITA enabled.<br>Fast-charge current and charge termination voltage change based on thermistor temperature. |
| REGTEMP     | 6:3  | Junction Temperature Thermal Regulation (°C).<br>The charger's target current limit starts to foldback and the TREG bit is set if the junction temperature is greater than the REGTEMP setpoint. | 0x0: 85<br>0x1: 90<br>0x2: 95<br>0x3: 100<br>0x4: 105<br>0x5: 110<br>0x6: 115<br>0x7: 120<br>0x8: 125<br>0x9: 130  |
| VCHGCV_COOL | 2    | JEITA-Controlled Battery Termination Voltage When Thermistor Temperature is Between T <sub>COLD</sub> and T <sub>COOL</sub>  | 0b0: Battery termination voltage is set by CHG_CV_PRM.<br>0b1: Battery termination voltage is set by (CHG_CV_PRM - 180mV/cell).  |
| ICHGCC_COOL | 1    | JEITA-Controlled Battery Fast-Charge Current When Thermistor Temperature is Between T <sub>COLD</sub> and T <sub>COOL</sub>  | 0b0: Battery fast-charge current is set by CHGCC<br>0b1: Battery fast-charge current is reduced to 50% of CHGCC  |
| FSHIP_MODE  | 0    | Factory Ship Mode Enable   | 0b0: Disable factory ship mode<br>0b1: Enable factory ship mode  |

**CHG\_CNFG\_08 (0x1E)**

Charger configuration 8

| BIT                | 7           | 6               | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|-------------|-----------------|---|---|---|---|---|---|
| <b>Field</b>       | RESERVED    | CHGIN_ILIM[6:0] |   |   |   |   |   |   |
| <b>Reset</b>       | 0x1         | 0x0B            |   |   |   |   |   |   |
| <b>Access Type</b> | Write, Read | Write, Read     |   |   |   |   |   |   |

| BITFIELD | BITS | DESCRIPTION | DECODE |
|----------|------|-------------|--------|
| RESERVED | 7    | Reserved    |        |

| BITFIELD   | BITS | DESCRIPTION   | DECODE  |
|------------|------|---|---|
| CHGIN_ILIM | 6:0  | CHGIN Input Current Limit (mA).<br>Read back value of the CHGIN_ILIM register reflect the actual input current limit programmed in the charger. | 0x00: 100<br>0x01: 100<br>0x02: 100<br>0x03: 100<br>0x04: 150<br>0x05: 200<br>0x06: 250<br>0x07: 300<br>0x08: 350<br>0x09: 400<br>0x0A: 450<br>0x0B: 500<br>0x0C: 550<br>0x0D: 600<br>0x0E: 650<br>0x0F: 700<br>0x10: 750<br>0x11: 800<br>0x12: 850<br>0x13: 900<br>0x14: 950<br>0x15: 1000<br>0x16: 1050<br>0x17: 1100<br>0x18: 1150<br>0x19: 1200<br>0x1A: 1250<br>0x1B: 1300<br>0x1C: 1350<br>0x1D: 1400<br>0x1E: 1450<br>0x1F: 1500<br>0x20: 1550<br>0x21: 1600<br>0x22: 1650<br>0x23: 1700<br>0x24: 1750<br>0x25: 1800<br>0x26: 1850<br>0x27: 1900<br>0x28: 1950<br>0x29: 2000<br>0x2A: 2050<br>0x2B: 2100<br>0x2C: 2150<br>0x2D: 2200<br>0x2E: 2250<br>0x2F: 2300<br>0x30: 2350<br>0x31: 2400<br>0x32: 2450<br>0x33: 2500<br>0x34: 2550<br>0x35: 2600<br>0x36: 2650<br>0x37: 2700<br>0x38: 2750 |

| BITFIELD | BITS | DESCRIPTION | DECODE     |
|----------|------|-------------|------------|
|          |      |             | 0x39: 2800 |
|          |      |             | 0x3A: 2850 |
|          |      |             | 0x3B: 2900 |
|          |      |             | 0x3C: 2950 |
|          |      |             | 0x3D: 3000 |
|          |      |             | 0x3E: 3050 |
|          |      |             | 0x3F: 3100 |
|          |      |             | 0x40: 3150 |
|          |      |             | 0x41: 3200 |
|          |      |             | 0x42: 3250 |
|          |      |             | 0x43: 3300 |
|          |      |             | 0x44: 3350 |
|          |      |             | 0x45: 3400 |
|          |      |             | 0x46: 3450 |
|          |      |             | 0x47: 3500 |
|          |      |             | 0x48: 3550 |
|          |      |             | 0x49: 3600 |
|          |      |             | 0x4A: 3650 |
|          |      |             | 0x4B: 3700 |
|          |      |             | 0x4C: 3750 |
|          |      |             | 0x4D: 3800 |
|          |      |             | 0x4E: 3850 |
|          |      |             | 0x4F: 3900 |
|          |      |             | 0x50: 3950 |
|          |      |             | 0x51: 4000 |
|          |      |             | 0x52: 4050 |
|          |      |             | 0x53: 4100 |
|          |      |             | 0x54: 4150 |
|          |      |             | 0x55: 4200 |
|          |      |             | 0x56: 4250 |
|          |      |             | 0x57: 4300 |
|          |      |             | 0x58: 4350 |
|          |      |             | 0x59: 4400 |
|          |      |             | 0x5A: 4450 |
|          |      |             | 0x5B: 4500 |
|          |      |             | 0x5C: 4550 |
|          |      |             | 0x5D: 4600 |
|          |      |             | 0x5E: 4650 |
|          |      |             | 0x5F: 4700 |
|          |      |             | 0x60: 4750 |
|          |      |             | 0x61: 4800 |
|          |      |             | 0x62: 4850 |
|          |      |             | 0x63: 4900 |
|          |      |             | 0x64: 4950 |
|          |      |             | 0x65: 5000 |
|          |      |             | 0x66: 5050 |
|          |      |             | 0x67: 5100 |
|          |      |             | 0x68: 5150 |
|          |      |             | 0x69: 5200 |
|          |      |             | 0x6A: 5250 |
|          |      |             | 0x6B: 5300 |
|          |      |             | 0x6C: 5350 |
|          |      |             | 0x6D: 5400 |
|          |      |             | 0x6E: 5450 |
|          |      |             | 0x6F: 5500 |
|          |      |             | 0x70: 5550 |
|          |      |             | 0x71: 5600 |

| BITFIELD | BITS | DESCRIPTION | DECODE   |
|----------|------|-------------|--|
|          |      |             | 0x72: 5650<br>0x73: 5700<br>0x74: 5750<br>0x75: 5800<br>0x76: 5850<br>0x77: 5900<br>0x78: 5950<br>0x79: 6000<br>0x7A: 6050<br>0x7B: 6100<br>0x7C: 6150<br>0x7D: 6200<br>0x7E: 6250<br>0x7F: 6300 |

**CHG\_CNFG\_09 (0x1F)**

Charger configuration 9

| BIT         | 7              | 6 | 5             | 4 | 3 | 2            | 1 | 0 |
|-------------|----------------|---|---------------|---|---|--------------|---|---|
| Field       | INLIM_CLK[1:0] |   | OTG_ILIM[2:0] |   |   | MINVSYS[2:0] |   |   |
| Reset       | 0x2            |   | 0x3           |   |   | 0x3          |   |   |
| Access Type | Write, Read    |   | Write, Read   |   |   | Write, Read  |   |   |

| BITFIELD  | BITS | DESCRIPTION  | DECODE   |
|-----------|------|--|--|
| INLIM_CLK | 7:6  | Input Current Limit Soft-Start Period (μs)<br>Between Consecutive Increments of 25mA | 0b00: 8<br>0b01: 256<br>0b10: 1024<br>0b11: 4096   |
| OTG_ILIM  | 5:3  | OTG Mode Current Limit Setting (mA)  | 0b000: 500<br>0b001: 900<br>0b010: 1200<br>0b011: 1500<br>0b100: 2000<br>0b101: 2250<br>0b110: 2500<br>0b111: 3000   |
| MINVSYS   | 2:0  | Minimum System Regulation Voltage (V)  | 2 Cell Battery<br>0b000: 5.535<br>0b001: 5.740<br>0b010: 5.945<br>0b011: 6.150<br>0b100: 6.355<br>0b101: 6.560<br>0b110: 6.765<br>0b111: 6.970<br>3 Cell Battery<br>0b000: 8.303<br>0b001: 8.610<br>0b010: 8.918<br>0b011: 9.225<br>0b100: 9.533<br>0b101: 9.840<br>0b110: 10.148<br>0b111: 10.455 |

**CHG\_CNFG 10 (0x20)**

Charger configuration 10

| BIT         | 7           | 6 | 5               | 4 | 3 | 2 | 1 | 0           |
|-------------|-------------|---|-----------------|---|---|---|---|-------------|
| Field       | SPR[1:0]    |   | VCHGIN_REG[4:0] |   |   |   |   | DISKIP      |
| Reset       | 0x0         |   | 0x04            |   |   |   |   | 0x0         |
| Access Type | Write, Read |   | Write, Read     |   |   |   |   | Write, Read |

| BITFIELD   | BITS | DESCRIPTION                            | DECODE  |
|------------|------|--|---|
| SPR        | 7:6  | Spare Bit                              |   |
| VCHGIN_REG | 5:1  | CHGIN Voltage Regulation Threshold (V) | 0x00: 4.025<br>0x01: 4.200<br>0x02: 4.375<br>0x03: 4.550<br>0x04: 4.725<br>0x05: 4.900<br>0x06: 5.425<br>0x07: 5.950<br>0x08: 6.475<br>0x09: 7.000<br>0x0A: 7.525<br>0x0B: 8.050<br>0x0C: 8.575<br>0x0D: 9.100<br>0x0E: 9.625<br>0x0F: 10.150<br>0x10: 10.675<br>0x11: 10.950<br>0x12: 11.550<br>0x13: 12.150<br>0x14: 12.750<br>0x15: 13.350<br>0x16: 13.950<br>0x17: 14.550<br>0x18: 15.150<br>0x19: 15.750<br>0x1A: 16.350<br>0x1B: 16.950<br>0x1C: 17.550<br>0x1D: 18.150<br>0x1E: 18.750<br>0x1F: 19.050 |
| DISKIP     | 0    | Charger Skip Mode Disable              | 0b0: Autoskip mode<br>0b1: Disable skip mode  |



## Applications Information

### Inductor Selection

Buck-boost allows a range of inductance for different combinations of switching frequency and maximum nominal CHGIN voltage. See [Table 11](#) for recommendations. The lower the inductor DCR is, the higher the buck-boost efficiency is. The user needs to weigh the trade-offs between inductor size and DCR value and choose a suitable inductor for the buck-boost. See [Table 12](#) for inductor recommendations.

**Table 11. Recommended Inductance for Combinations of Switching Frequency and Maximum Nominal CHGIN Voltage**

| SWITCHING FREQUENCY (kHz) | MAXIMUM NOMINAL CHGIN VOLTAGE (V) | RECOMMENDED NOMINAL INDUCTANCE (μH) |
|---------------------------|-----------------------------------|-------------------------------------|
| 600                       | 15 or lower                       | 2.2, 3.3                            |
|                           | Higher than 15                    | 3.3                                 |

**Table 12. Suggested Inductors**

| ROOT PART NUMBER | MFGR.     | SERIES          | NOMINAL INDUCTANCE (μH) | TYPICAL DC RESISTANCE (mΩ) | CURRENT RATING (A) -30% (ΔL/L) | CURRENT RATING (A) ΔT = +40°C RISE | DIMENSIONS L x W x H (mm) |
|------------------|-----------|-----------------|-------------------------|----------------------------|--------------------------------|------------------------------------|---------------------------|
| MAX77960         | Coilcraft | XAL4020-222ME   | 2.2                     | 35.2                       | 5.6                            | 5.5                                | 4.0 x 4.0 x 2.1           |
|                  | Coilcraft | XAL4030-332ME   | 3.3                     | 26.0                       | 5.5                            | 6.6                                | 4.0 x 4.0 x 3.1           |
| MAX77961         | Cyntec    | CMLE063T2R2-063 | 2.2                     | 11.0                       | 14.0                           | 10.0                               | 6.95 x 6.6 x 2.8          |
|                  | Pulse     | PA5007.332NLT   | 3.3                     | 16.3                       | 15.0                           | 10.0                               | 7.8 x 7.6 x 2.9           |

### CHGIN Capacitor Selection

The CHGIN capacitor, C<sub>CHGIN</sub>, reduces the current peaks drawn from the input power source and reduces switching noise in the device. In OTG mode, it also reduces the output voltage ripple and ensures regulation loop stability. The impedance of C<sub>CHGIN</sub> at the switching frequency should be kept very low. Ceramic capacitors with X5R or X7R dielectrics are highly recommended due to their small size, low ESR, and small temperature coefficients. For most applications, a 10μF capacitor is sufficient. See [Table 13](#) for CHGIN capacitor recommendations.

**Table 13. Suggested CHGIN Capacitors**

| MFGR.  | SERIES            | NOMINAL CAPACITANCE (μF) | RATED VOLTAGE (V) | TEMPERATURE CHARACTERISTICS | CASE SIZE (in) | DIMENSIONS L x W x H (mm) |
|--------|-------------------|--------------------------|-------------------|-----------------------------|----------------|---------------------------|
| Murata | GRM32ER7YA106KA12 | 10                       | 35                | X7R                         | 1210           | 3.2 x 2.5 x 2.5           |
| Murata | GRM21BR6YA106ME43 | 10                       | 35                | X5R                         | 0805           | 2.0 x 1.25 x 1.25         |

### SYS Capacitor Selection

The SYS capacitor, C<sub>SYS</sub>, is required to keep the output voltage ripple small and to ensure regulation loop stability. The C<sub>SYS</sub> must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients. For stable operation, buck-boost requires 40μF of minimum effective output capacitance. Considering the DC bias characteristic of ceramic capacitors, 2 x 47μF (1210) or 3 x 47μF (1206) or 7 x 22μF (0805) capacitors are recommended for 2-cell applications, and 3 x 47μF (1210) or 4 x 47μF (1206) capacitors are recommended for 3-cell applications. See [Table 14](#) for SYS capacitor recommendations.

**Table 14. Suggested SYS Capacitors**

| MFGR.       | SERIES            | NOMINAL CAPACITANCE (μF) | RATED VOLTAGE (V) | TEMPERATURE CHARACTERISTICS | CASE SIZE (in) | DIMENSIONS L x W x H (mm) |
|-------------|-------------------|--------------------------|-------------------|-----------------------------|----------------|---------------------------|
| Taiyo Yuden | EMK325ABJ476MM8P  | 47                       | 16                | X5R                         | 1210           | 3.2 x 2.5 x 2.5           |
| Murata      | GRM31CR61C476ME44 | 47                       | 16                | X5R                         | 1206           | 3.2 x 1.6 x 1.6           |
| Murata      | GRM21BR61C226ME44 | 22                       | 16                | X5R                         | 0805           | 2.0 x 1.25 x 1.25         |

### Battery Insertion Protection

When the battery hot inserts into the MAX77960/MAX77961, it creates high inrush current flowing through the body diode of Q<sub>BAT</sub> FET. The inrush current peaks at tens of amperes and lasts for less than a few hundreds of microseconds. Such current can possibly damage the Q<sub>BAT</sub> FET. For IC protection, the following battery insertion protection is required on the board:

- For system designs with a 2S battery, include an external 3A Schottky diode from BATT to SYS. The Schottky diode has low forward voltage drop when conducting high current in the forward direction. It diverts the inrush current from BATT to SYS at battery insertion. The inrush current flowing through the Q<sub>BAT</sub> FET is greatly reduced and therefore the IC is protected. See [Figure 14](#).
- For system designs with a 3S battery, the inrush current is higher than a 2S battery due to higher battery voltage. In addition to the 3A Schottky diode from BATT to SYS, it is required to include an inrush protection circuit. The inrush protection circuit consists of an FET and RC network. See [Figure 15](#) for a complete solution. At battery hot insertion, V<sub>GS</sub> of the FET is slowly charged by the RC network. The FET gradually turns on and limits the inrush current. For FET selection, check the current and voltage rating of the FET to guarantee that it satisfies the system specification.

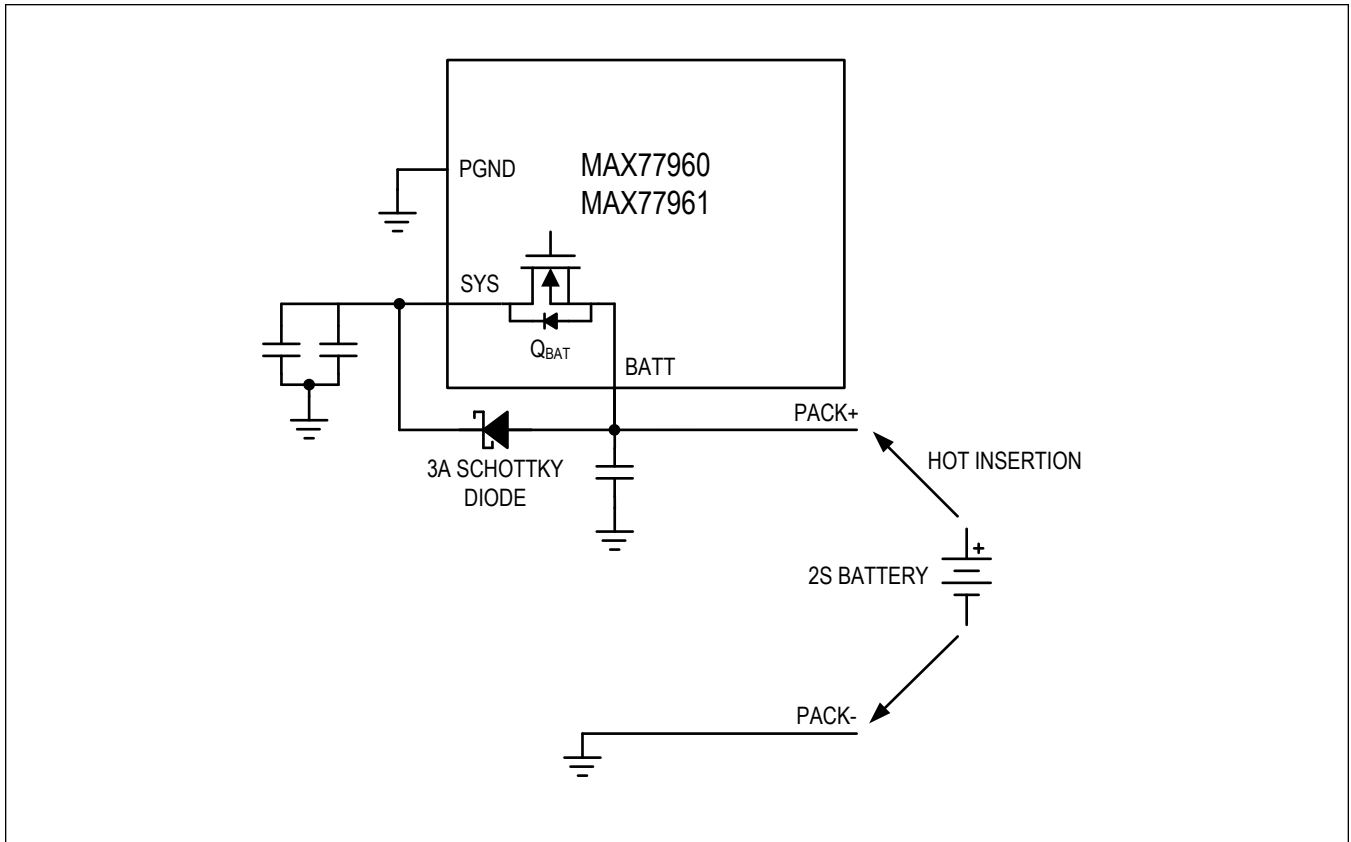


Figure 14. Battery Insertion Protection with 2S Battery

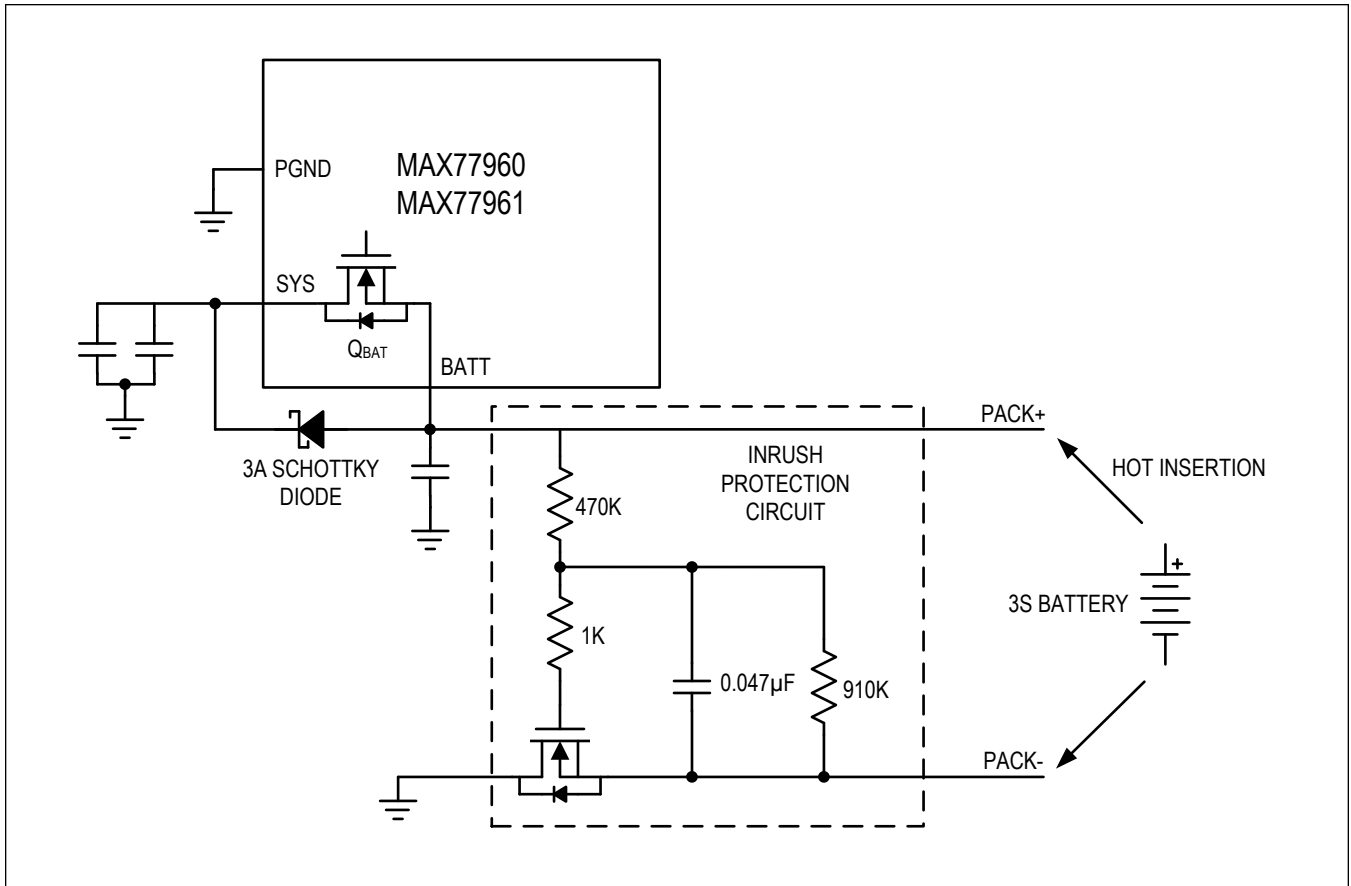


Figure 15. Battery Insertion Protection with 3S Battery

## PCB Layout Guidelines

Careful circuit board layout is critical to achieve low switching power losses and clean, stable operation. [Figure 16](#) shows a PCB layout example.

When designing the PCB, follow these guidelines:

1. Place the CHGIN capacitor ( $C_{CHGIN}$ ) and SYS capacitors ( $C_{SYS}$ ) immediately next to the CHGIN pin and SYS pin of the IC, respectively. Since the IC operates at a high switching frequency, this placement is critical for minimizing parasitic inductance within the input and output current loops which can cause high voltage spikes and can damage the internal switching MOSFETs.
2. Place the inductor next to the LX pins and make the traces between the LX pins and the inductor short and wide to minimize PCB trace impedance. Excessive PCB impedance reduces converter efficiency. When routing LX traces on a separate layer, make sure to include enough vias to minimize trace impedance. Routing LX traces on multiple layers is recommended to further reduce trace impedance. Furthermore, do not make LX traces take up an excessive amount of area. The voltage on this node switches very quickly and additional area creates more radiated emissions.
3. Route LX nodes to their corresponding bootstrap capacitors ( $C_{BST}$ ) as short as possible. Prioritize  $C_{BST}$  placement to reduce trace length to the IC.
4. Route CSINP and CSINN traces as symmetrical as possible. Having the same trace parasitics improves accuracy of the differential CHGIN current sensing.
5. Place the PVL capacitor ( $C_{PVL}$ ) immediately next to the PVL pin. Proximity to the IC provides a stable supply for the internal circuitry.
6. Place the BATT capacitor ( $C_{BATT}$ ) and SYSA capacitor ( $C_{SYSA}$ ) immediately next to the BATT pin and SYSA pin of the IC, respectively.
7. Keep the power traces and load connections short and wide. This is essential for high converter efficiency.
8. Do not neglect ceramic capacitor DC voltage derating. Choose capacitor values and case sizes carefully. See the [SYS Capacitor Selection](#) section and refer to [Tutorial 5527](#) for more information.

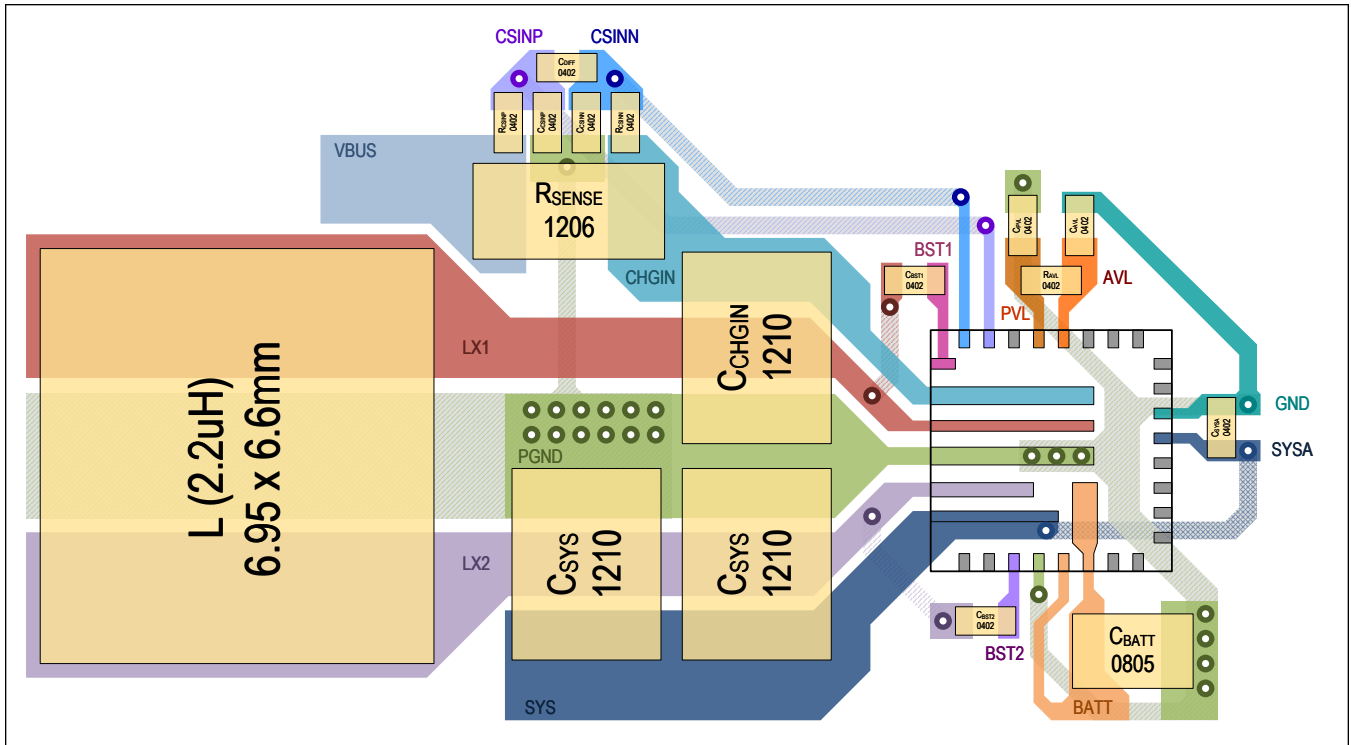
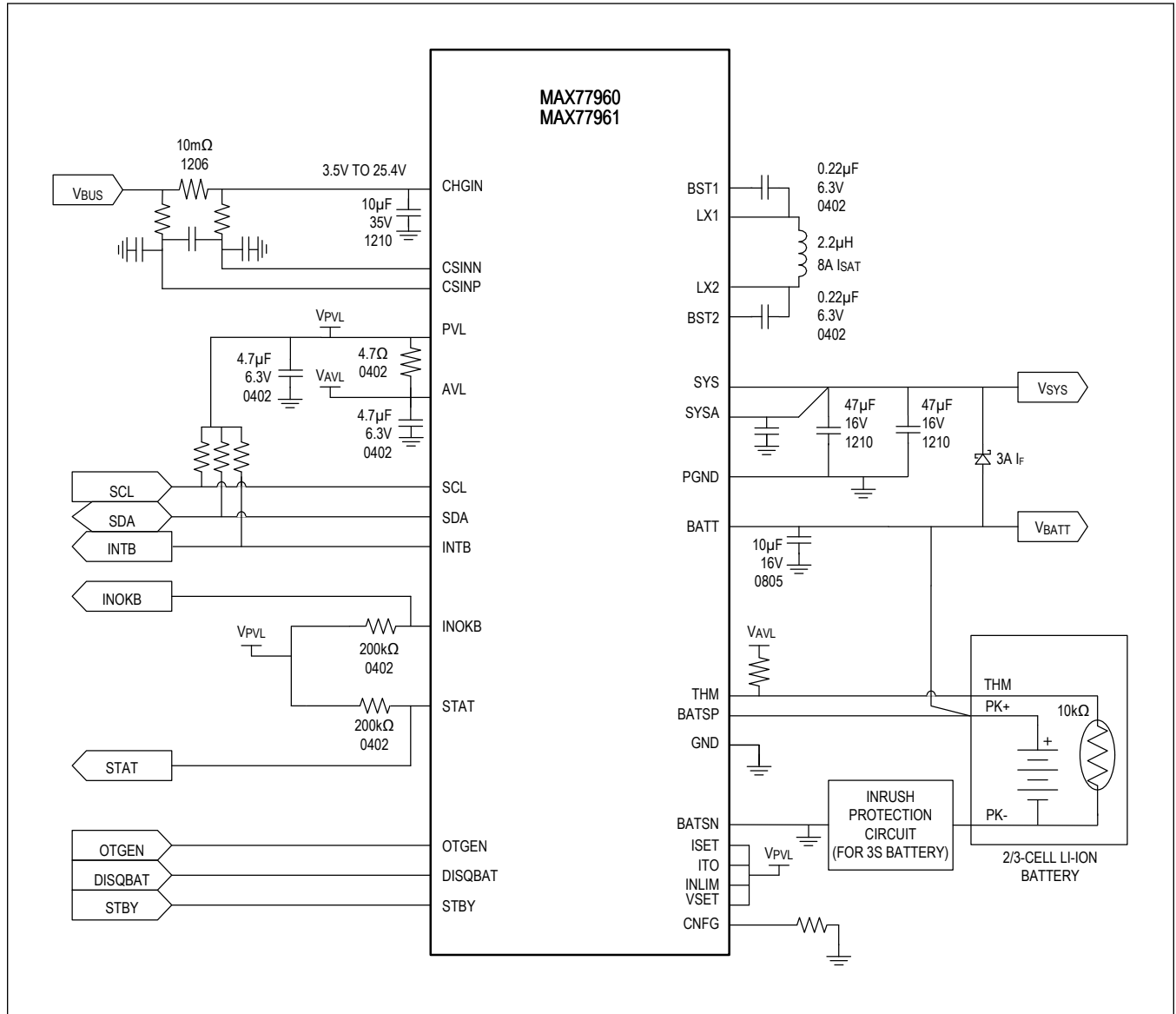


Figure 16. PCB Layout Example

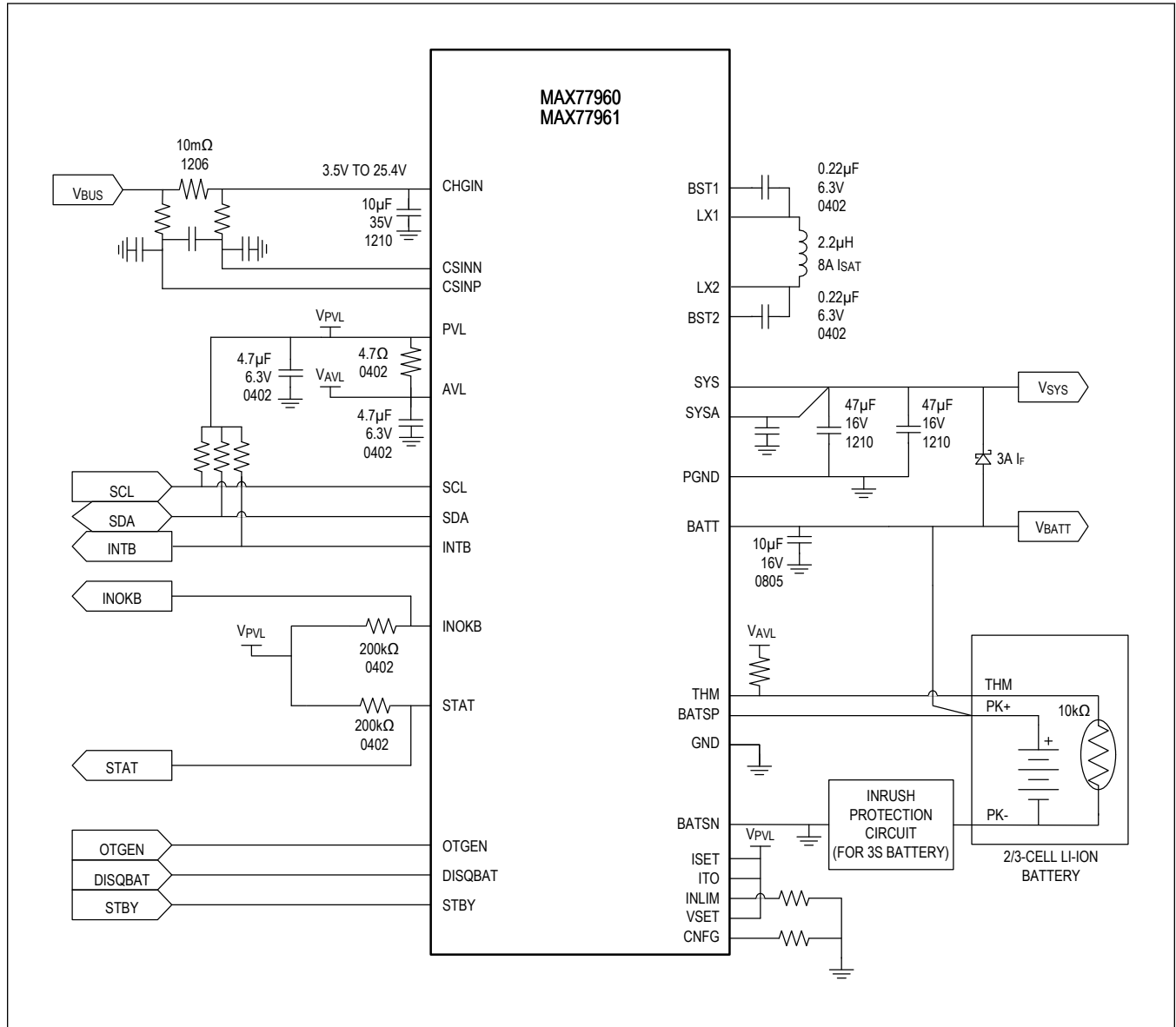
Typical Application Circuits

Wide-Input I<sup>2</sup>C Programmable Charger



Typical Application Circuits (continued)

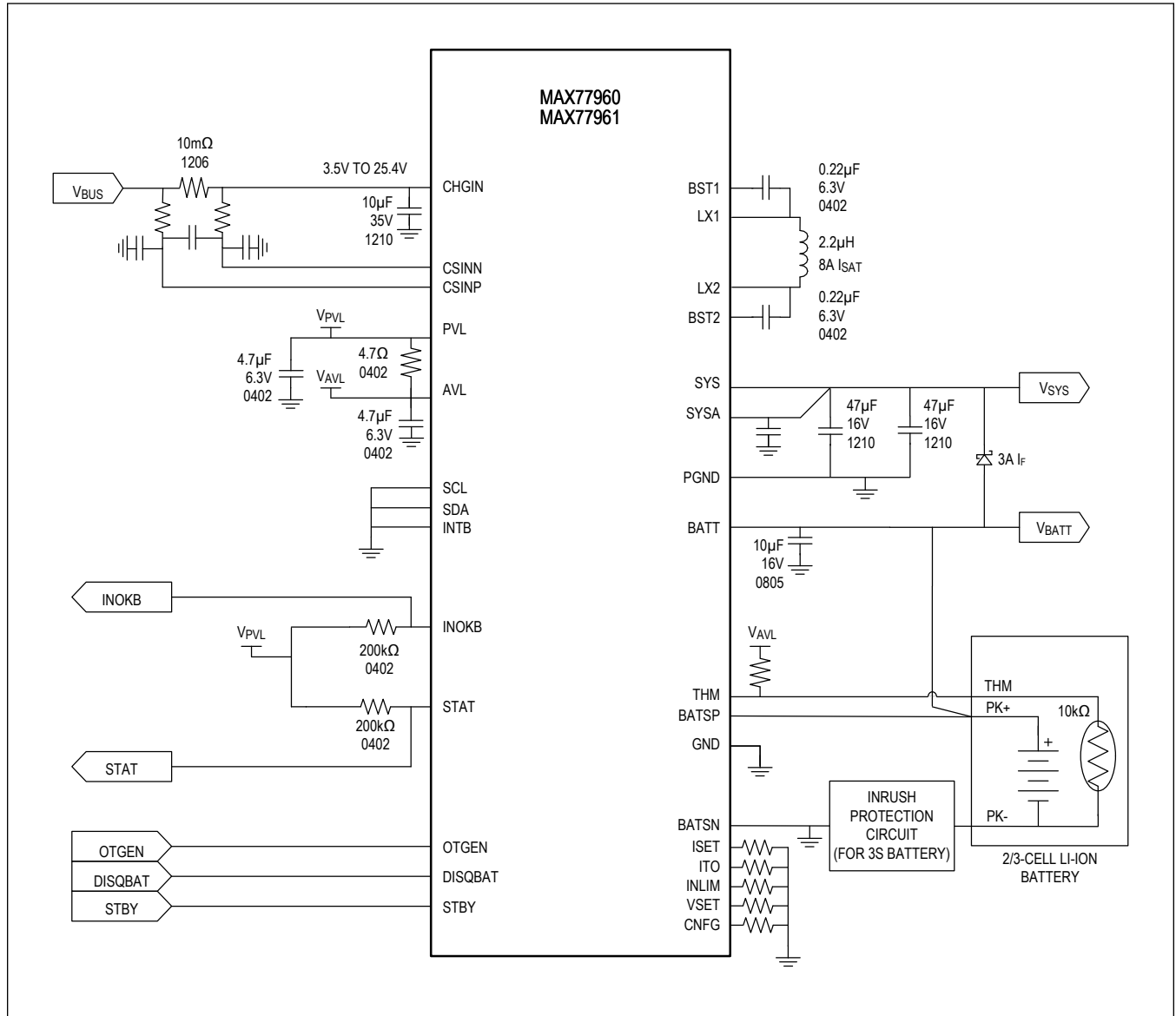
Wide-Input I<sup>2</sup>C Programmable Charger with Charger Disabled





Typical Application Circuits (continued)

Wide-Input Autonomous Charger



MAX77960/MAX77961

25V<sub>IN</sub> 3A/6A<sub>OUT</sub> USB-C Buck-Boost Charger with  
Integrated FETs for 2S/3S Li-Ion Batteries**Ordering Information**

| PART NUMBER            | TEMP RANGE     | PIN-PACKAGE                  | SWITCHING FREQUENCY | AUTONOMOUS OPERATION SUPPORTED | MAXIMUM CHARGING CURRENT |
|------------------------|----------------|------------------------------|---------------------|--------------------------------|--------------------------|
| <b>MAX77960</b> EFV06+ | -40°C to +85°C | 4mm x 4mm,<br>30-Lead FC2QFN | 600kHz              | Yes                            | 3A                       |
| MAX77960EFV06+T        | -40°C to +85°C | 4mm x 4mm,<br>30-Lead FC2QFN | 600kHz              | Yes                            | 3A                       |
| <b>MAX77961</b> EFV06+ | -40°C to +85°C | 4mm x 4mm,<br>30-Lead FC2QFN | 600kHz              | Yes                            | 6A                       |
| MAX77961EFV06+T        | -40°C to +85°C | 4mm x 4mm,<br>30-Lead FC2QFN | 600kHz              | Yes                            | 6A                       |

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

MAX77960/MAX77961

25V<sub>IN</sub> 3A/6A<sub>OUT</sub> USB-C Buck-Boost Charger with  
Integrated FETs for 2S/3S Li-Ion Batteries

## Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION     | PAGES CHANGED |
|-----------------|---------------|-----------------|---------------|
| 0               | 9/20          | Initial release | —             |

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at <https://www.maximintegrated.com/en/storefront/storefront.html>.

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